



## ADC12Jxx00 12-Bit 1.6 or 2.7 GSPS ADCs With Integrated DDC

### 1 Features

- Excellent Noise and Linearity up to and beyond  $F_{IN} = 3$  GHz
- Configurable DDC
- Decimation Factors from 4 to 32 (Complex Baseband Out)
- Bypass Mode for Full Nyquist Output Bandwidth
- Usable Output Bandwidth of 540 MHz at 4x Decimation and 2700 MSPS
- Usable Output Bandwidth of 320 MHz at 4x Decimation and 1600 MSPS
- Usable Output Bandwidth of 67.5 MHz at 32x Decimation and 2700 MSPS
- Usable Output Bandwidth of 40 MHz at 32x Decimation and 1600 MSPS
- Low Pin-Count JESD204B Subclass 1 Interface
- Automatically Optimized Output Lane Count
- Embedded Low Latency Signal Range Indication
- Low Power Consumption
- **Key Specifications**
  - Max Sampling Rate: 1600 or 2700 MSPS
  - Min Sampling Rate: 1000 MSPS
  - DDC Output Word Size: 15-Bit Complex (30 bits total)
  - Bypass Output Word Size: 12-Bit Offset Binary
  - Noise Floor:  $-147.3$  dBFS/Hz (ADC12J2700)
  - Noise Floor:  $-145$  dBFS/Hz (ADC12J1600)
  - IMD3:  $-64$  dBc ( $F_{IN} = 2140$  MHz  $\pm$  30 MHz at  $-13$  dBFS)
  - FPBW ( $-3$  dB): 3.2 GHz
  - Peak NPR: 46 dB
  - Supply Voltages: 1.9 V and 1.2 V
  - Power Consumption
    - Bypass (2700 MSPS): 1.8 W
    - Bypass (1600 MSPS): 1.6 W
    - Power Down Mode:  $<50$  mW

### 2 Applications

- Wireless Infrastructure
- RF-Sampling Software Defined Radio
- Wideband Microwave Backhaul
- Military Communications
- SIGINT
- RADAR and LIDAR
- DOCSIS / Cable Infrastructure
- Test and Measurement

### 3 Description

The ADC12J1600 and ADC12J2700 devices are wideband sampling and digital tuning devices. Texas Instruments' giga-sample analog-to-digital converter (ADC) technology enables a large block of frequency spectrum to be sampled directly at RF. An integrated DDC (Digital Down Converter) provides digital filtering and down-conversion. The selected frequency block is made available on a JESD204B serial interface. Data is output as baseband 15-bit complex information for ease of downstream processing. Based on the digital down-converter (DDC) decimation and link output rate settings, this data is output on 1 to 5 lanes of the serial interface.

A DDC bypass mode allows the full rate 12-bit raw ADC data to also be output. This mode of operation requires 8 lanes of serial output.

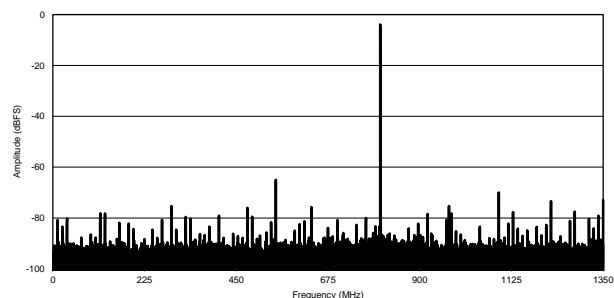
The ADC12J1600 and ADC12J2700 devices are available in a 68-pin VQFN package. The device operates over the Industrial ( $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ) ambient temperature range.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)     |
|-------------|-----------|---------------------|
| ADC12J1600  | VQFN (68) | 10.00 mm x 10.00 mm |
| ADC12J2700  | VQFN (68) | 10.00 mm x 10.00 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### Bypass — Spectral Response $f_S = 2.7$ GHz, $F_{IN} = 1897$ MHz at $-1$ dBFS



## Table of Contents

|  |           |  |           |
|--|-----------|--|-----------|
| <b>1 Features</b> .....                        | <b>1</b>  | 7.6 Register Map .....   | <b>57</b> |
| <b>2 Applications</b> .....                    | <b>1</b>  | <b>8 Application and Implementation</b> .....                    | <b>82</b> |
| <b>3 Description</b> .....                     | <b>1</b>  | 8.1 Application Information .....                                | <b>82</b> |
| <b>4 Revision History</b> .....                | <b>2</b>  | 8.2 Typical Application .....                                    | <b>82</b> |
| <b>5 Pin Configuration and Functions</b> ..... | <b>3</b>  | 8.3 Initialization Set-Up .....                                  | <b>86</b> |
| <b>6 Specifications</b> .....                  | <b>8</b>  | 8.4 Dos and Don'ts .....   | <b>86</b> |
| 6.1 Absolute Maximum Ratings .....             | <b>8</b>  | <b>9 Power Supply Recommendations</b> .....                      | <b>87</b> |
| 6.2 ESD Ratings .....                          | <b>9</b>  | 9.1 Supply Voltage .....   | <b>87</b> |
| 6.3 Recommended Operating Conditions .....     | <b>9</b>  | <b>10 Layout</b> .....   | <b>87</b> |
| 6.4 Thermal Information .....                  | <b>9</b>  | 10.1 Layout Guidelines .....                                     | <b>87</b> |
| 6.5 Electrical Characteristics .....           | <b>9</b>  | 10.2 Layout Example .....  | <b>88</b> |
| 6.6 Timing Requirements .....                  | <b>16</b> | 10.3 Thermal Management .....                                    | <b>90</b> |
| 6.7 Internal Characteristics .....             | <b>18</b> | <b>11 Device and Documentation Support</b> .....                 | <b>90</b> |
| 6.8 Switching Characteristics .....            | <b>19</b> | 11.1 Device Support .....  | <b>90</b> |
| 6.9 Typical Characteristics .....              | <b>20</b> | 11.2 Documentation Support .....                                 | <b>92</b> |
| <b>7 Detailed Description</b> .....            | <b>30</b> | 11.3 Related Links .....   | <b>92</b> |
| 7.1 Overview .....                             | <b>30</b> | 11.4 Community Resource .....                                    | <b>92</b> |
| 7.2 Functional Block Diagram .....             | <b>30</b> | 11.5 Trademarks .....  | <b>92</b> |
| 7.3 Feature Description .....                  | <b>31</b> | 11.6 Electrostatic Discharge Caution .....                       | <b>92</b> |
| 7.4 Device Functional Modes .....              | <b>49</b> | 11.7 Glossary .....  | <b>92</b> |
| 7.5 Programming .....                          | <b>55</b> | <b>12 Mechanical, Packaging, and Orderable Information</b> ..... | <b>92</b> |

## 4 Revision History

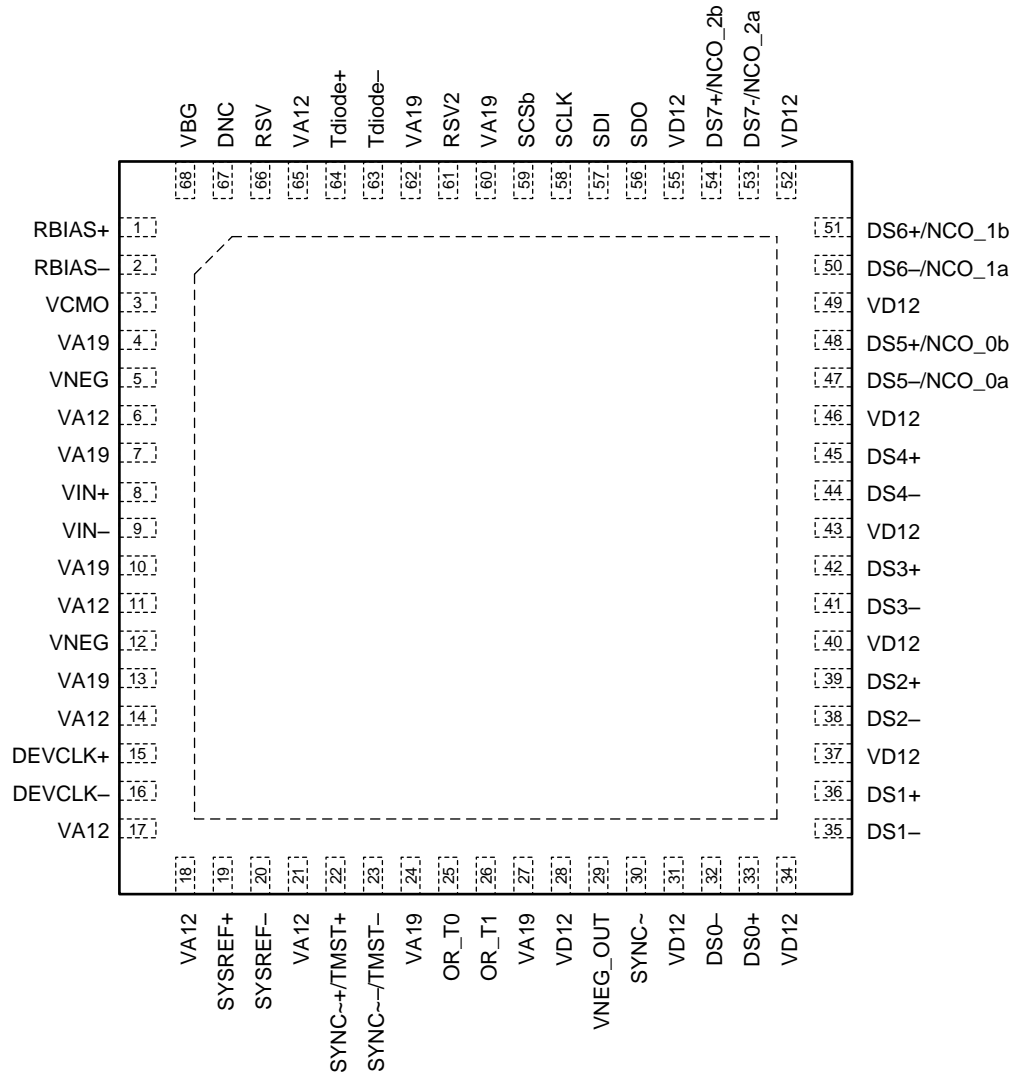
| Changes from Revision B (September 2014) to Revision C  | Page      |
|---|-----------|
| • Added additional voltage difference parameters to the <i>Absolute Maximum Ratings</i> table .....   | <b>8</b>  |
| • Added junction temperature to the <i>Absolute Maximum Ratings</i> table .....   | <b>8</b>  |
| • Added common mode voltage parameter to the <i>Recommended Operating Conditions</i> table. Changed CLK to SYSREF, and ~SYNC .....                | <b>9</b>  |
| • Changed some of the maximum interleaving offset values for both devices to tighten the levels .....   | <b>10</b> |
| • Deleted the <i>Differential Analog Input Connection</i> image in <i>The Analog Inputs</i> section .....   | <b>31</b> |
| • Added note about offset adjust in Background Calibration Mode to the <i>Offset Adjust</i> section and I/O offset register tables .....          | <b>35</b> |
| • Added the <i>Calibration Cycle Timing for Different Calibration Modes and Options</i> table in the <i>Timing Calibration Mode</i> section ..... | <b>50</b> |
| • Changed 0x004-0x005 to RESERVED in the <i>Standard SPI-3.0 Registers</i> summary table .....  | <b>60</b> |

| Changes from Revision A (February 2014) to Revision B                                   | Page     |
|---|----------|
| • Changed the device status from <i>Product Preview</i> to <i>Production Data</i> ..... | <b>1</b> |

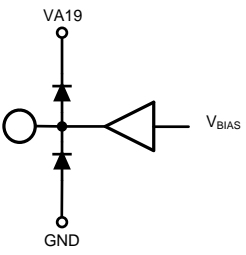
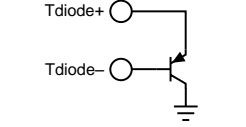
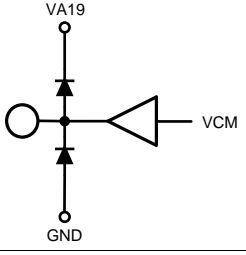
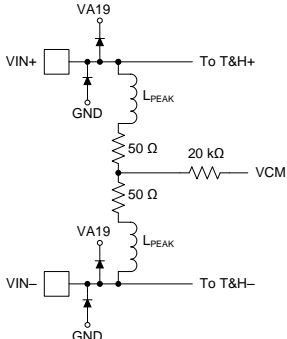
## 5 Pin Configuration and Functions

NKE Package  
68-Pin VQFN With Thermal Pad  
Top View

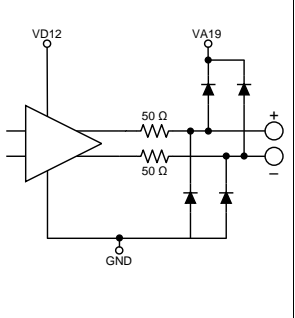
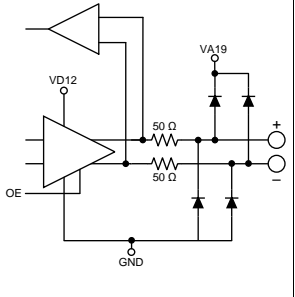
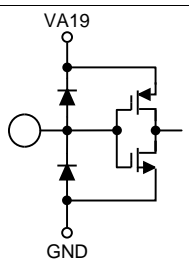
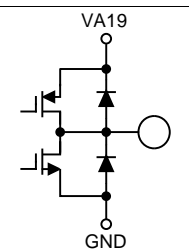


DNC = Make no external connection

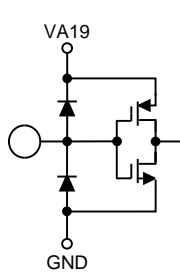
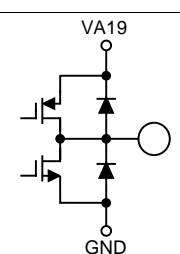
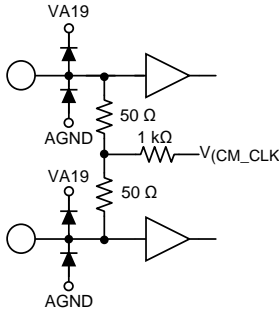
**Pin Functions**

| PIN           |     | EQUIVALENT CIRCUIT   | TYPE    | DESCRIPTION  |
|---------------|-----|--|---------|--|
| NAME          | NO. |  |         |  |
| <b>ANALOG</b> |     |  |         |  |
| RBIAS+        | 1   |   | I/O     | <b>External Bias Resistor Connections</b><br>External bias resistor terminals. A 3.3 kΩ (±0.1%) resistor should be connected between RBIAS+ and RBIAS-. The RBIAS resistor is used as a reference for internal circuits which affect the linearity of the converter. The value and precision of this resistor should not be compromised. These pins must be isolated from all other signals and grounds. |
| RBIAS-        | 2   |  |         |  |
| TDIODE-       | 63  |   | Passive | <b>Temperature Diode</b><br>These pins are the positive (anode) and negative (cathode) diode connections for die temperature measurements. Leave these pins unconnected if they are not used. See the <a href="#">Built-In Temperature Monitor Diode</a> section for more details.   |
| TDIODE+       | 64  |  |         |  |
| VBG           | 68  |   | O       | <b>Bandgap Output Voltage</b><br>This pin is capable of sourcing or sinking 100 μA and can drive a load up to 80 pF. Leave this pin unconnected if it is not used in the application. See the <a href="#">The Reference Voltage</a> section for more details.  |
| VCMO          | 3   |  | O       |  |
| VIN+          | 8   |  | I       | <b>Signal Input</b><br>The differential full-scale input range is determined by the full-scale voltage adjust register. An internal peaking inductor ( $L_{PEAK}$ ) of 5 nH is included for parasitic compensation.  |
| VIN-          | 9   |  |         |  |

**Pin Functions (continued)**

| PIN                          |     | EQUIVALENT CIRCUIT  | TYPE | DESCRIPTION  |
|------------------------------|-----|---|------|--|
| NAME                         | NO. |   |      |  |
| <b>DATA</b>                  |     |   |      |  |
| DS0–                         | 32  |    | O    | <b>Data</b><br><b>CML</b> These pins are the high-speed serialized-data outputs with user-configurable pre-emphasis. These outputs must always be terminated with a 100-Ω differential resistor at the receiver.   |
| DS0+                         | 33  |   |      |  |
| DS1–                         | 35  |   |      |  |
| DS1+                         | 36  |   |      |  |
| DS2–                         | 38  |   |      |  |
| DS2+                         | 39  |   |      |  |
| DS3–                         | 41  |   |      |  |
| DS3+                         | 42  |   |      |  |
| DS4–                         | 44  |   |      |  |
| DS4+                         | 45  |   |      |  |
| DS5–/NCO_0                   | 47  |    | O/I  | <b>Data</b><br><b>DS5–/NCO_0, DS5+/NCO_0, DS6–/NCO_1, DS6+/NCO_1, DS7–/NCO_2 and DS7+/NCO_2:</b> When decimation is enabled, these pins become LVCMOS inputs and allow the host device to select the specific NCO frequency or phase accumulator that is active. In this mode the positive (+) and negative (–) pins should be connected together and both driven. An acceptable alternative is to let one of the pair float while the other pin is driven. Connect these inputs to GND if they are not used in the application. |
| DS5+/NCO_0                   | 48  |   |      |  |
| DS6–/NCO_1                   | 50  |   |      |  |
| DS6+/NCO_1                   | 51  |   |      |  |
| DS7–/NCO_2                   | 53  |   |      |  |
| DS7+/NCO_2                   | 54  |   |      |  |
| <b>GROUND, RESERVED, DNC</b> |     |   |      |  |
| DNC                          | 67  |   | —    | <b>Do Not Connect</b><br>Do not connect DNC to any circuitry, power, or ground signals.  |
| RSV                          | 66  |  | —    | <b>Reserved</b><br><b>Connect to Ground or Leave Unconnected:</b> This reserved pin is a logic input for possible future device versions. It is recommended to connect this pin to ground. Floating this pin is also permissible.  |
| RSV2                         | 61  |   | —    | <b>Reserved</b><br><b>Connect to Ground</b> Connect this reserved input pin to ground for proper operation.  |
| Thermal Pad                  |     |   | —    | <b>Ground (GND)</b><br>The exposed pad on the bottom of the package is the ground return for all supplies. This pad must be connected with multiple vias to the printed circuit board (PCB) ground planes to ensure proper electrical and thermal performance. The exposed center pad on the bottom of the package must be thermally and electrically connected (soldered) to a ground plane to ensure rated performance.  |
| <b>LVCMOS</b>                |     |   |      |  |
| OR_T0                        | 25  |  | O    | <b>Over-Range</b><br>Over-range detection status for T0 and T1 thresholds. Leave these pins unconnected if they are not used in the application.   |
| OR_T1                        | 26  |   |      |  |

**Pin Functions (continued)**

| PIN                       |     | EQUIVALENT CIRCUIT  | TYPE | DESCRIPTION   |  |
|---------------------------|-----|---|------|---|--|
| NAME                      | NO. |   |      |   |  |
| SCLK                      | 58  |    | I    | <b>Serial Interface Clock</b><br>This pin functions as the serial-interface clock input which clocks the serial data in and out. The <a href="#">Using the Serial Interface</a> section describes the serial interface in more detail.  |  |
| SDI                       | 57  |   | I    | <b>Serial Data In</b><br>This pin functions as the serial-interface data input. The <a href="#">Using the Serial Interface</a> section describes the serial interface in more detail.   |  |
| SYNC~                     | 30  |   | I    | <b>SYNC~</b><br>This pin provides the JESD204B-required synchronizing request input. A logic-low applied to this input initiates a lane alignment sequence. The choice of LVCMOS or differential SYNC~ is selected through bit 6 of the configuration register 0x202h. Connect this input to GND or VA19 if differential SYNC~ input is used. |  |
| $\overline{\text{SCS}}$   | 59  |   | I    | <b>Serial Chip Select (active low)</b><br>This pin functions as the serial-interface chip select. The <a href="#">Using the Serial Interface</a> section describes the serial interface in more detail.   |  |
| SDO                       | 56  |    | O    | <b>Serial Data Out</b><br>This pin functions as the serial-interface data output. The <a href="#">Using the Serial Interface</a> section describes the serial interface in more detail.   |  |
| <b>DIFFERENTIAL INPUT</b> |     |   |      |   |  |
| DEVCLK+                   | 15  |  | I    | <b>Device Clock Input</b><br>The differential device clock signal must be AC coupled to these pins. The input signal is sampled on the rising edge of CLK.  |  |
| DEVCLK-                   | 16  |   | I    | <b>SYSREF</b><br>The differential periodic waveform on these pins synchronizes the device per JESD204B. If JESD204B subclass 1 synchronization is not required and these inputs are not utilized they may be left unconnected. In that case ensure SysRef_Rcvr_En=0 and SysRef_Pr_En=0.   |  |
| SYSREF+                   | 19  |   |      | I   | <b>SYNC~/TMST+</b><br>This differential input provides the JESD204B-required synchronizing request input. A differential logic-low applied to these inputs initiates a lane alignment sequence. For differential SYNC~ usage, ensure that SYNC_DIFF_PD = 0 and SYNC_DIFFSEL = 1. |
| SYNC~-/TMST-              | 20  |   |      |   | I  |
| SYNC~+/TMST+              | 22  |   |      |   |  |
| SYNC~-/TMST-              | 23  |   |      |   |  |

**Pin Functions (continued)**

| PIN          |     | EQUIVALENT CIRCUIT | TYPE | DESCRIPTION   |
|--------------|-----|--------------------|------|---|
| NAME         | NO. |                    |      |   |
| <b>POWER</b> |     |                    |      |   |
| VA12         | 6   |                    | —    | <b>Analog 1.2 V power supply pins</b><br>Bypass these pins to ground using one 10- $\mu$ F capacitor and two 1- $\mu$ F capacitors for bulk decoupling plus one 0.1- $\mu$ F capacitor per pin for individual decoupling.   |
|              | 11  |                    |      |   |
|              | 14  |                    |      |   |
|              | 17  |                    |      |   |
|              | 18  |                    |      |   |
|              | 21  |                    |      |   |
|              | 65  |                    |      |   |
| VA19         | 4   |                    | —    | <b>Analog 1.9 V power supply pins</b><br>Bypass these pins to ground using one 10- $\mu$ F capacitor and two 1- $\mu$ F capacitors for bulk decoupling plus one 0.1- $\mu$ F capacitor per pin for individual decoupling.   |
|              | 7   |                    |      |   |
|              | 10  |                    |      |   |
|              | 13  |                    |      |   |
|              | 24  |                    |      |   |
|              | 27  |                    |      |   |
|              | 60  |                    |      |   |
|              | 62  |                    |      |   |
| VD12         | 28  |                    | —    | <b>Digital 1.2 V power supply pins</b><br>Bypass these pins to ground using one 10- $\mu$ F capacitor and two 1- $\mu$ F capacitors for bulk decoupling plus one 0.1- $\mu$ F capacitor per pin for individual decoupling.  |
|              | 31  |                    |      |   |
|              | 34  |                    |      |   |
|              | 37  |                    |      |   |
|              | 40  |                    |      |   |
|              | 43  |                    |      |   |
|              | 46  |                    |      |   |
|              | 49  |                    |      |   |
|              | 52  |                    |      |   |
|              | 55  |                    |      |   |
| VNEG         | 5   |                    | I    | <b>VNEG</b><br>These pins must be decoupled to ground with a 0.1- $\mu$ F ceramic capacitor near each pin. These power input pins must be connected to the VNEG_OUT pin with a low resistance path. The connections must be isolated from any noisy digital signals and must also be isolated from the analog input and clock input pins. |
|              | 12  |                    |      |   |
| VNEG_OUT     | 29  |                    | O    | <b>VNEG_OUT</b><br>The voltage on this output can range from $-1V$ to $+1V$ . This pin must be decoupled to ground with a 4.7- $\mu$ F, low ESL, low ESR multi-layer ceramic chip capacitor and connected to the VNEG input pins. This voltage must be isolated from any noisy digital signals, clocks, and the analog input.             |

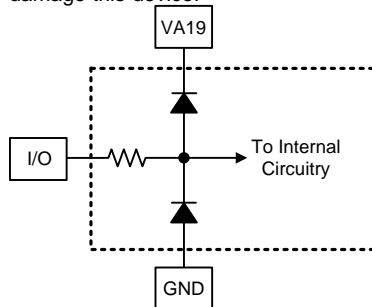
## 6 Specifications

### 6.1 Absolute Maximum Ratings

The soldering process must comply with TI's Reflow Temperature Profile specifications. Refer to [www.ti.com/packaging](http://www.ti.com/packaging).<sup>(1)(2)(3)</sup>

|                                       |  | MIN        | MAX                 | UNIT  |
|---------------------------------------|--|------------|---------------------|-------|
| Supply voltage                        | 1.2-V supply   | VA12, VD12 | 1.4                 | V     |
|                                       | 1.9-V supply   | VA19       | 2.2                 | V     |
|                                       | 1.2-V supply difference between VA12 and VD12  |            | -200                | 200   |
| Voltage                               | On any input pin (except VIN+ or VIN-)   | -0.15      | $V_{(VA19)} + 0.15$ | V     |
|                                       | On VIN+ or VIN-  | 0          | 2                   | V     |
| Voltage difference                    | $ (VIN+) - (VIN-) $ <sup>(4)</sup>   |            | 2                   | V     |
|                                       | $ (DEVCLK+) - (DEVCLK-) $  |            | 2                   |       |
|                                       | $ (SYSREF+) - (SYSREF-) $  |            | 2                   |       |
|                                       | $ (-SYNC+) - (-SYNC-) $  |            | 1                   |       |
| RF input power, P <sub>I</sub>        | On VIN+, VIN-, with proper input common mode maintained. F <sub>IN</sub> ≥ 3 GHz, Z <sub>(SOURCE)</sub> = 100 Ω, Input_Clamp_EN = 0 or 1 |            | 11.07               | dBm   |
|                                       | On VIN+, VIN-, with proper input common mode maintained. F <sub>IN</sub> = 1 GHz, Z <sub>(SOURCE)</sub> = 100 Ω, Input_Clamp_EN = 1      |            | 14.95               |       |
|                                       | On VIN+, VIN-, with proper input common mode maintained. F <sub>IN</sub> ≤ 100 MHz, Z <sub>(SOURCE)</sub> = 100 Ω, Input_Clamp_EN = 1    |            | 20.97               |       |
| Input current                         | At any pin other than VIN+ or VIN- <sup>(5)</sup>  | -25        | 25                  | mA    |
|                                       | VIN+ or VIN-   | -50        | 50                  | mA DC |
|                                       | Package <sup>(5)</sup> (sum of absolute value of all currents forced in or out, not including power supply current)                      |            | 100                 | mA    |
| Junction temperature, T <sub>J</sub>  | Power applied. Verified by High Temperature Operation Life testing to 1000 hours.  | -40        | 150                 | °C    |
| Storage temperature, T <sub>stg</sub> |  | -65        | 150                 | °C    |

- (1) Reflow temperature profiles are different for lead-free and non-lead-free packages.
- (2) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (4) The analog inputs are protected as in the following circuit. Input-voltage magnitudes beyond the *Absolute Maximum Ratings* may damage this device.



- (5) When the input voltage at any pin (other than VIN+ or VIN-) exceeds the power supply limits (that is, less than GND or greater than VA19), the current at that pin must be limited to 25 mA. The 100-mA maximum package input current rating limits the number of pins that can safely exceed the power supplies. This limit is not placed upon the power pins or thermal pad (GND).

## 6.2 ESD Ratings

|                    |                         | VALUE  | UNIT  |
|--------------------|-------------------------|--|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ±2000 |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±500  |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

All voltages are measured with respect to GND = 0 V, unless otherwise specified.

|   |   | MIN                        | MAX                        | UNIT            |   |
|---|---|----------------------------|----------------------------|-----------------|---|
| V <sub>DD</sub>                           | Supply voltage                                  | 1.2-V supply: VA12, VD12   | 1.14                       | 1.26            | V |
|   |   | 1.9-V supply: VA19         | 1.8                        | 2               | V |
| Supply sequence (power-up and power-down) |   |                            | 1.9 supply ≥ 1.2 supply    | V               |   |
| V <sub>CM1</sub>                          | Analog input common mode voltage                | V <sub>(VCMO)</sub> – 0.15 | V <sub>(VCMO)</sub> + 0.15 | V               |   |
|   | VIN+, VIN– voltage (maintaining common mode)    | 0                          | V <sub>(VA19)</sub>        | V               |   |
|   | DEVCLK±, SYSREF±, ~SYNC± pin voltage range      | 0                          | V <sub>(VA19)</sub>        | V               |   |
| V <sub>ID(CLK)</sub>                      | Differential DEVCLK±, SYSREF±, ~SYNC± amplitude | 0.4                        | 2                          | V <sub>PP</sub> |   |
| V <sub>CM(CLK)</sub>                      | SYSREF±, ~SYNC± Common Mode                     | 0.64                       | 1.1                        | V               |   |
| T <sub>A</sub>                            | Ambient temperature                             | –40                        | 85                         | °C              |   |
| T <sub>J</sub>                            | Junction temperature                            |                            | 135                        | °C              |   |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |   | ADC12J1x00 | UNIT |
|-------------------------------|---|------------|------|
|                               |   | NKE (VQFN) |      |
|                               |   | 68 PINS    |      |
| R <sub>θJA</sub>              | Thermal resistance, junction-to-ambient       | 19.8       | °C/W |
| R <sub>θJcbot</sub>           | Thermal resistance, junction-to-case (bottom) | 2.7        | °C/W |
| Ψ <sub>JB</sub>               | Characterization parameter, junction-to-board | 9.1        | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics

Unless otherwise noted, these specifications apply for V<sub>(VA12)</sub> = V<sub>(VD12)</sub> = 1.2 V, V<sub>(VA19)</sub> = 1.9 V, VIN full scale range at default setting (725 mV<sub>PP</sub>), VIN = –1 dBFS, differential AC-coupled sinewave input clock, f<sub>(DEVCLK)</sub> = 2.7 or 1.6 GHz at 0.5 V<sub>PP</sub> with 50% duty cycle, R<sub>(RBIAS)</sub> = 3.3 kΩ ±0.1%, after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at T<sub>A</sub> = 25°C. <sup>(1)(2)</sup>

| PARAMETER                                  | TEST CONDITIONS                        | MIN  | TYP | MAX   | UNIT |
|--|--|--|-----|-------|------|
| <b>DYNAMIC PERFORMANCE CHARACTERISTICS</b> |  |  |     |       |      |
| RES  | ADC core resolution                    | Resolution with no missing codes   |     | 12    | bits |
| INL  | Integral non-linearity                 | T <sub>A</sub> = 25°C  |     | ±2    | LSB  |
|  |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>  |     | ±3    |      |
| DNL  | Differential non-linearity             | T <sub>A</sub> = 25°C  |     | ±0.25 | LSB  |
|  |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>  |     | ±0.3  |      |
| Peak NPR                                   | Peak noise power ratio                 | 500-kHz tone spacing from 1 MHz to f <sub>S</sub> / 2–1 MHz, DDC bypass mode<br>25-MHz wide notch at 320 MHz |     | 46    | dB   |
| IMD <sub>3</sub>                           | Third-order intermodulation distortion | F1 = 2110 MHz at –13 dBFS<br>F2 = 2170 MHz at –13 dBFS   |     | –64   | dBc  |

(1) To ensure accuracy, the VA19, VA12, and VD12 pins are required to be well bypassed. Each supply pin must be decoupled with one or more bypass capacitors.

(2) Interleave related fixed frequency spurs at f<sub>S</sub> / 4 and f<sub>S</sub> / 2 are excluded from all SNR, SINAD, ENOB and SFDR specifications. The magnitude of these spurs is provided separately.

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN full scale range at default setting ( $725\text{ mV}_{PP}$ ), VIN = -1 dBFS, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(BIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER  | TEST CONDITIONS  | MIN   | TYP  | MAX   | UNIT |
|--|--|---|------|-------|------|
| <b>DDC BYPASS Mode, ADC12J2700, <math>f_{(DEVCLK)} = 2.7\text{ GHz}</math></b> |  |   |      |       |      |
| SNR  | $F_{IN} = 350\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  |   | 55.1 |       | dBFS |
|  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | 54.9 |       |      |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                | 52.5 |       |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | 54.8 |       |      |
|  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG              | 52.4  |      |       |      |
|  | $F_{IN} = 1500\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode |   | 52.5 |       |      |
| $F_{IN} = 2400\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode                   |  | 50  |      |       |      |
| SINAD  | $F_{IN} = 350\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  |   | 55   |       | dBFS |
|  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | 54.8 |       |      |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                | 52.3 |       |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | 54.7 |       |      |
|  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG              | 52.2  |      |       |      |
|  | $F_{IN} = 1500\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode |   | 52.4 |       |      |
| $F_{IN} = 2400\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode                   |  | 50  |      |       |      |
| ENOB   | $F_{IN} = 350\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  |   | 8.8  |       | Bits |
|  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | 8.8  |       |      |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                | 8.4  |       |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | 8.8  |       |      |
|  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG              | 8.4   |      |       |      |
|  | $F_{IN} = 1500\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode |   | 8.4  |       |      |
| $F_{IN} = 2400\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode                   |  | 8   |      |       |      |
| SFDR   | $F_{IN} = 350\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  |   | 66.7 |       | dBFS |
|  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | 71.6 |       |      |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                | 61   |       |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | 70   |       |      |
|  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG              | 59  |      |       |      |
|  | $F_{IN} = 1500\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode |   | 65.2 |       |      |
| $F_{IN} = 2400\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode                   |  | 58.6  |      |       |      |
| $f_s/2$  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -77  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -59.5 |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -74  |       |      |
| $f_s/4$  | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -70  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -54.5 |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -68  |       |      |
| $f_s/2 - F_{IN}$   | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -78  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -62   |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -76  |       |      |
| $f_s/4 + F_{IN}$   | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -76  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -61   |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -71  |       |      |
| $f_s/4 - F_{IN}$   | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -77  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -61.4 |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -76  |       |      |
| $f_s/4 - F_{IN}$   | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -77  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -61.4 |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -76  |       |      |
| $f_s/4 - F_{IN}$   | $F_{IN} = 600\text{ MHz}$ , -1 dBFS, 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                    | -77  |       | dBFS |
|  |  | $T_A = T_{MIN}$ to $T_{MAX}$                |      | -61.4 |      |
|  |  | $T_A = 25^\circ\text{C}$ , calibration = BG | -76  |       |      |

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN full scale range at default setting (725 mV<sub>PP</sub>), VIN = -1 dBFS, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or 1.6 GHz at 0.5 V<sub>PP</sub> with 50% duty cycle,  $R_{(BIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER  |   | TEST CONDITIONS   |  | MIN  | TYP | MAX    | UNIT    |
|--|---|---|--|--|-----|--------|---------|
| THD  | Total harmonic distortion   | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | -73    | dBFS    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | -70    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | -61    |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | -72    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | -62    |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | -68    |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | -68  |     |        |         |
| HD2  | Second harmonic distortion  | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | -72    | dBFS    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | -79    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | -62    |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | -81    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | -64    |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | -76    |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | -70  |     |        |         |
| HD3  | Third harmonic distortion   | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | -72    | dBFS    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | -75    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | -63    |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | -81    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | -64    |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | -70    |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | -76  |     |        |         |
| NSD  | Noise spectral density, average NSD across Nyquist bandwidth  | 12-bit DDC bypass mode, ADC12J2700, $f_{(DEVCLK)} = 2.7\text{ GHz}$ |  | 50-Ω AC-coupled terminated input   |     | -147.3 | dBFS/Hz |
|  |   |   |  |  |     | -149.1 | dBm/Hz  |
|  |   |   |  | F <sub>IN</sub> = 600 MHz, -1 dBFS                                       |     | -146.2 | dBFS/Hz |
|  |   |   |  |  |     | -148.0 | dBm/Hz  |
| <b>DDC BYPASS MODE, ADC12J1600, <math>f_{(DEVCLK)} = 1.6\text{ GHz}</math></b> |   |   |  |  |     |        |         |
| SNR  | Signal-to-noise ratio, integrated across entire Nyquist bandwidth<br>Input frequency-dependent interleaving spurs included                | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | 55.3   | dBFS    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | 54.9   |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | 52.3   |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | 54.8   |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | 52.2   |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | 52.5   |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | 49.8   |     |        |         |
| SINAD  | Signal-to-noise and distortion ratio, integrated across entire Nyquist bandwidth<br>Input frequency-dependent interleaving spurs included | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | 55.2   | dBFS    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | 54.8   |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | 52.1   |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | 54.7   |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | 52     |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | 52.4   |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | 49.7   |     |        |         |
| ENOB   | Effective number of bits, integrated across entire Nyquist bandwidth<br>Input frequency-dependent interleaving spurs included             | F <sub>IN</sub> = 350 MHz, -1 dBFS, 12-bit DDC bypass mode          |  |  |     | 8.9    | Bits    |
|  |   | F <sub>IN</sub> = 600 MHz, -1 dBFS, 12-bit DDC bypass mode          |  | T <sub>A</sub> = 25°C  |     | 8.8    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>                    |     | 8.4    |         |
|  |   |   |  | T <sub>A</sub> = 25°C, calibration = BG                                  |     | 8.8    |         |
|  |   |   |  | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> , calibration = BG |     | 8.4    |         |
|  |   | F <sub>IN</sub> = 1500 MHz, -1 dBFS, 12-bit DDC bypass mode         |  |  |     | 8.4    |         |
| F <sub>IN</sub> = 2400 MHz, -1 dBFS, 12-bit DDC bypass mode                    |   |   |  | 8  |     |        |         |

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ ,  $V_{IN}$  full scale range at default setting ( $725\text{ mV}_{PP}$ ),  $V_{IN} = -1\text{ dBFS}$ , differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or  $1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER  | TEST CONDITIONS   |  | MIN   | TYP  | MAX  | UNIT |       |
|--|---|--|---|------|------|------|-------|
| SFDR   | Spurious-free dynamic range<br>Input frequency-dependent<br>interleaving spurs included | $F_{IN} = 350\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  |   | 72.9 |      | dBFS |       |
|  |   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | 74.8 |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | 61.8  |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | 71   |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | 60.7  |
|  |   | $F_{IN} = 1500\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |      | 66.7 |      |       |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |  | 59.8  |      |      |      |       |
| $f_{s/2}$  | Interleaving offset spur at $\frac{1}{2}$<br>sampling rate                              | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -77  | dBFS |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -59.8 |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -73  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -57.3 |
| $f_{s/4}$  | Interleaving offset spur at $\frac{1}{4}$<br>sampling rate                              | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -72  | dBFS |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -54.3 |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -69  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -54   |
| $f_{s/2} - F_{IN}$   | Interleaving offset spur at $\frac{1}{2}$<br>sampling rate – input<br>frequency         | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -77  | dBFS |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -62   |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -79  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -62   |
| $f_{s/4} + F_{IN}$   | Interleaving offset spur at $\frac{1}{4}$<br>sampling rate + input<br>frequency         | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -76  | dBFS |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -61.8 |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -74  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -61   |
| $f_{s/4} - F_{IN}$   | Interleaving offset spur at $\frac{1}{4}$<br>sampling rate – input<br>frequency         | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -76  | dBFS |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -62   |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -77  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -61   |
| THD  | Total harmonic distortion   | $F_{IN} = 350\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  |   | -72  |      | dBFS |       |
|  |   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -72  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -60.9 |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -71  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -61   |
|  |   | $F_{IN} = 1500\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |      | -69  |      |       |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |  | -69   |      |      |      |       |
| HD2  | Second harmonic distortion  | $F_{IN} = 350\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  |   | -79  |      | dBFS |       |
|  |   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -78  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -62   |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -79  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -63   |
|  |   | $F_{IN} = 1500\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |      | -73  |      |       |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |  | -70   |      |      |      |       |
| HD3  | Third harmonic distortion   | $F_{IN} = 350\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  |   | -76  |      | dBFS |       |
|  |   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode  | $T_A = 25^\circ\text{C}$                        |      | -81  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$                    |      |      |      | -65   |
|  |   |  | $T_A = 25^\circ\text{C}$ , calibration = BG     |      | -76  |      |       |
|  |   |  | $T_A = T_{MIN}$ to $T_{MAX}$ , calibration = BG |      |      |      | -61   |
|  |   | $F_{IN} = 1500\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |      | -72  |      |       |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , 12-bit DDC bypass mode |   |  | -76   |      |      |      |       |

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ ,  $V_{IN}$  full scale range at default setting ( $725\text{ mV}_{PP}$ ),  $V_{IN} = -1\text{ dBFS}$ , differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or  $1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER   |   | TEST CONDITIONS   |  | MIN | TYP    | MAX | UNIT    |
|---|---|---|--|-----|--------|-----|---------|
| NSD   | Noise spectral density, average NSD across Nyquist bandwidth  | 12-bit DDC bypass mode, ADC12J1600, $f_{(DEVCLK)} = 1.6\text{ GHz}$ | 50- $\Omega$ AC-coupled terminated input                           |     | -145   |     | dBFS/Hz |
|   |   |   |  |     | -146.8 |     | dBm/Hz  |
|   |   |   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$                       |     | -143.9 |     | dBFS/Hz |
|   |   |   |  |     | -145.7 |     | dBm/Hz  |
| <b>DECIMATE-BY-8 MODE, ADC12J2700, <math>f_{(DEVCLK)} = 2.7\text{ GHz}</math></b> |   |   |  |     |        |     |         |
| SNR   | Signal-to-noise ratio, integrated across DDC output bandwidth<br>Interleaving spurs included                | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 62.8   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 62.7   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , Decimate-by-8 mode |     | 53.3   |     |         |
| SINAD   | Signal-to-noise and distortion ratio, integrated across DDC output bandwidth<br>Interleaving spurs included | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 62.8   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 62.7   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode |     | 53.3   |     |         |
| ENOB  | Effective number of bits, integrated across DDC output bandwidth<br>Interleaving spurs included             | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 10.1   |     | Bits    |
|   |   |   | Calibration = BG   |     | 10.1   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode |     | 8.6    |     |         |
| SFDR  | Spurious-free dynamic range<br>Interleaving spurs included  | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 75.9   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 74.7   |     |         |
| $f_{s/2}$   | Interleaving offset spur at $\frac{1}{2}$ sampling rate <sup>(3)</sup>                                      | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -73    |     | dBFS    |
| $f_{s/4}$   | Interleaving offset spur at $\frac{1}{4}$ sampling rate <sup>(3)</sup>                                      | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -70    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -70    |     |         |
| $f_{s/2} - F_{IN}$  | Interleaving spur at $\frac{1}{2}$ sampling rate – input frequency <sup>(3)</sup>                           | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -80    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -79    |     |         |
| $f_{s/4} + F_{IN}$  | Interleaving spur at $\frac{1}{4}$ sampling rate + input frequency <sup>(3)</sup>                           | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -73    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -70    |     |         |
| $f_{s/4} - F_{IN}$  | Interleaving spur at $\frac{1}{4}$ sampling rate – input frequency <sup>(3)</sup>                           | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -77    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -77    |     |         |
| THD   | Total harmonic distortion <sup>(3)</sup>  | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -70    |     | dBFS    |
|   |   |   | calibration = BG   |     | -71    |     |         |
| HD2   | Second harmonic distortion <sup>(3)</sup>   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -78    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -76    |     |         |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode                |   |   |  | -67 |        |     |         |
|   | HD3   | Third harmonic distortion <sup>(3)</sup>                            | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode  |     |        | -74 |         |
| Calibration = BG  |   |   |  |     | -81    |     |         |
| $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode                |   |   |  |     | -73    |     |         |
| <b>DECIMATE-BY-8 MODE, ADC12J1600, <math>f_{(DEVCLK)} = 1.6\text{ GHz}</math></b> |   |   |  |     |        |     |         |
| SNR   | Signal-to-noise ratio, integrated across DDC output bandwidth<br>Interleaving spurs included                | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 63.5   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 63.4   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode |     | 55.8   |     |         |
| SINAD   | Signal-to-noise and distortion ratio, integrated across DDC output bandwidth<br>Interleaving spurs included | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 63.5   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 63.4   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode |     | 55.8   |     |         |
| ENOB  | Effective number of bits, integrated across DDC output bandwidth<br>Interleaving spurs included             | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 10.3   |     | Bits    |
|   |   |   | Calibration = BG   |     | 10.2   |     |         |
|   |   |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode |     | 9.0    |     |         |
| SFDR  | Spurious-free dynamic range<br>Interleaving Spurs Included  | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | 76.2   |     | dBFS    |
|   |   |   | Calibration = BG   |     | 76.7   |     |         |
| $f_{s/2}$   | Interleaving offset spur at $\frac{1}{2}$ sampling rate <sup>(3)</sup>                                      | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |  |     | -73    |     | dBFS    |
|   |   |   | Calibration = BG   |     | -72    |     |         |

(3) Magnitude of reported tones in output spectrum of ADC core. This tone will only be present in the DDC output for specific Decimation and NCO settings. Careful frequency planning can be used to intentionally place unwanted tones outside the DDC output spectrum.

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN full scale range at default setting ( $725\text{ mV}_{PP}$ ),  $V_{IN} = -1\text{ dBFS}$ , differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER  |   | TEST CONDITIONS  | MIN   | TYP   | MAX   | UNIT                  |
|--|---|--|-------|-------|-------|-----------------------|
| $f_{s/4}$  | Interleaving offset spur at $\frac{1}{4}$ sampling rate <sup>(3)</sup>            | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -70   |       | dBFS                  |
|  |   | Calibration = BG   |       | -69   |       |                       |
| $f_{s/2} - F_{IN}$                               | Interleaving spur at $\frac{1}{2}$ sampling rate – input frequency <sup>(3)</sup> | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -78   |       | dBFS                  |
|  |   | Calibration = BG   |       | -79   |       |                       |
| $f_{s/4} + F_{IN}$                               | Interleaving spur at $\frac{1}{4}$ sampling rate + input frequency <sup>(3)</sup> | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -76   |       | dBFS                  |
|  |   | Calibration = BG   |       | -77   |       |                       |
| $f_{s/4} - F_{IN}$                               | Interleaving spur at $\frac{1}{4}$ sampling rate – input frequency <sup>(3)</sup> | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -77   |       | dBFS                  |
|  |   | Calibration = BG   |       | -72   |       |                       |
| THD  | Total harmonic distortion <sup>(3)</sup>  | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -71   |       | dBFS                  |
|  |   | Calibration = BG   |       | -71   |       |                       |
|  |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |       | -63   |       |                       |
| HD2  | Second harmonic distortion <sup>(3)</sup>   | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -77   |       | dBFS                  |
|  |   | Calibration = BG   |       | -78   |       |                       |
|  |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |       | -65   |       |                       |
| HD3  | Third harmonic distortion <sup>(3)</sup>  | $F_{IN} = 600\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode    |       | -80   |       | dBFS                  |
|  |   | Calibration = BG   |       | -77   |       |                       |
|  |   | $F_{IN} = 2400\text{ MHz}$ , $-1\text{ dBFS}$ , decimate-by-8 mode   |       | -74   |       |                       |
| <b>DDC CHARACTERISTICS</b>                       |   |  |       |       |       |                       |
|  | Alias protection <sup>(4)</sup>   |  | 80    |       |       | dB                    |
|  | Alias protected bandwidth <sup>(4)</sup>  |  | 80    |       |       | % of output BW        |
| SFDR-DDC   | Spurious-free dynamic range of digital down-converter <sup>(4)</sup>              |  | 100   |       |       | dB                    |
|  | Implementation loss <sup>(4)</sup>  |  |       |       | 0.5   | dB                    |
| <b>ANALOG INPUT CHARACTERISTICS</b>              |   |  |       |       |       |                       |
| $V_{ID(VIN)}$                                    | Full-scale analog-differential input range  | Minimum FSR setting <sup>(5)</sup>                                   |       | 500   |       | $\text{mV}_{PP}$      |
|  |   | Default FSR setting, $T_A = T_{MIN}$ to $T_{MAX}$                    | 650   | 725   | 800   |                       |
|  |   | Maximum FSR setting <sup>(5)</sup>                                   |       | 950   |       |                       |
| $C_{I(VIN)}$                                     | Analog input capacitance <sup>(4)</sup>   | Differential   |       | 0.05  |       | pF                    |
|  |   | Each input pin to ground   |       | 1.5   |       | pF                    |
| $R_{ID(VIN)}$                                    | Differential input resistance   |  | 80    | 95    | 110   | $\Omega$              |
| FPBW   | Full power bandwidth  | $-3\text{ dB}$ — calibration = BG                                    |       | 2.8   |       | GHz                   |
|  |   | $-3\text{ dB}$ — calibration = FG                                    |       | 3.2   |       |                       |
| Gain flatness                                    | Gain flatness   | DC to 2 GHz  |       | 1.2   |       | dB                    |
|  |   | 2 GHz to 4 GHz   |       | 3.8   |       |                       |
|  |   | DC to 2 GHz — calibration = BG                                       |       | 1.5   |       |                       |
|  |   | 2 GHz to 4 GHz — calibration = BG                                    |       | 4.5   |       |                       |
| <b>ANALOG OUTPUT CHARACTERISTICS (VCMO, VBG)</b> |   |  |       |       |       |                       |
| $V_{(VCMO)}$                                     | Common-mode output voltage  | $I_{(VCMO)} = \pm 100\ \mu\text{A}$ , $T_A = 25^\circ\text{C}$       |       | 1.225 |       | V                     |
|  |   | $I_{(VCMO)} = \pm 100\ \mu\text{A}$ , $T_A = T_{MIN}$ to $T_{MAX}$   | 1.185 |       | 1.265 |                       |
| $TCV_{O(VCMO)}$                                  | Common-mode output-voltage temperature coefficient                                | $T_A = T_{MIN}$ to $T_{MAX}$   |       | -21   |       | ppm/ $^\circ\text{C}$ |
| $C_{(LOAD\_VCMO)}$                               | Maximum VCMO output load capacitance  |  |       |       | 80    | pF                    |
| $V_{(VBG)}$                                      | Bandgap reference output voltage  | $I_{(VBG)} = \pm 100\ \mu\text{A}$ , $T_A = 25^\circ\text{C}$        |       | 1.248 |       | V                     |
|  |   | $I_{(VBG)} = \pm 100\ \mu\text{A}$ , $T_A = T_{MIN}$ to $T_{MAX}$    | 1.195 |       | 1.3   |                       |
| $TCV_{ref(VBG)}$                                 | Bandgap reference voltage temperature coefficient                                 | $T_A = T_{MIN}$ to $T_{MAX}$ ,<br>$I_{(VBG)} = \pm 100\ \mu\text{A}$ |       | 0     |       | ppm/ $^\circ\text{C}$ |
| $C_{(LOAD\_BG)}$                                 | Maximum bandgap reference output load capacitance                                 |  |       |       | 80    | pF                    |

(4) This parameter is specified by design and is not tested in production.

(5) This parameter is specified by design, characterization, or both and is not tested in production.

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN full scale range at default setting ( $725\text{ mV}_{PP}$ ), VIN = -1 dBFS, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or  $1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER   | TEST CONDITIONS                     | MIN   | TYP  | MAX  | UNIT                       |          |
|---|-------------------------------------|---|--|------|----------------------------|----------|
| <b>TEMPERATURE DIODE CHARACTERISTICS</b>  |                                     |   |  |      |                            |          |
| $V_{(TDIODE)}$  | Temperature diode voltage slope     | Offset voltage (approx. 0.77 V) varies with process and must be measured for each part. Offset measurement should be done with PowerDown=1 to minimize device self-heating. | 100- $\mu\text{A}$ forward current<br>Device active        | -1.6 | $\text{mV}/^\circ\text{C}$ |          |
|   |                                     |   | 100- $\mu\text{A}$ forward current<br>Device in power-down | -1.6 | $\text{mV}/^\circ\text{C}$ |          |
| <b>CLOCK INPUT CHARACTERISTICS (DEVCLK<math>\pm</math>, SYSREF<math>\pm</math>, SYNC-/TMST<math>\pm</math>)</b> |                                     |   |  |      |                            |          |
| $V_{(IDCLK)}$   | Differential clock input level      | Sine wave clock, $T_A = T_{MIN}$ to $T_{MAX}$   | 0.4  | 0.6  | 2                          | $V_{PP}$ |
|   |                                     | Square wave clock, $T_A = T_{MIN}$ to $T_{MAX}$   | 0.4  | 0.6  | 2                          | $V_{PP}$ |
| $I_{I(CLK)}$  | Input current                       | $V_I = 0$ or $V_I = V_A$  | $\pm 1$  |      | $\mu\text{A}$              |          |
| $C_{I(CLK)}$  | Input capacitance <sup>(4)</sup>    | Differential  | 0.02   |      | pF                         |          |
|   |                                     | Each input to ground  | 1  |      | pF                         |          |
| $R_{(IDCLK)}$   | Differential input resistance       | $T_A = 25^\circ\text{C}$  | 95   |      | $\Omega$                   |          |
|   |                                     | $T_A = T_{MIN}$ to $T_{MAX}$  | 80   | 110  | $\Omega$                   |          |
| <b>CML OUTPUT CHARACTERISTICS (DS0–DS7<math>\pm</math>)</b>   |                                     |   |  |      |                            |          |
| $V_{OD}$  | Differential output voltage         | Assumes ideal 100- $\Omega$ load<br>Measured differentially<br>Default pre-emphasis setting   | 280  | 305  | 330                        | mV peak  |
| $V_{O(ofs)}$  | Output offset voltage               |   | 0.6  |      | V                          |          |
| $I_{OS}$  | Output short-circuit current        | Output+ and output– shorted together  | $\pm 6$  |      | mA                         |          |
|   |                                     | Output+ or output– shorted to 0 V   | 12   |      |                            |          |
| $Z_{OD}$  | Differential output impedance       |   | 100  |      | $\Omega$                   |          |
| <b>LVMOS INPUT CHARACTERISTICS (SDI, SCLK, SCS, SYNC–)</b>  |                                     |   |  |      |                            |          |
| $V_{IH}$  | Logic high input voltage            | See <sup>(5)</sup>  | 0.83   |      | V                          |          |
| $V_{IL}$  | Logic low input voltage             | See <sup>(5)</sup>  |  | 0.4  | V                          |          |
| $C_1$   | Input capacitance <sup>(4)(6)</sup> | Each input to ground  | 1  |      | pF                         |          |
| <b>LVMOS OUTPUT CHARACTERISTICS (SDO, OR_T0, OR_T1)</b>   |                                     |   |  |      |                            |          |
| $V_{OH}$  | CMOS H level output                 | $I_{OH} = -400\text{ }\mu\text{A}$ <sup>(5)</sup>   | 1.65   | 1.9  | V                          |          |
| $V_{OL}$  | CMOS L level output                 | $I_{OH} = 400\text{ }\mu\text{A}$ <sup>(5)</sup>  | 0.01   | 0.15 | V                          |          |
| <b>POWER SUPPLY CHARACTERISTICS</b>   |                                     |   |  |      |                            |          |
| <b>ADC12J2700, <math>f_{(DEVCLK)} = 2.7\text{ GHz}</math></b>   |                                     |   |  |      |                            |          |
| $I_{(VA19)}$  | Analog 1.9-V supply current         | PD = 0, calibration = FG, bypass DDC  | 457  | 495  | mA                         |          |
|   |                                     | PD = 0, calibration = BG, bypass DDC  | 557  | 594  |                            |          |
|   |                                     | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1   | 557  | 598  |                            |          |
| $I_{(VA12)}$  | Analog 1.2-V supply current         | PD = 0, calibration = FG, bypass DDC  | 245  | 296  | mA                         |          |
|   |                                     | PD = 0, calibration = BG, bypass DDC  | 261  | 312  |                            |          |
|   |                                     | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1   | 270  | 322  |                            |          |
| $I_{(VD12)}$  | Digital 1.2-V supply current        | PD = 0, calibration = FG, bypass DDC  | 330  | 541  | mA                         |          |
|   |                                     | PD = 0, calibration = BG, bypass DDC  | 341  | 588  |                            |          |
|   |                                     | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1   | 366  | 610  |                            |          |
| $P_C$   | Power consumption                   | PD = 0, calibration = FG, bypass DDC  | 1.56   | 1.94 | W                          |          |
|   |                                     | PD = 0, calibration = BG, bypass DDC  | 1.78   | 2.21 |                            |          |
|   |                                     | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1   | 1.82   | 2.25 |                            |          |
|   |                                     | PD = 1  | < 50   |      |                            | mW       |

(6) The digital control pin capacitances are die capacitances only and is in addition to package and bond-wire capacitance of approximately 0.4 pF.

## Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN full scale range at default setting ( $725\text{ mV}_{PP}$ ), VIN = -1 dBFS, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or  $1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground (FG) mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .<sup>(1)(2)</sup>

| PARAMETER   | TEST CONDITIONS              | MIN   | TYP  | MAX  | UNIT |
|---|------------------------------|---|------|------|------|
| <b>ADC12J1600, <math>f_{(DEVCLK)} = 1.6\text{ GHz}</math></b> |                              |   |      |      |      |
| $I_{(VA19)}$  | Analog 1.9-V supply current  | PD = 0, calibration = FG, bypass DDC                      | 454  | 493  | mA   |
|   |                              | PD = 0, calibration = BG, bypass DDC                      | 553  | 591  |      |
|   |                              | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1 | 553  | 598  |      |
| $I_{(VA12)}$  | Analog 1.2-V supply current  | PD = 0, calibration = FG, bypass DDC                      | 180  | 222  | mA   |
|   |                              | PD = 0, calibration = BG, bypass DDC                      | 190  | 233  |      |
|   |                              | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1 | 196  | 243  |      |
| $I_{(VD12)}$  | Digital 1.2-V supply current | PD = 0, calibration = FG, bypass DDC                      | 225  | 460  | mA   |
|   |                              | PD = 0, calibration = BG, bypass DDC                      | 237  | 529  |      |
|   |                              | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1 | 255  | 568  |      |
| $P_C$   | Power consumption            | PD = 0, calibration = FG, bypass DDC                      | 1.35 | 1.75 | W    |
|   |                              | PD = 0, calibration = BG, bypass DDC                      | 1.56 | 2.04 |      |
|   |                              | PD = 0, calibration = BG, decimate by 8, DDR = 0, P54 = 1 | 1.59 | 2.11 |      |
|   |                              | PD = 1  | < 50 |      | mW   |

## 6.6 Timing Requirements

|                                   |   | MIN   | NOM | MAX  | UNIT           |
|-----------------------------------|---|---|-----|------|----------------|
| <b>DEVICE (SAMPLING) CLOCK</b>    |   |   |     |      |                |
| $f_{(DEVCLK)}$                    | Input DEVCLK frequency                  | Sampling rate is equal to clock input, ADC12J2700 | 1   | 2.7  | GHz            |
|                                   |   | Sampling rate is equal to clock input, ADC12J1600 | 1   | 1.6  |                |
| $t_{d(A)}$                        | Sampling (aperture) delay               | Input CLK transition to sampling instant          |     | 0.64 | ns             |
| $t_{(AJ)}$                        | Aperture jitter                         |   |     | 0.1  | ps RMS         |
| $t_{(LAT)}$                       | ADC core latency <sup>(1)</sup>         | Decimation = 1, DDR = 1, P54 = 0                  |     | 64   | $t_{(DEVCLK)}$ |
| $t_{(LAT\_DDC)}$                  | ADC core and DDC latency <sup>(1)</sup> | Decimation = 4, DDR = 1, P54 = 0                  |     | 292  | $t_{(DEVCLK)}$ |
|                                   |   | Decimation = 4, DDR = 1, P54 = 1                  |     | 284  |                |
|                                   |   | Decimation = 8, DDR = 0, P54 = 0                  |     | 384  |                |
|                                   |   | Decimation = 8, DDR = 0, P54 = 1                  |     | 368  |                |
|                                   |   | Decimation = 8, DDR = 1, P54 = 0                  |     | 392  |                |
|                                   |   | Decimation = 8, DDR = 1, P54 = 1                  |     | 368  |                |
|                                   |   | Decimation = 10, DDR = 0, P54 = 0                 |     | 386  |                |
|                                   |   | Decimation = 10, DDR = 1, P54 = 0                 |     | 386  |                |
|                                   |   | Decimation = 16, DDR = 0, P54 = 0                 |     | 608  |                |
|                                   |   | Decimation = 16, DDR = 0, P54 = 1                 |     | 560  |                |
|                                   |   | Decimation = 16, DDR = 1, P54 = 0                 |     | 608  |                |
|                                   |   | Decimation = 16, DDR = 1, P54 = 1                 |     | 560  |                |
|                                   |   | Decimation = 20, DDR = 0, P54 = 0                 |     | 568  |                |
|                                   |   | Decimation = 20, DDR = 1, P54 = 0                 |     | 568  |                |
|                                   |   | Decimation = 32, DDR = 0, P54 = 0                 |     | 1044 |                |
| Decimation = 32, DDR = 0, P54 = 1 |   | 948   |     |      |                |
| Decimation = 32, DDR = 1, P54 = 0 |   | 1044  |     |      |                |

(1) Unless otherwise specified, delays quoted are exact un-rounded functional delays (assuming zero propagation delay).

**Timing Requirements (continued)**

|   |  | MIN                               | NOM | MAX                    | UNIT                     |
|---|--|-----------------------------------|-----|------------------------|--------------------------|
| <b>JESD204B INTERFACE LINK TIMING CHARACTERISTICS (REFER TO Figure 1)</b> |  |                                   |     |                        |                          |
| $t_{d(LMFC)}$   | SYSREF to LMFC delay<br>Functional delay between SYSREF assertion latched and LMFC frame boundary <sup>(1)</sup>   | All decimation modes              |     | 40                     | $t_{(DEVCLK)}$           |
| $t_{d(TX)}$   | LMFC to frame boundary delay - DDC bypass mode<br>Functional delay from LMFC frame boundary to beginning of next multi-frame in transmitted data. <sup>(2)</sup> | Decimation = 1, DDR = 1, P54 = 0  |     | 52.7                   | $t_{(DEVCLK)}$           |
| $t_{d(TX)}$   | LMFC to frame boundary delay - decimation modes<br>Functional delay from LMFC frame boundary to beginning of next multi-frame in transmitted data <sup>(2)</sup> | Decimation = 4, DDR = 1, P54 = 0  |     | 52.7                   | $t_{(DEVCLK)}$           |
|   |  | Decimation = 4, DDR = 1, P54 = 1  |     | 43.9                   |                          |
|   |  | Decimation = 8, DDR = 0, P54 = 0  |     | 60.7                   |                          |
|   |  | Decimation = 8, DDR = 0, P54 = 1  |     | 51.5                   |                          |
|   |  | Decimation = 8, DDR = 1, P54 = 0  |     | 52.7                   |                          |
|   |  | Decimation = 8, DDR = 1, P54 = 1  |     | 43.9                   |                          |
|   |  | Decimation = 10, DDR = 0, P54 = 0 |     | 60.7                   |                          |
|   |  | Decimation = 10, DDR = 1, P54 = 0 |     | 52.7                   |                          |
|   |  | Decimation = 16, DDR = 0, P54 = 0 |     | 60.7                   |                          |
|   |  | Decimation = 16, DDR = 0, P54 = 1 |     | 51.5                   |                          |
|   |  | Decimation = 16, DDR = 1, P54 = 0 |     | 52.7                   |                          |
|   |  | Decimation = 16, DDR = 1, P54 = 1 |     | 43.9                   |                          |
|   |  | Decimation = 20, DDR = 0, P54 = 0 |     | 60.7                   |                          |
| Decimation = 20, DDR = 1, P54 = 0   |  | 52.7                              |     |                        |                          |
| Decimation = 32, DDR = 0, P54 = 0   |  | 60.7                              |     |                        |                          |
| Decimation = 32, DDR = 0, P54 = 1   |  | 51.5                              |     |                        |                          |
| Decimation = 32, DDR = 1, P54 = 0   |  | 52.7                              |     |                        |                          |
| $t_{su(SYNC--F)}$   | SYNC- to LMFC setup time <sup>(3)</sup><br>Required SYNC- setup time relative to the internal LMFC boundary.   |                                   |     | 40                     | $t_{(DEVCLK)}$           |
| $t_{h(SYNC--F)}$  | SYNC- to LMFC hold time <sup>(3)</sup><br>Required SYNC- hold time relative to the internal LMFC boundary.   |                                   |     | -8                     |                          |
| $t_{(SYNC-)}$   | SYNC- assertion time<br>Required SYNC- assertion time before deassertion to initiate a link resynchronization.   |                                   |     | 4                      | Frame clock cycles       |
| $t_{d(LMFC)}$   | Delay from SYSREF sampled high by DEVCLK to internal LMFC boundary   |                                   |     | 40                     | $t_{(DEVCLK)}$           |
| $t_{(ILA)}$   | Duration of initial lane alignment sequence  |                                   |     | 4                      | Multi-frame clock cycles |
| <b>SYSREF</b>   |  |                                   |     |                        |                          |
| $t_{su(SYS)}$   | Setup time SYSREF relative to DEVCLK rising edge <sup>(4)</sup>  |                                   |     | 40                     | ps                       |
| $t_{h(SYS)}$  | Hold time SYSREF relative to DEVCLK rising edge <sup>(4)</sup>   |                                   |     | 40                     | ps                       |
| $t_{(PH\_SYS)}$   | SYSREF assertion duration after rising edge event.   |                                   |     | 8                      | $t_{(DEVCLK)}$           |
| $t_{(PL\_SYS)}$   | SYSREF deassertion duration after falling edge event.  |                                   |     | 8                      | $t_{(DEVCLK)}$           |
| $t_{(SYS)}$   | Period SYSREF±   | DDR = 0, P54 = 0                  |     | $K \times F \times 10$ | $t_{(DEVCLK)}$           |
|   |  | DDR = 0, P54 = 1                  |     | $K \times F \times 8$  |                          |
|   |  | DDR = 1, P54 = 0                  |     | $K \times F \times 5$  |                          |
|   |  | DDR = 1, P54 = 1                  |     | $K \times F \times 4$  |                          |

(2) The values given are functional delays only. Additional propagation delay of 0 to 3 clock cycles will be present.

(3) This parameter must be met to achieve deterministic alignment of the data frame and NCO phase to other similar devices. If this parameter is not met the device will still function correctly but will not be aligned to other devices.

(4) This parameter is specified by design, characterization, or both and is not tested in production.

**Timing Requirements (continued)**

|   |  | MIN | NOM | MAX | UNIT |
|---|--|-----|-----|-----|------|
| <b>SERIAL INTERFACE (REFER TO Figure 2)</b> |  |     |     |     |      |
| $f_{(SCK)}$                                 | Serial clock frequency <sup>(5)</sup>                        |     |     | 20  | MHz  |
| $t_{(PH)}$                                  | Serial clock high time                                       | 20  |     |     | ns   |
| $t_{(PL)}$                                  | Serial clock low time  | 20  |     |     | ns   |
| $t_{su}$                                    | Serial-data to serial-clock rising setup time <sup>(5)</sup> | 10  |     |     | ns   |
| $t_h$                                       | Serial-data to serial clock rising hold time <sup>(5)</sup>  | 10  |     |     | ns   |
| $t_{(CSS)}$                                 | $\overline{SCS}$ -to-serial clock rising setup time          | 10  |     |     | ns   |
| $t_{(CSH)}$                                 | $\overline{SCS}$ -to-serial clock falling hold time          | 10  |     |     | ns   |
| $t_{(IAG)}$                                 | Inter-access gap   | 10  |     |     | ns   |

(5) This parameter is specified by design and is not tested in production.

**6.7 Internal Characteristics**

| PARAMETER  | TEST CONDITIONS  | MIN                                      | NOM | MAX               | UNIT                     |
|--|--|--|-----|-------------------|--------------------------|
| <b>DEVICE (SAMPLING) CLOCK</b>   |  |  |     |                   |                          |
| $t_{d(A)}$   | Sampling (aperture) delay  | Input CLK transition to sampling instant |     | 0.64              | ns                       |
| $t_{(AJ)}$   | Aperture jitter  |  | 0.1 |                   | ps RMS                   |
| $t_{(LAT)}$  | ADC core latency. See <sup>(1)</sup>   | Decimation = 1, DDR = 1, P54 = 0         |     | 64                | $t_{(DEVCLK)}$           |
| <b>CALIBRATION TIMING CHARACTERISTICS (REFER TO THE CALIBRATION SECTION)</b> |  |  |     |                   |                          |
| $t_{(CAL)}$  | Calibration cycle time   | Calibration = FG, T_AUTO=1               |     | $227 \times 10^6$ | $t_{(DEVCLK)}$           |
|  |  | Calibration = FG, T_AUTO=0               |     | $102 \times 10^6$ |                          |
| <b>JESD204B INTERFACE LINK TIMING CHARACTERISTICS (REFER TO Figure 1)</b>    |  |  |     |                   |                          |
| $t_{d(LMFC)}$  | SYSREF to LMFC delay<br>Functional delay between SYSREF assertion latched and LMFC frame boundary <sup>(1)</sup>   | All decimation modes                     |     | 40                | $t_{(DEVCLK)}$           |
| $t_{d(TX)}$  | LMFC to Frame Boundary delay - DDC Bypass Mode<br>Functional delay from LMFC frame boundary to beginning of next multi-frame in transmitted data <sup>(2)</sup>  | Decimation = 1, DDR = 1, P54 = 0         |     | 52.7              | $t_{(DEVCLK)}$           |
| $t_{d(TX)}$  | LMFC to frame boundary delay - decimation modes<br>Functional delay from LMFC frame boundary to beginning of next multi-frame in transmitted data <sup>(2)</sup> | Decimation = 4, DDR = 1, P54 = 0         |     | 52.7              | $t_{(DEVCLK)}$           |
|  |  | Decimation = 4, DDR = 1, P54 = 1         |     | 43.9              |                          |
|  |  | Decimation = 8, DDR = 0, P54 = 0         |     | 60.7              |                          |
|  |  | Decimation = 8, DDR = 0, P54 = 1         |     | 51.5              |                          |
|  |  | Decimation = 8, DDR = 1, P54 = 0         |     | 52.7              |                          |
|  |  | Decimation = 8, DDR = 1, P54 = 1         |     | 43.9              |                          |
|  |  | Decimation = 10, DDR = 0, P54 = 0        |     | 60.7              |                          |
|  |  | Decimation = 10, DDR = 1, P54 = 0        |     | 52.7              |                          |
|  |  | Decimation = 16, DDR = 0, P54 = 0        |     | 60.7              |                          |
|  |  | Decimation = 16, DDR = 0, P54 = 1        |     | 51.5              |                          |
|  |  | Decimation = 16, DDR = 1, P54 = 0        |     | 52.7              |                          |
|  |  | Decimation = 16, DDR = 1, P54 = 1        |     | 43.9              |                          |
|  |  | Decimation = 20, DDR = 0, P54 = 0        |     | 60.7              |                          |
|  |  | Decimation = 20, DDR = 1, P54 = 0        |     | 52.7              |                          |
|  |  | Decimation = 32, DDR = 0, P54 = 0        |     | 60.7              |                          |
| Decimation = 32, DDR = 0, P54 = 1  |  | 51.5                                     |     |                   |                          |
| Decimation = 32, DDR = 1, P54 = 0  |  | 52.7                                     |     |                   |                          |
| $t_{d(LMFC)}$  | Delay from SYSREF sampled high by DEVCLK to internal LMFC boundary   |  | 40  |                   | $t_{(DEVCLK)}$           |
| $t_{(ILA)}$  | Duration of initial lane alignment sequence  |  | 4   |                   | Multi-frame clock cycles |

(1) Unless otherwise specified, delays quoted are exact un-rounded functional delays (assuming zero propagation delay).

(2) The values given are functional delays only. Additional propagation delay of 0 to 3 clock cycles will be present.

### 6.8 Switching Characteristics

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ ,  $V_{IN}\text{ FSR (AC coupled)} = \text{Default setting}$ , differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a foreground mode calibration with timing calibration enabled. Typical values are at  $T_A = 25^\circ\text{C}$ .

| PARAMETER                  | TEST CONDITIONS                   | MIN                | TYP               | MAX  | UNIT |    |
|----------------------------|-----------------------------------|--------------------|-------------------|------|------|----|
| <b>SERIAL DATA OUTPUTS</b> |                                   |                    |                   |      |      |    |
| Serialized output bit rate |                                   | 1                  |                   | 10   | Gbps |    |
| Serialized output bit rate | DDR = 0, P54 = 0                  |                    | $f_S$             |      |      |    |
|                            | DDR = 0, P54 = 1                  |                    | $1.25 \times f_S$ |      |      |    |
|                            | DDR = 1, P54 = 0                  |                    | $2 \times f_S$    |      |      |    |
|                            | DDR = 1, P54 = 1                  |                    | $2.5 \times f_S$  |      |      |    |
| $t_{TLH}$                  | LH transition time — differential | 10% to 90%, 8 Gbps |                   | 35   | ps   |    |
| $t_{THL}$                  | HL transition time — differential | 10% to 90%, 8 Gbps |                   | 35   | ps   |    |
| UI                         | Unit interval                     | 8 Gbps serial rate |                   | 125  | ps   |    |
| DDJ                        | Data dependent jitter             | 8 Gbps serial rate |                   | 11.3 | ps   |    |
| RJ                         | Random Jitter                     | 8 Gbps serial rate |                   | 1.4  | ps   |    |
| <b>SERIAL INTERFACE</b>    |                                   |                    |                   |      |      |    |
| $t_{(OZD)}$                | SDO tri-state to driven           | See Figure 2       |                   | 5    | ns   |    |
| $t_{(ODZ)}$                | SDO driven to tri-state           |                    |                   | 2.5  | 5    | ns |
| $t_{(OD)}$                 | SDO output delay                  |                    |                   | 20   |      | ns |

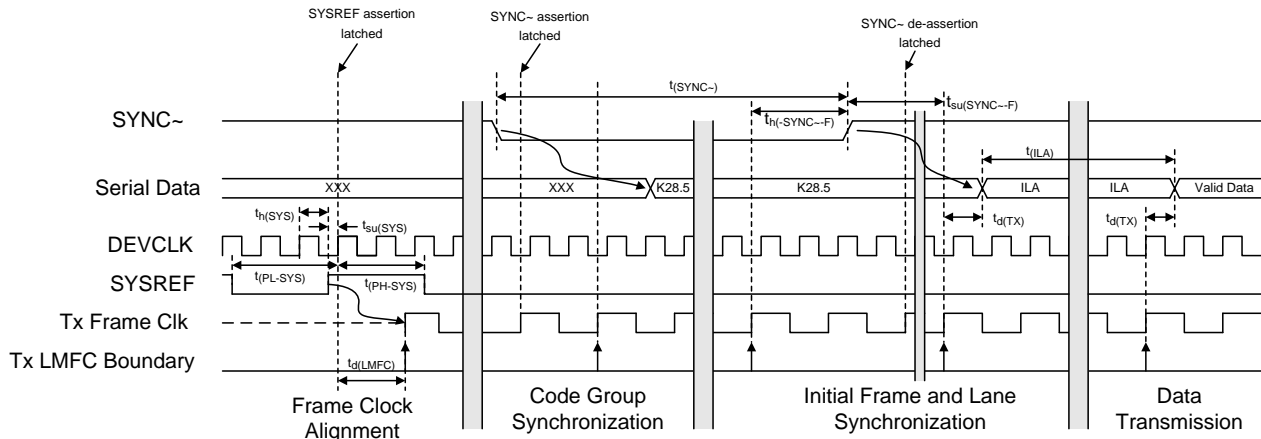


Figure 1. JESD204 Synchronization

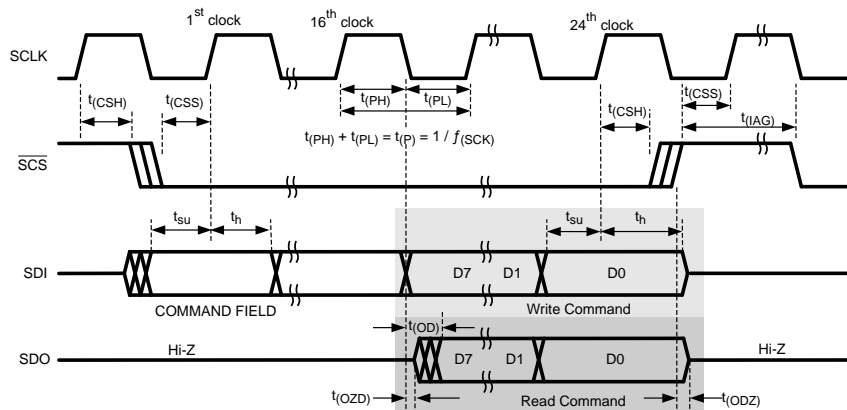
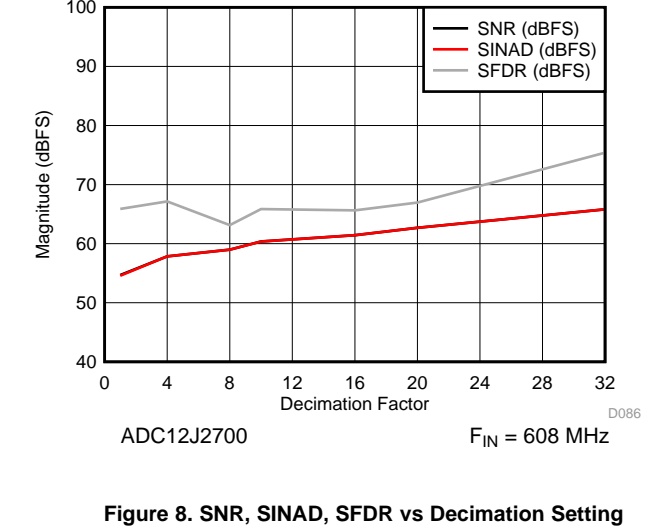
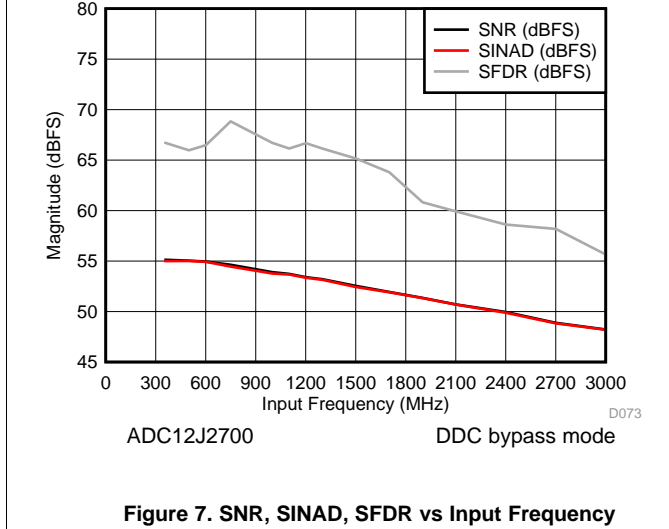
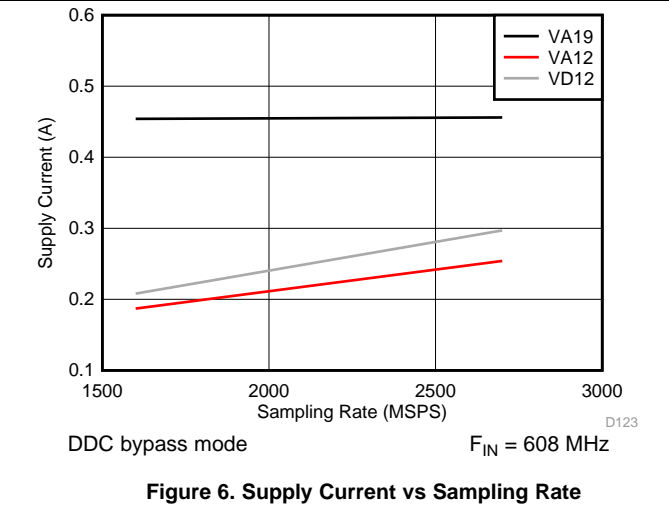
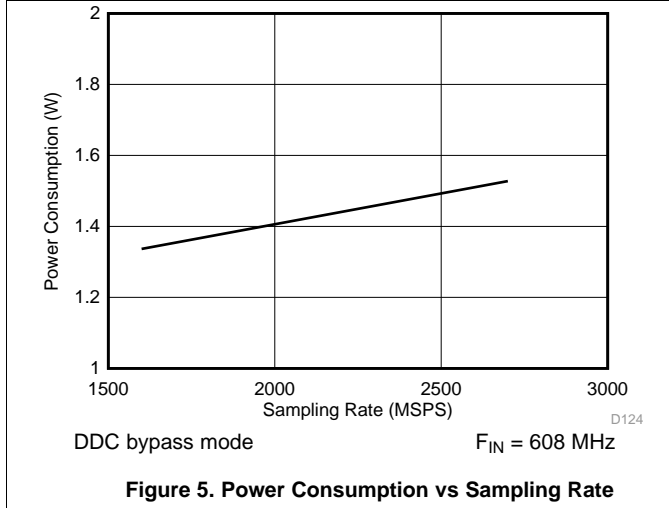
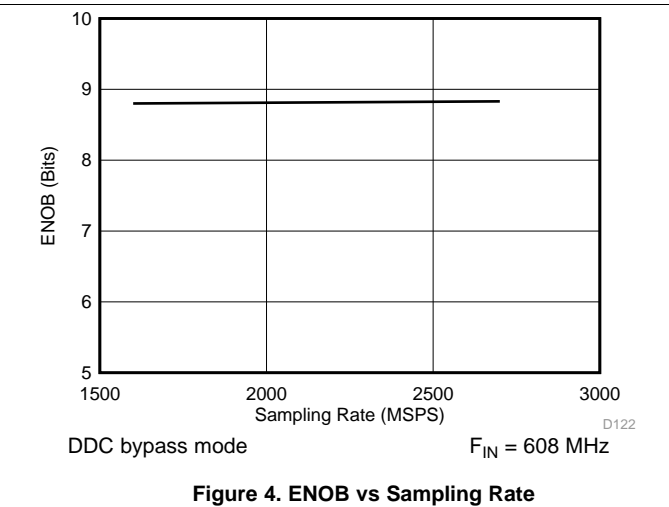
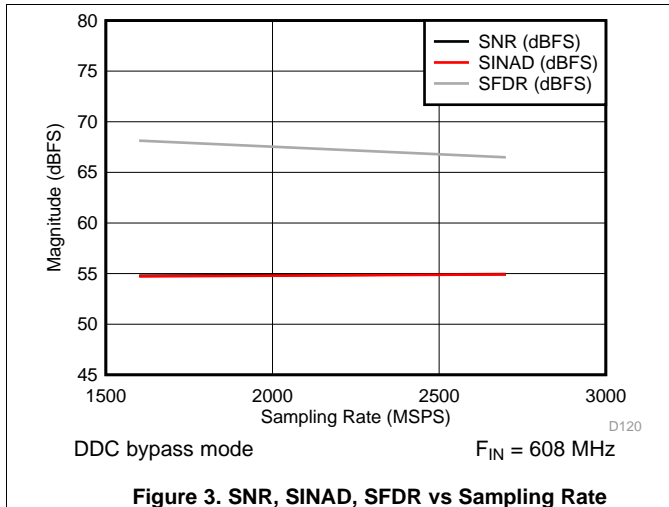


Figure 2. Serial Interface Timing

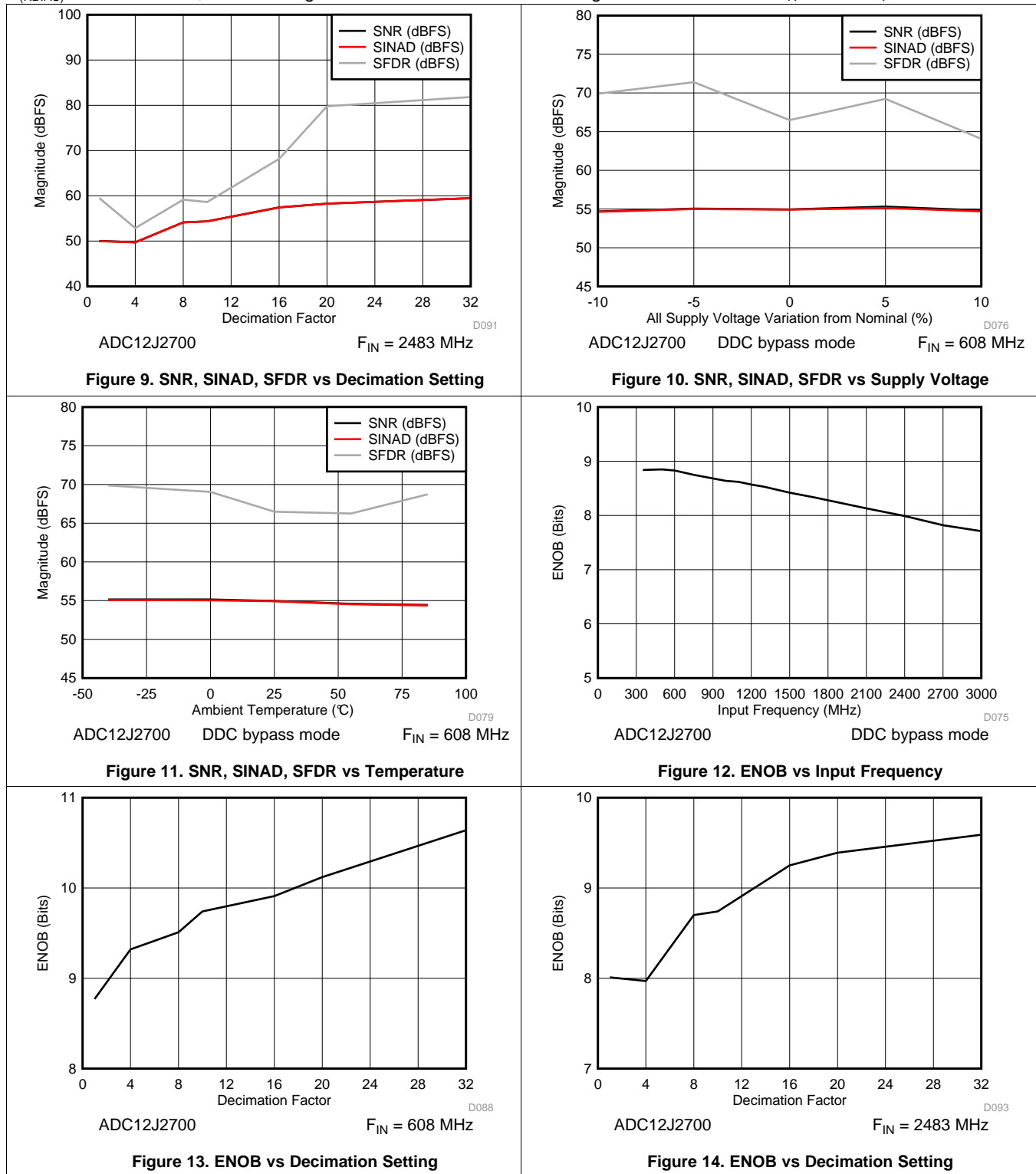
### 6.9 Typical Characteristics

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7$  or  $1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



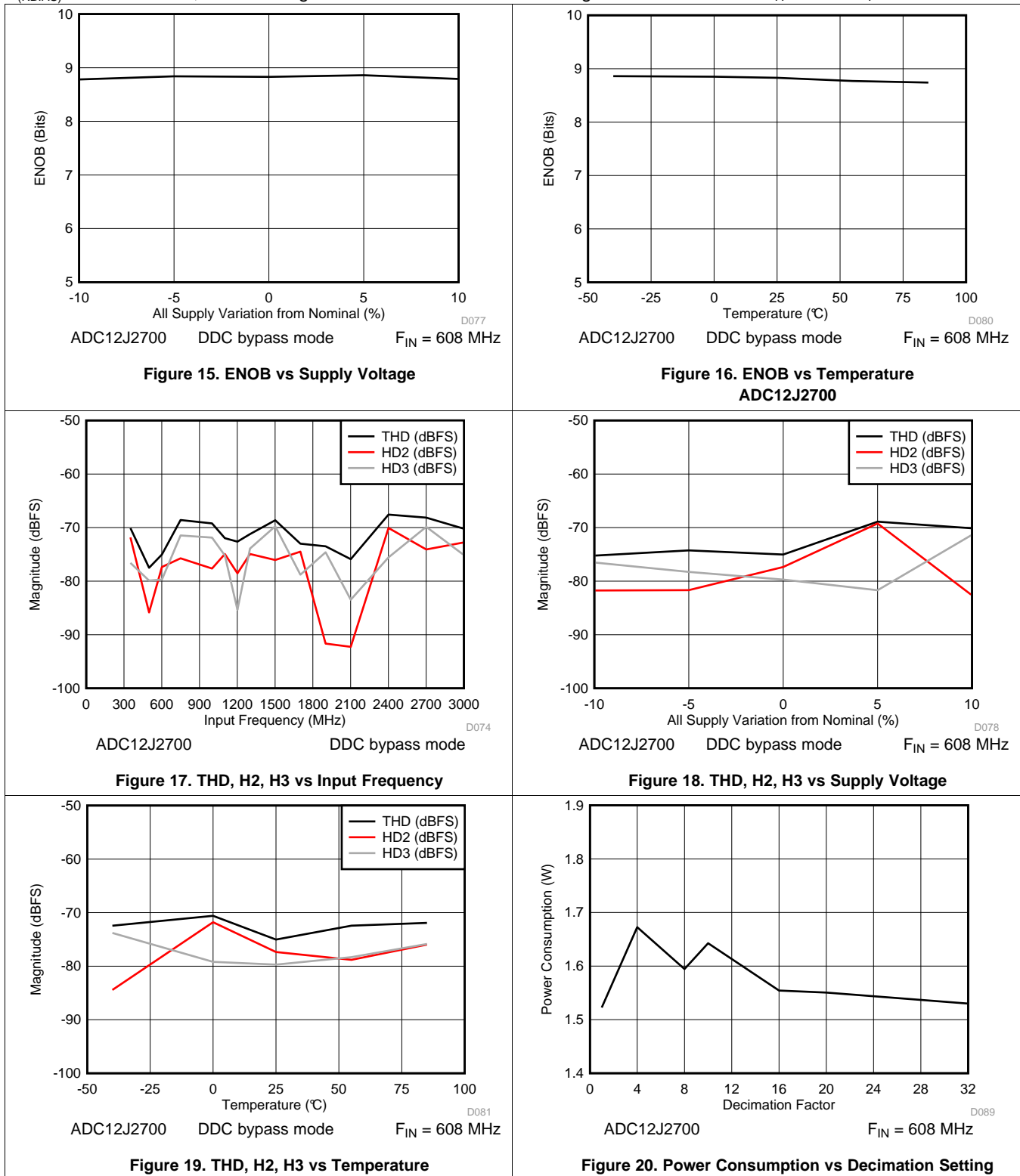
**Typical Characteristics (continued)**

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



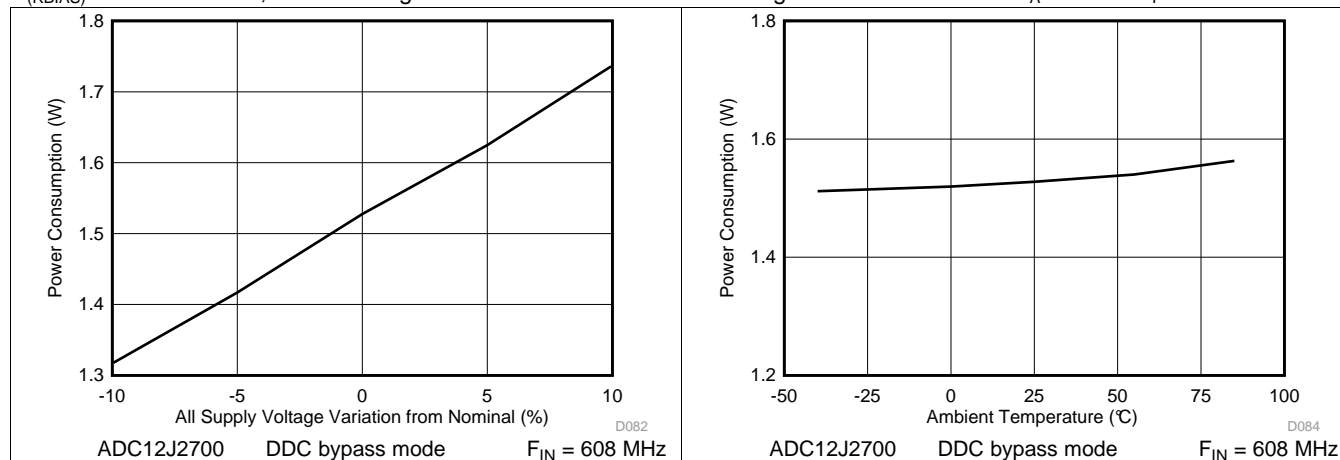
Typical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .

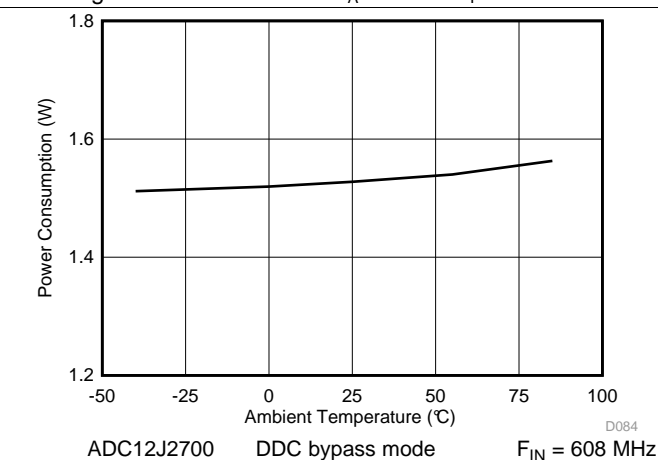


**Typical Characteristics (continued)**

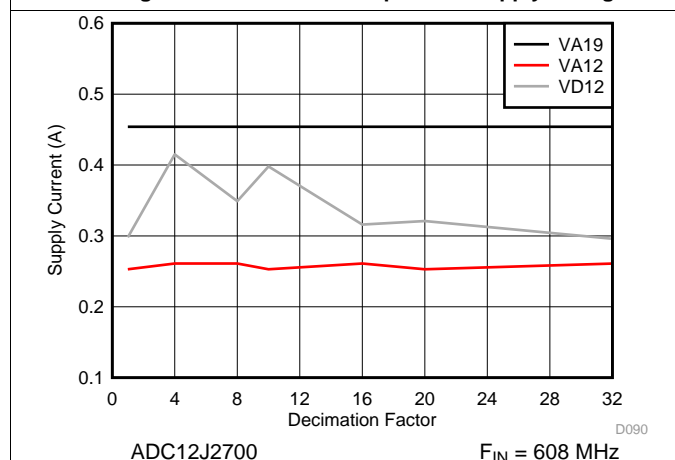
Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



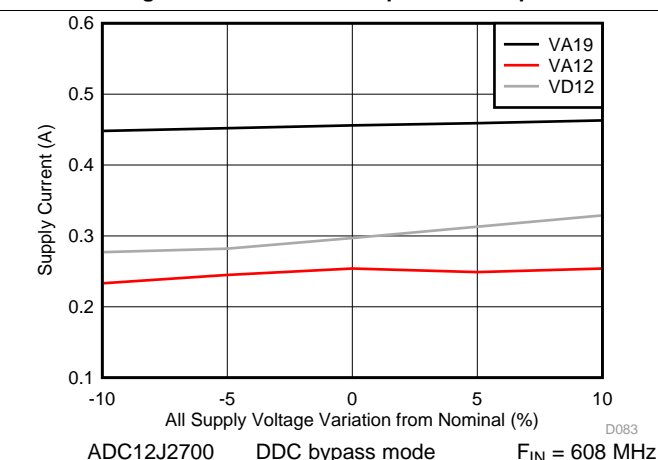
**Figure 21. Power Consumption vs Supply Voltage**



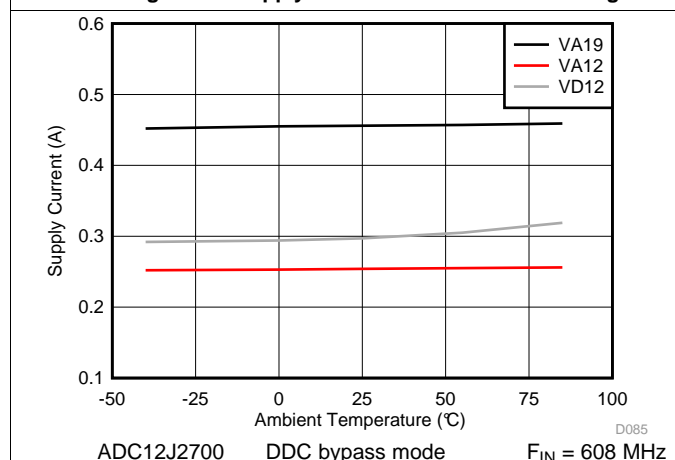
**Figure 22. Power Consumption vs Temperature**



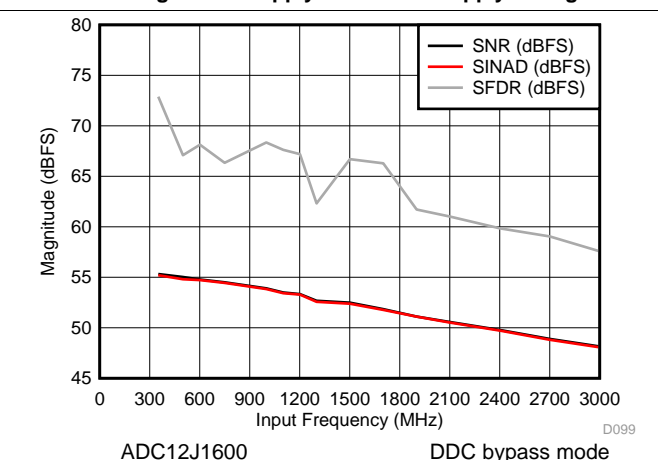
**Figure 23. Supply Current vs Decimation Setting**



**Figure 24. Supply Current vs Supply Voltage**



**Figure 25. Supply Current vs Temperature**



**Figure 26. SNR, SINAD, SFDR vs Input Frequency**

Typical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .

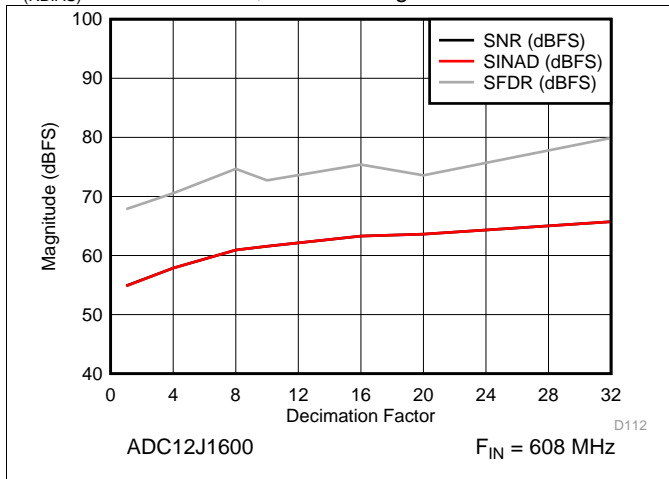


Figure 27. SNR, SINAD, SFDR vs Decimation Setting

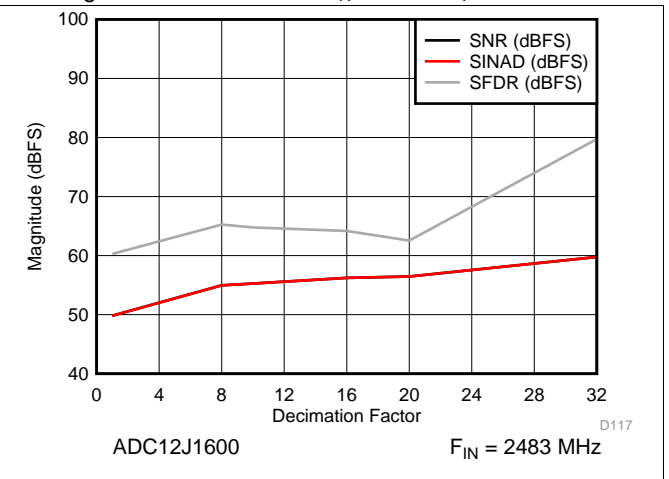


Figure 28. SNR, SINAD, SFDR vs Decimation Setting

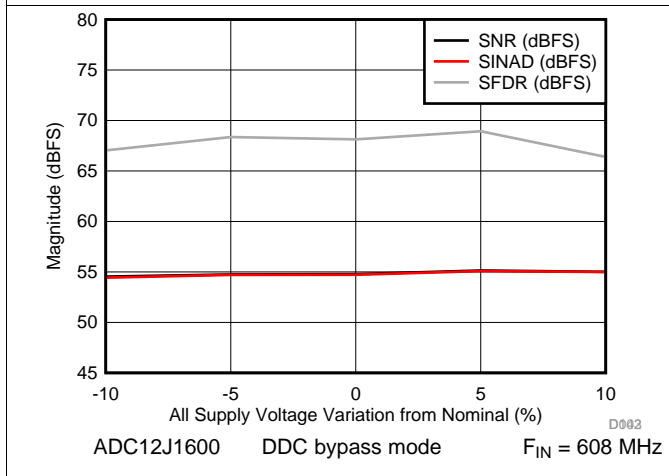


Figure 29. SNR, SINAD, SFDR vs Supply Voltage

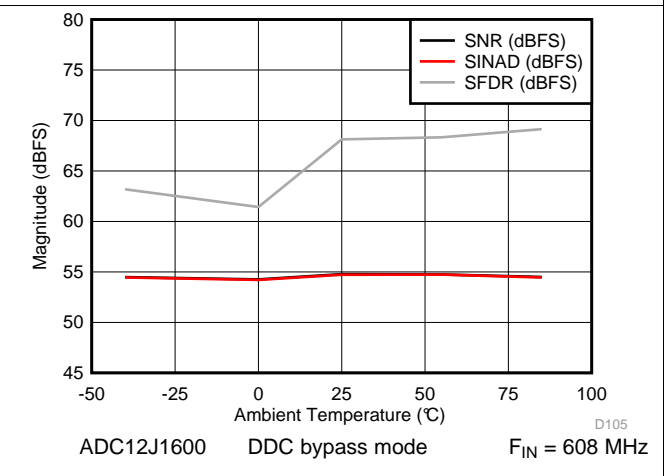


Figure 30. SNR, SINAD, SFDR vs Temperature

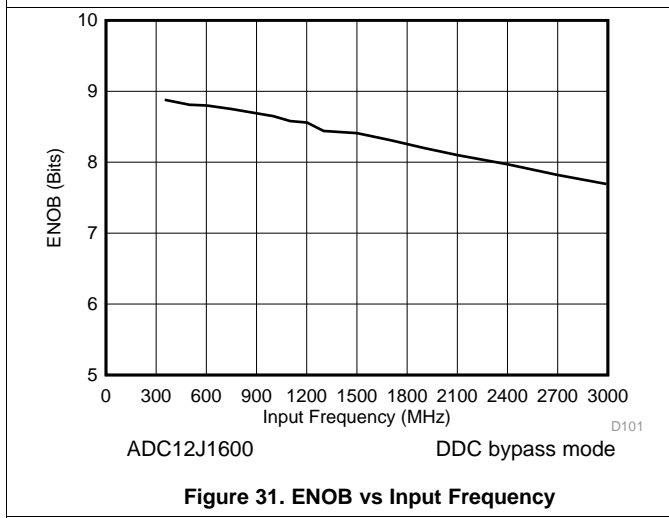


Figure 31. ENOB vs Input Frequency

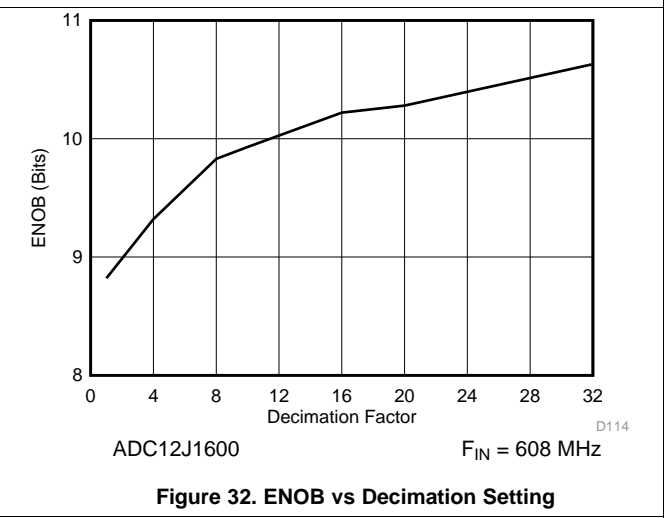
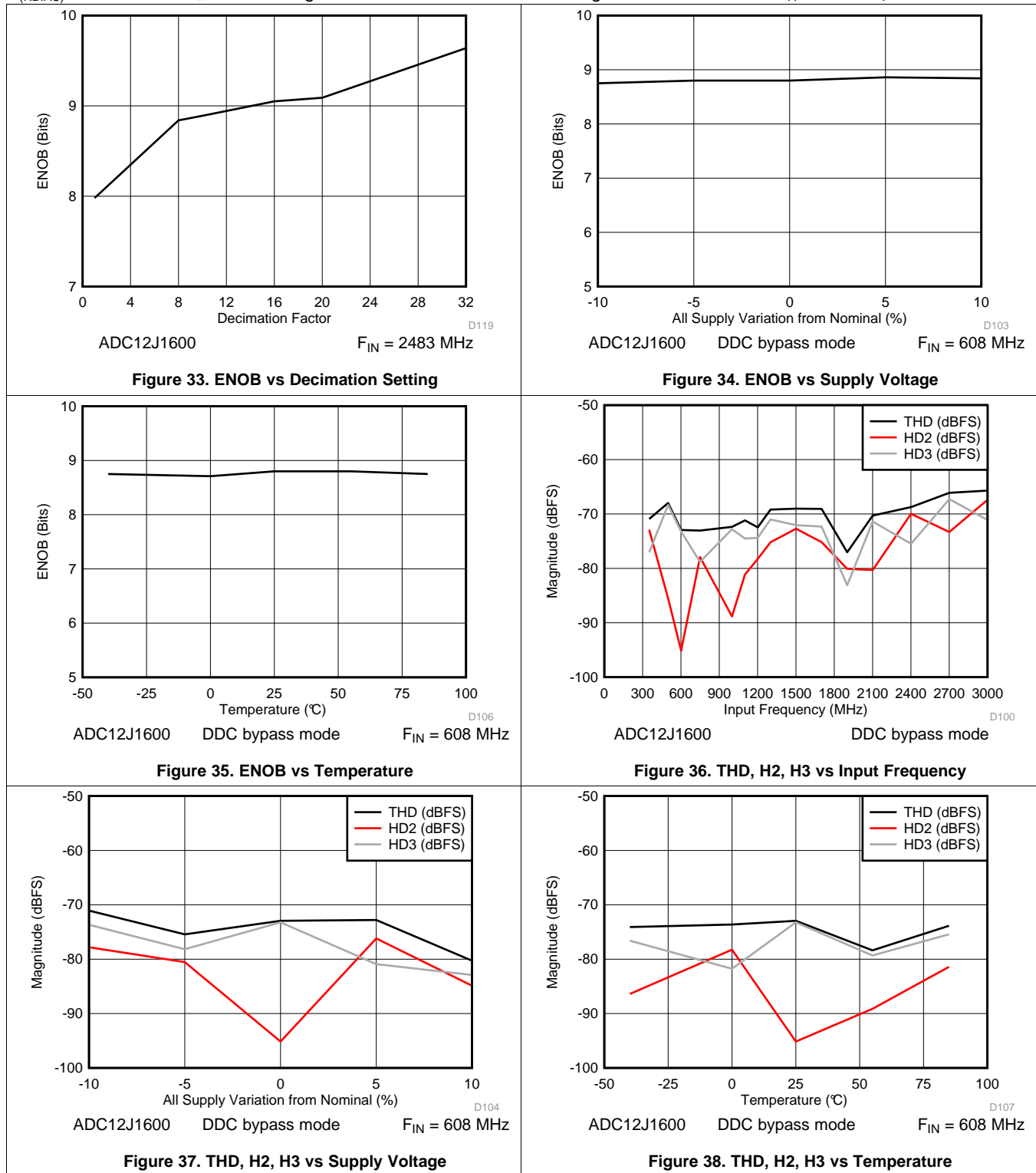


Figure 32. ENOB vs Decimation Setting

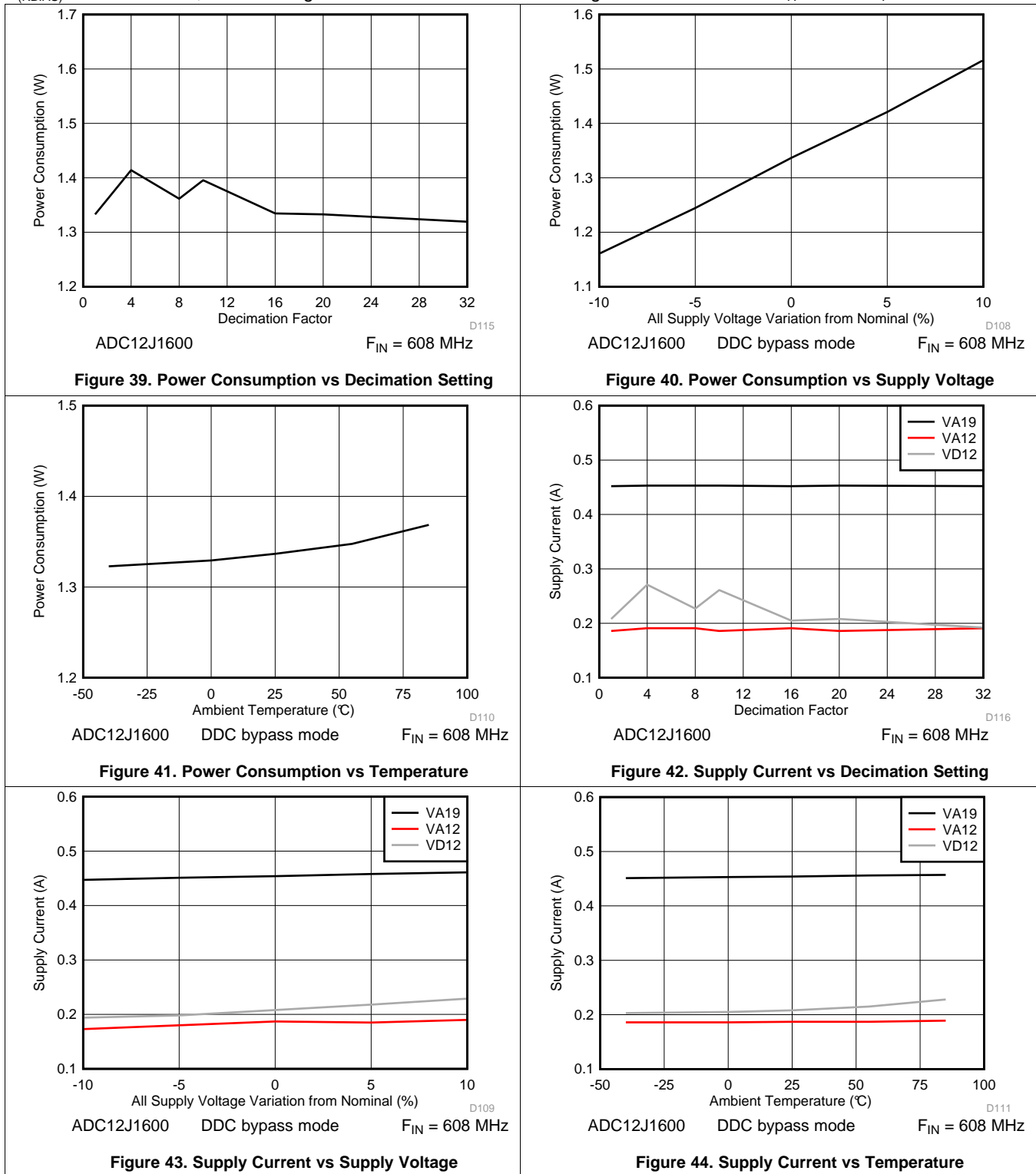
**Typical Characteristics (continued)**

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



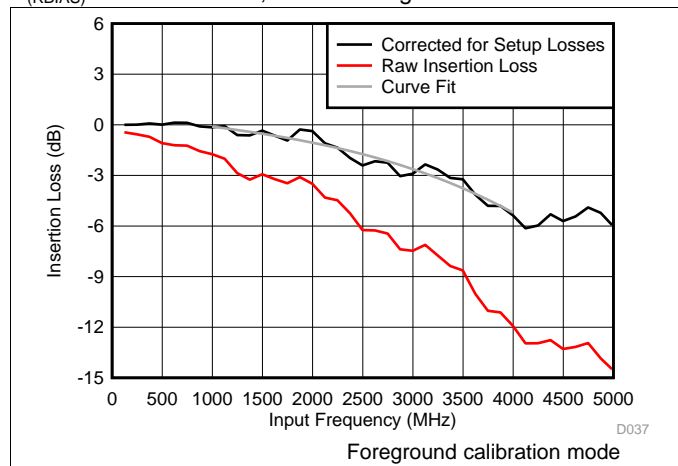
**Typical Characteristics (continued)**

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .

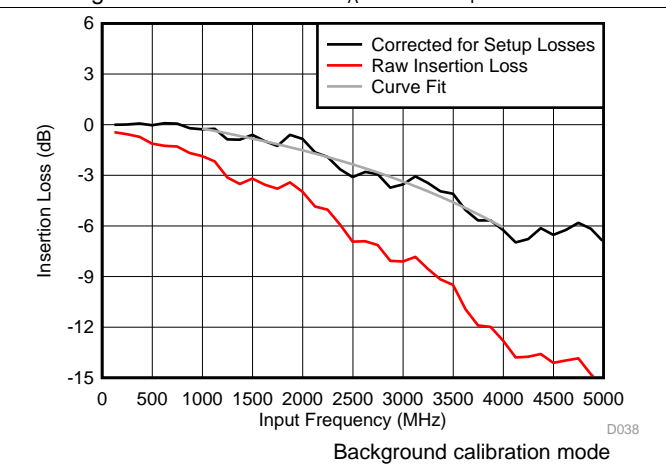


**Typical Characteristics (continued)**

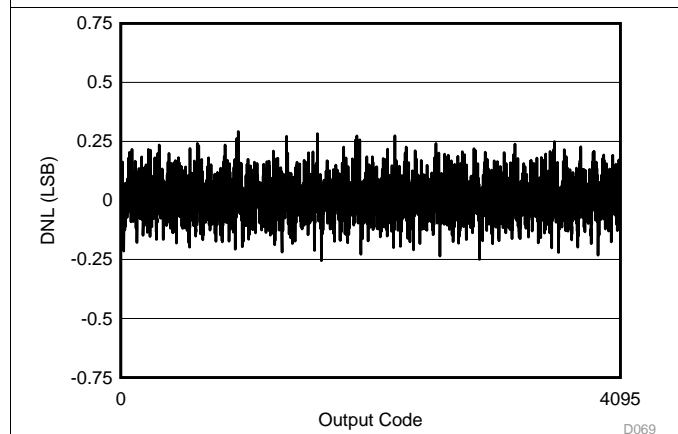
Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



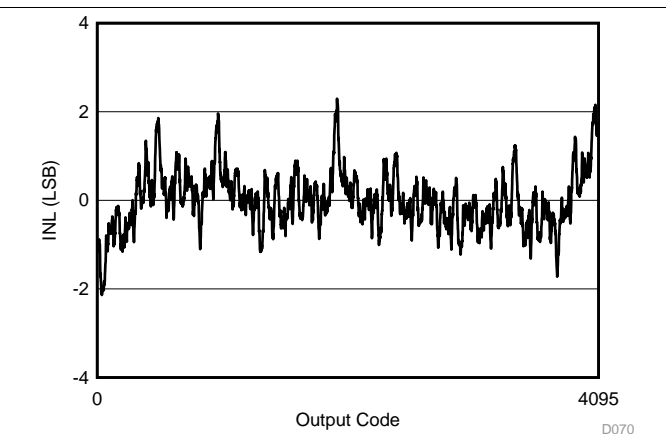
**Figure 45. Insertion Loss vs Input Frequency**



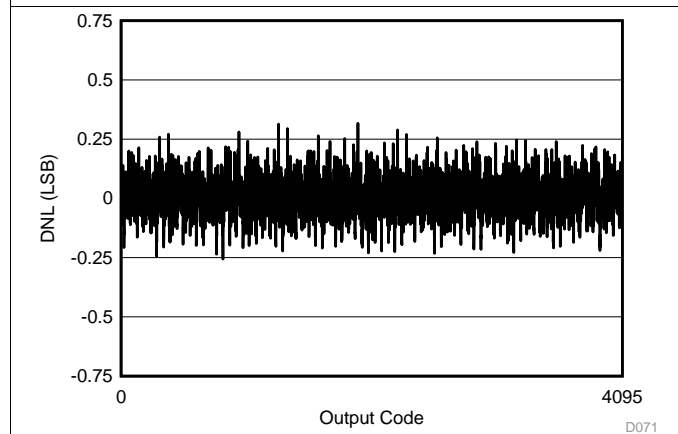
**Figure 46. Insertion Loss vs Input Frequency**



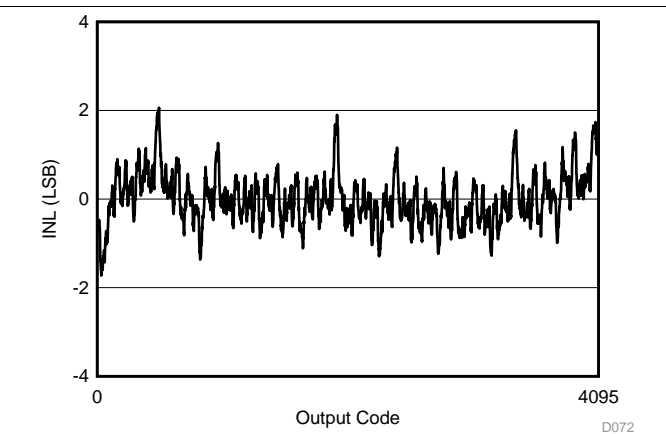
**Figure 47. DNL versus Code - ADC12J2700**



**Figure 48. INL versus Code - ADC12J2700**



**Figure 49. DNL versus Code - ADC12J1600**



**Figure 50. INL versus Code - ADC12J1600**

### Typical Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .

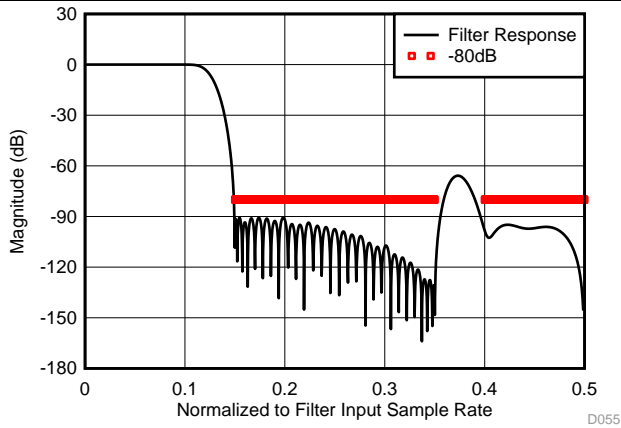


Figure 51. Decimate by 4 - Stopband Response

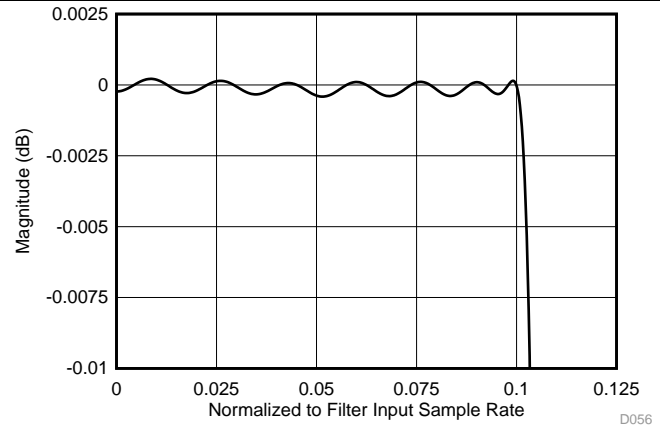


Figure 52. Decimate by 4 - Passband Response

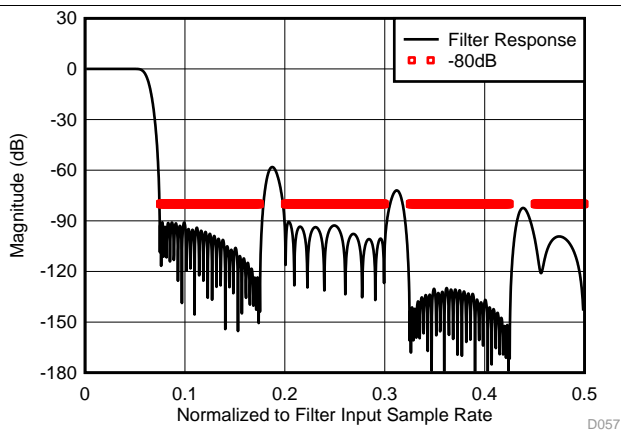


Figure 53. Decimate by 8 - Stopband Response

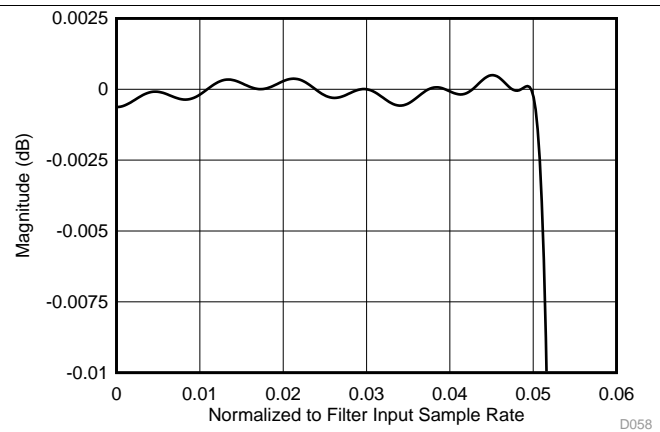


Figure 54. Decimate by 8 - Passband Response

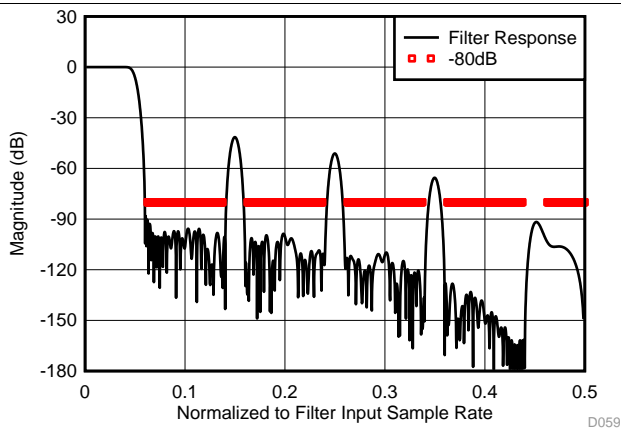


Figure 55. Decimate by 10 - Stopband Response

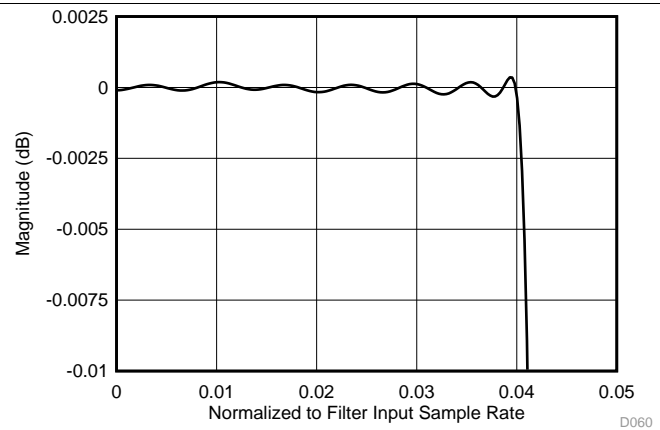
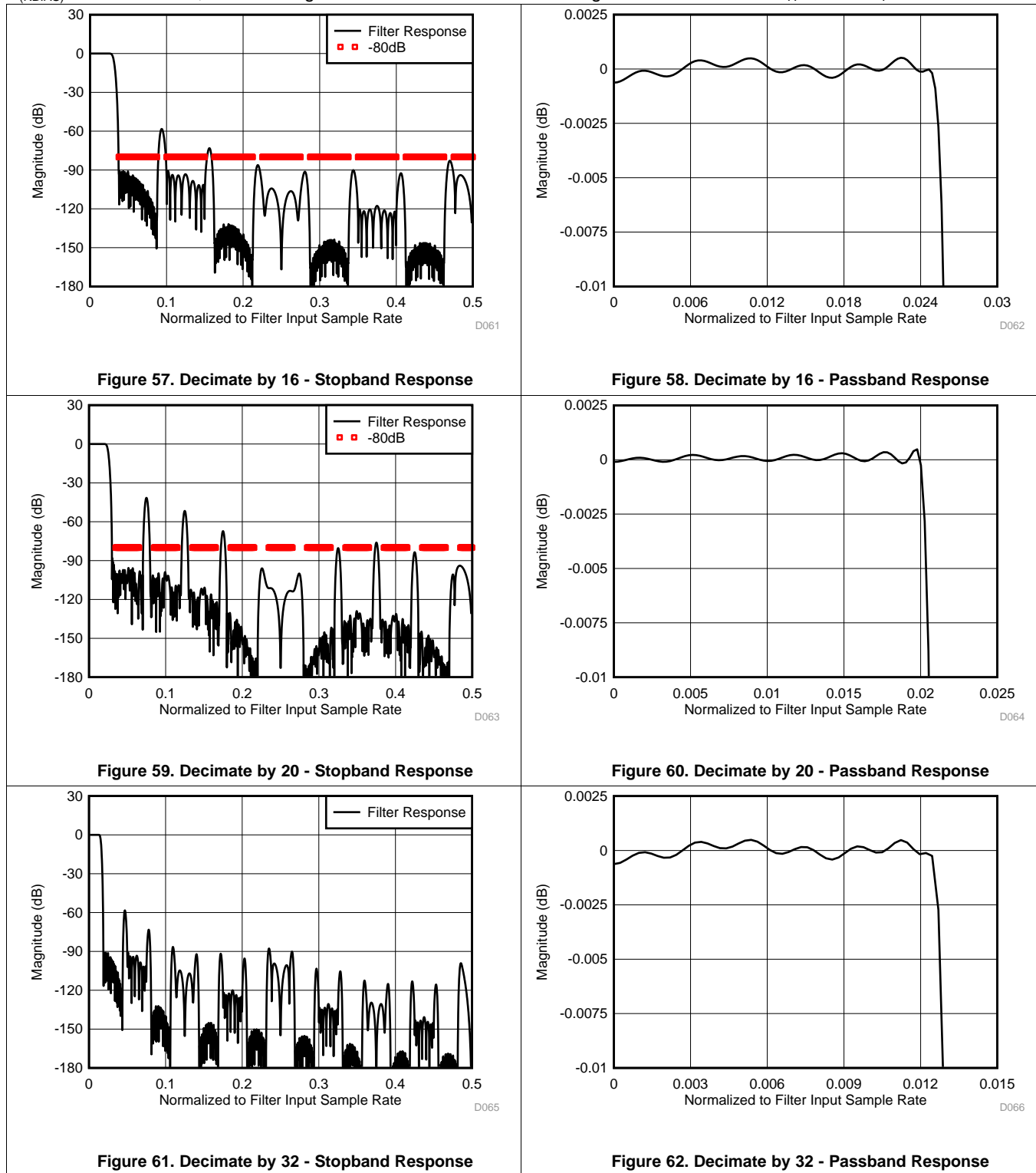


Figure 56. Decimate by 10 - Passband Response

**Typical Characteristics (continued)**

Unless otherwise noted, these specifications apply for  $V_{(VA12)} = V_{(VD12)} = 1.2\text{ V}$ ,  $V_{(VA19)} = 1.9\text{ V}$ , VIN FSR (AC coupled) = Default setting, differential AC-coupled sinewave input clock,  $f_{(DEVCLK)} = 2.7\text{ or }1.6\text{ GHz}$  at  $0.5\text{ V}_{PP}$  with 50% duty cycle,  $R_{(RBIAS)} = 3.3\text{ k}\Omega \pm 0.1\%$ , after a Foreground mode calibration with Timing Calibration enabled.  $T_A = 25^\circ\text{C}$ .  $V_I = -1\text{ dBFS}$ .



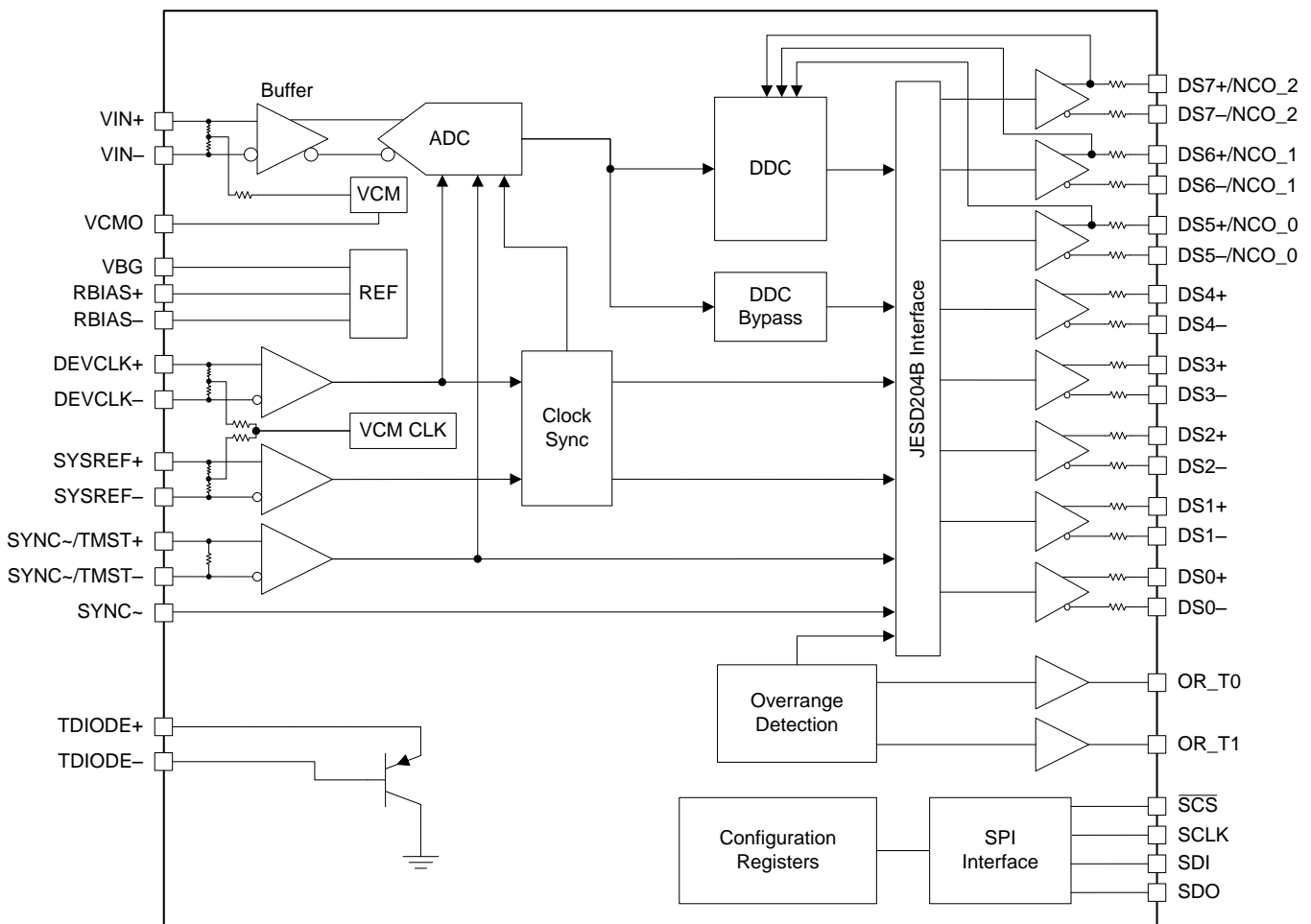
## 7 Detailed Description

### 7.1 Overview

The ADC12J1600 and ADC12J2700 devices are an ultra-wideband sampling and digital tuning subsystem. The devices combine a very-wideband and high sampling-rate ADC front-end with a configurable digital-down conversion block. This combination provides the necessary features to facilitate the development of flexible software-defined radio products for a wide range of communications applications.

The ADC12J1600 and ADC12J2700 devices are based on an ultra high-speed ADC core. The core uses an interleaved calibrated folding and interpolating architecture that results in very high sampling rate, very good dynamic performance, and relatively low-power consumption. This ADC core is followed by a configurable DDC block which is implemented on a small geometry CMOS. The DDC block provides a range of decimation settings that allow the product to work in ultra-wideband, wideband, and more-narrow-band receive systems. The output data from the DDC block is transmitted through a JESD204B-compatible multi-lane serial-output system. This system minimizes the number of data pairs required to convey the output data to the downstream processing circuitry.

### 7.2 Functional Block Diagram



## Functional Block Diagram (continued)

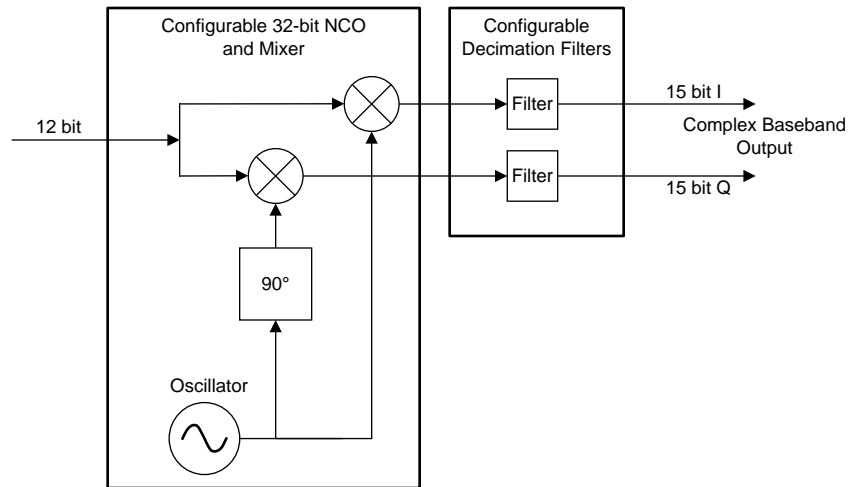


Figure 63. DDC Details Block Diagram

## 7.3 Feature Description

### 7.3.1 Signal Acquisition

The analog input is sampled on the rising edge of CLK and the digital equivalent of that data is available in the serialized datastream  $t_{(LAT)}$  or  $t_{(LAT\_DDC)}$  input clock cycles later.

The ADC12J1600 and ADC12J2700 devices convert as long as the input clock signal is present. The fully-differential comparator design and the innovative design of the sample-and-hold amplifier, together with calibration, enables very good performance at input frequencies beyond 3 GHz. The ADC12J1600 and ADC12J2700 data is output on a high-speed serial JESD204B interface.

### 7.3.2 The Analog Inputs

A differential input signal must be used to drive the ADC12J1600 and ADC12J2700 devices. Operation with a single-ended signal is not recommended as performance suffers. The input signals can be either be AC coupled or DC coupled. The analog inputs are internally connected to the  $V_{CMO}$  bias voltage. When DC-coupled input signals are used, the common mode voltage of the applied signal must meet the device Input common mode requirements. See  $V_{CMI}$  in the [Recommended Operating Conditions](#) table.

The full-scale input range for each converter can be adjusted through the serial interface. See the [Full Scale Range Adjust](#) section.

The buffered analog inputs simplify the task of driving these inputs and the RC pole that is generally used at sampling ADC inputs is not required. If an amplifier circuit before the ADC is desired, use care when selecting an amplifier with adequate noise and distortion performance and adequate gain at the frequencies used for the application. If gain is not required, a balun (balanced-to-unbalanced transformer) is generally used to provide single ended (SE) to differential conversion.

The input impedance of  $V_{IN\pm}$  consists of two 50- $\Omega$  resistors in series between the inputs and a capacitance from each of these inputs to ground. A resistance of approximately 20 k $\Omega$  exists from the center point of the 50- $\Omega$  resistors to the on-chip  $V_{CMO}$  providing self-biasing for AC-coupled applications.

Performance is good in both DC-coupled mode and AC coupled mode, provided the common-mode voltage at the analog input is within specifications.

## Feature Description (continued)

### 7.3.2.1 Input Clamp

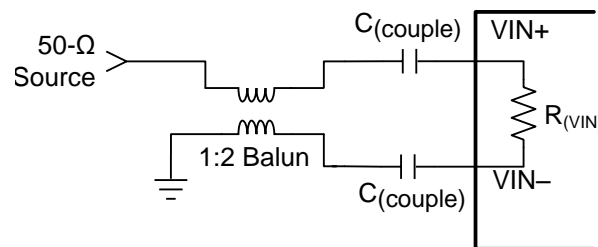
The ADC12J1600 and ADC12J2700 maximum DC input voltage is limited to the range 0 to 2 V to prevent damage to the device. To help maintain these limits, an active input clamping circuit is incorporated which sources or sinks input currents up to  $\pm 50$  mA. The clamping circuit is enabled by default and is controlled via the Input\_Clamp\_EN bit (register 0x034, bit 5). The protection provided by this circuit is limited as follows:

- Shunt current-clamping is only effective for non-zero source impedances.
- At frequencies above 3 GHz the clamping is ineffective because of the finite turn-on and turn-off time of the switch.

With these limitations in mind, analysis has been done to determine the allowable input signal levels as a function of input frequency when the Input Clamp is enabled, assuming the source impedance matches the input impedance of the device (100- $\Omega$  differential). This information is incorporated in the [Absolute Maximum Ratings](#) table.

### 7.3.2.2 AC Coupled Input Usage

The easiest way to accomplish SE-to-differential conversion for AC-coupled signals is with an appropriate balun.



**Figure 64. Single-Ended-to-Differential Signal Conversion With a Balun**

Figure 64 shows a generic depiction of a SE-to-differential signal conversion using a balun. The circuitry specific to the balun depends on the type of balun selected and the overall board layout. TI recommends that the system designer contact the manufacturer of the selected balun to aid in designing the best performing single-ended to differential conversion circuit using that particular balun.

When selecting a balun, understanding the input architecture of the ADC is important. Specific balun parameters must be considered. The balun must match the impedance of the analog source to the on-chip 100- $\Omega$  differential input termination of the ADC12J1600 and ADC12J2700 devices. The range of this input termination resistor is described in the [Electrical Characteristics](#) table as the specification  $R_{ID}$ .

Also, as a result of the ADC architecture, the phase and amplitude balance are important. The lowest possible phase and amplitude imbalance is desired when selecting a balun. The phase imbalance must be no more than  $\pm 2.5^\circ$  and the amplitude imbalance must be limited to less than 1 dB at the desired input frequency range.

Finally, when selecting a balun, the voltage standing-wave ratio (VSWR), bandwidth, and insertion loss of the balun must also be considered. The VSWR aids in determining the overall transmission line termination capability of the balun when interfacing to the ADC input. The insertion loss must be considered so that the signal at the balun output is within the specified input range of the ADC as described in the [Electrical Characteristics](#) table as the specification  $V_{ID}$ .

Table 1 lists the recommended baluns for specific signal frequency ranges.

**Table 1. Balun Recommendations**

| MINIMUM FREQUENCY (MHz) | MAXIMUM FREQUENCY (MHz) | IMPEDANCE RATIO | PART NUMBER    | MANUFACTURER  |
|-------------------------|-------------------------|-----------------|----------------|---------------|
| 4.5                     | 3000                    | 1:1             | TC1-1-13MA+    | Mini-Circuits |
| 400                     | 3000                    | 1:2             | B0430J50100AHF | Anaren        |
| 30                      | 1800                    | 1:2             | ADTL2-18+      | Mini-Circuits |
| 10                      | 4000                    | 1:2             | TCM2-43X+      | Mini-Circuits |

### 7.3.2.3 DC Coupled Input Usage

When a DC-coupled signal source is used, the common mode voltage of the applied signal must be within a specified range ( $V_{\text{CMI}}$ ). To achieve this range, the common mode of the driver should be based on the VCMO output provided for this purpose.

Full-scale distortion performance degrades as the input common-mode voltage deviates from VCMO. Therefore, maintaining the input common-mode voltage within the  $V_{\text{CMI}}$  range is important.

Table 2 lists the recommended amplifiers for DC-coupled usage or if AC-coupling with gain is required.

**Table 2. Amplifier Recommendations**

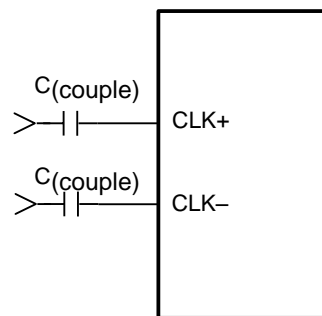
| -3-dB BANDWIDTH (MHz) | MIN GAIN (dB) | MAX GAIN (dB) | GAIN TYPE            | PART NUMBER |
|-----------------------|---------------|---------------|----------------------|-------------|
| 7000                  | 16            | 16            | Fixed                | LMH3401     |
| 2800                  | 0             | 17            | Resistor set         | LMH6554     |
| 2400                  | 6             | 26            | Digital programmable | LMH6881     |
| 900                   | -1.16         | 38.8          | Digital programmable | LMH6518     |

### 7.3.2.4 Handling Single-Ended Input Signals

The ADC12J1600 and ADC12J2700 devices have no provision to adequately process single-ended input signals. The best way to handle single-ended signals is to convert these signals to balanced differential signals before presenting the signals to the ADC.

### 7.3.3 Clocking

The ADC12J1600 and ADC12J2700 devices have a differential clock input, DEVCLK+ and DEVCLK-, that must be driven with an AC-coupled differential clock-signal. The clock inputs are internally terminated and biased. The input clock signal must be capacitively coupled to the clock pins as shown in Figure 65.



**Figure 65. Differential Sample-Clock Connection**

The differential sample-clock line pair must have a characteristic impedance of 100  $\Omega$  and must be terminated at the clock source of that 100- $\Omega$  characteristic impedance. The input clock line must be as short and direct as possible. The ADC12J1600 and ADC12J2700 clock input is internally terminated with an untrimmed 100- $\Omega$  resistance.

Insufficient input clock levels results in poor dynamic performance. Excessively-high input-clock levels can cause a change in the analog-input offset voltage. To avoid these issues, maintain the input clock level within the range specified in the [Electrical Characteristics](#) table.

The low times and high times of the input clock signal can affect the performance of any ADC. The ADC12J1600 and ADC12J2700 devices feature a duty-cycle clock-correction circuit which maintains performance over temperature. The ADC meets the performance specification when the input clock high times and low times are maintained as specified in the [Electrical Characteristics](#) table.

High-speed high-performance ADCs such as the ADC12J1600 and ADC12J2700 devices require a very-stable input clock-signal with minimum phase noise or jitter. ADC jitter requirements are defined by the ADC resolution or ENOB (effective number of bits), maximum ADC input frequency, and the input signal amplitude relative to the ADC input full-scale range. Use [Equation 1](#) to calculate the maximum jitter (the sum of the jitter from all sources) allowed to prevent a jitter-induced reduction in SNR.

$$\text{RMS}_{\text{tot}(J)} = \frac{V_{\text{FSR}}}{V_{\text{I(PP)}}} \times \frac{1}{\left(2^{(n+1)} \times \pi \times F_{\text{IN}}\right)}$$

where

- $\text{RMS}_{\text{tot}(J)}$  is the RMS total of all jitter sources in seconds
  - $V_{\text{I(PP)}}$  is the peak-to-peak analog input signal
  - $V_{\text{FSR}}$  is the full-scale range of the ADC
  - $n$  is the ADC resolution in bits
  - $F_{\text{IN}}$  is the maximum input frequency, in Hertz, at the ADC analog input
- (1)

Note that the maximum jitter previously described is the root sum square (RSS) of the jitter from all sources, including that from the clock source, the jitter added by noise coupling at board level and that added internally by the ADC clock circuitry, in addition to any jitter added to the input signal. Because the effective jitter added by the ADC is beyond user control, the best option is to minimize the jitter from the clock source, the sum of the externally-added input clock jitter and the jitter added by any circuitry to the analog signal.

Input clock amplitudes above those specified in the [Recommended Operating Conditions](#) table can result in increased input-offset voltage. Increased input-offset voltage causes the converter to produce an output code other than the expected 2048 when both input pins are at the same potential.

### 7.3.4 Over-Range Function

To ensure that system-gain management has the quickest-possible response time, a low-latency configurable over-range function is included. The over-range function works by monitoring the raw 12-bit samples exiting the ADC module. The upper 8 bits of the magnitude of the ADC data are checked against two programmable thresholds, OVR\_T0 and OVR\_T1. The following table lists how a raw ADC value is converted to an absolute value for a comparison of the thresholds.

| ADC SAMPLE (OFFSET BINARY) | ADC SAMPLE (2's COMPLEMENT) | ABSOLUTE VALUE       | UPPER 8 BITS USED FOR COMPARISON |
|----------------------------|-----------------------------|----------------------|----------------------------------|
| 1111 1111 1111 (4095)      | 0111 1111 1111 (+2047)      | 111 1111 1111 (2047) | 1111 1111 (255)                  |
| 1111 1111 0000 (4080)      | 0111 1111 0000 (+2032)      | 111 1111 0000 (2032) | 1111 1110 (254)                  |
| 1000 0000 0000 (2048)      | 0000 0000 0000 (0)          | 000 0000 0000 (0)    | 0000 0000 (0)                    |
| 0000 0001 0000 (16)        | 1000 0001 0000 (-2032)      | 111 1111 0000 (2032) | 1111 1110 (254)                  |
| 0000 0000 0000 (0)         | 1000 0000 0000 (-2048)      | 111 1111 1111 (2047) | 1111 1111 (255)                  |

If the upper 8 bits of the absolute value equal or exceed the OVR\_T0 or OVR\_T1 threshold during the monitoring period, then the over-range bit associated with the threshold is set to 1, otherwise the over-range bit is 0. The resulting over-range bits are embedded into the complex output data samples and output on OR\_T0 and OR\_T1. [Table 3](#) lists the outputs, related data samples, threshold settings and the monitoring period equation.

**Table 3. Threshold and Monitor Period for Embedded OR Bits**

| EMBEDDED OVER-RANGE OUTPUTS | ASSOCIATED THRESHOLD | ASSOCIATED SAMPLES     | MONITORING PERIOD (ADC SAMPLES) |
|-----------------------------|----------------------|------------------------|---------------------------------|
| OR_T0                       | OVR_T0               | In-Phase (I) samples   | $2^{\text{OVR\_N}(1)}$          |
| OR_T1                       | OVR_T1               | Quadrature (Q) samples |                                 |

(1) OVR\_N is the monitoring period register setting.

**Table 4. Over-Range Monitoring Period**

| OVR_N | MONITORING PERIOD |
|-------|-------------------|
| 0     | 1                 |
| 1     | 2                 |
| 2     | 4                 |
| 3     | 8                 |
| 4     | 16                |
| 5     | 32                |
| 6     | 64                |
| 7     | 128               |

Typically, the OVR\_T0 threshold can be set near the full-scale value (228 for example). When the threshold is triggered, a typical system can turn down the system gain to avoid clipping. The OVR\_T1 threshold can be set much lower. For example, the OVR\_T1 threshold can be set to 64 (–12 dBFS). If the input signal is strong, the OVR\_T1 threshold is tripped occasionally. If the input is quite weak, the threshold is never tripped. The downstream logic device monitors the OVR\_T1 bit. If OVR\_T1 stays low for an extended period of time, then the system gain can be increased until the threshold is occasionally tripped (meaning the peak level of the signal is above –12 dBFS).

The OR\_T0 threshold is embedded as the LSB along with the upper 15 bits of every complex I sample. The OR\_T1 threshold is embedded as the LSB along with the upper 15 bits of every complex Q sample.

### 7.3.5 ADC Core Features

#### 7.3.5.1 The Reference Voltage

The reference voltage for the ADC12J1600 and ADC12J2700 devices is derived from an internal bandgap reference. A buffered version of the reference voltage is available at the VBG pin for user convenience. This output has an output-current capability of  $\pm 100 \mu\text{A}$ . The VBG output must be buffered if more current is required. No provision exists for the use of an external reference voltage, but the full-scale input voltage can be adjusted through the full-scale-range register settings.

#### 7.3.5.2 Common-Mode Voltage Generation

The internal reference voltage is used to generate a stable common-mode voltage reference for the analog inputs and the DEVCLK and SYSREF differential-clock inputs.

#### 7.3.5.3 Bias Current Generation

An external bias resistor, in combination with the on-chip voltage reference is used to provide an accurate and stable source of bias currents for internal circuitry. Using an external accurate resistor minimizes variation in device power consumption and performance.

#### 7.3.5.4 Full Scale Range Adjust

The ADC input full-scale range can be adjusted through the GAIN\_FS register setting (registers 0x022 and 0x023). The adjustment range is approximately 500 mV<sub>PP</sub> to 950 mV<sub>PP</sub>. The full-scale range adjustment is useful for matching the input-signal amplitude to the ADC full scale, or to match the full-scale range of multiple ADCs when developing a multi-converter system.

#### 7.3.5.5 Offset Adjust

The ADC-input offset voltage can be adjusted through the OFFSET\_FS register setting (registers 0x025 and 0x026). The adjustment range is approximately 28 mV to –28 mV differential.

---

#### NOTE

Offset adjust has no effect when background calibration mode is enabled.

---

### 7.3.5.6 Power-Down

The power-down bit (PD) allows the ADC12J1600 and ADC12J2700 devices to be entirely powered down. The serial data output drivers are disabled when PD is high. When the device returns to normal operation, the JESD204 link must be re-established, and the ADC pipeline and decimation filters contain meaningless information and must be flushed.

### 7.3.5.7 Built-In Temperature Monitor Diode

A built-in thermal monitoring diode junction is made available on the TDIODE+ and TDIODE– pins. This diode facilitates temperature monitoring and characterization of the device in higher ambient temperature environments. While the on-chip diode is not highly characterized, the diode can be used effectively by performing a baseline measurement at a known ambient or board temperature with the device in power-down (PD) mode. Recommended monitoring ICs include the LM95233 device and similar remote-diode temperature monitoring products from Texas Instruments.

## 7.3.6 Digital Down Converter (DDC)

The digitized data is the input to the digital down-converter block. This block provides frequency conversion and decimation filtering to allow a specific range of frequencies to be selected and output in the digital data stream.

### 7.3.6.1 NCO/Mixer

The DDC contains a complex numerically-controlled oscillator and a complex mixer. The oscillator generates a complex exponential sequence shown in [Equation 2](#).

$$x[n] = e^{j\omega n} \quad (2)$$

The frequency ( $\omega$ ) is specified by the a 32-bit register setting. The complex exponential sequence is multiplied by the real input from the ADC to mix the desired carrier down to 0 Hz.

### 7.3.6.2 NCO Settings

#### 7.3.6.2.1 NCO Frequency Phase Selection

Within the DDC, eight different frequency and phase settings are always available for use. Each of the eight settings uses a different phase accumulator within the NCO. Because all eight phase accumulators are continuously running independently, rapid switching between different NCO frequencies is possible allowing rapid tuning of different signals.

The specific frequency-phase pair in use is selected through either the NCO\_x input pins, or the NCO\_SEL configuration bits (register 0x20D, bits 2:0). The CFG\_MODE bit (register 0x20C, bit 0) is used to choose whether the input pins or selection bits are used. When the CFG\_MODE bit is set to 0, the NCO\_x input pins select the active NCO frequency and phase setting. When the CFG\_MODE bit is set to 1, the NCO\_SEL register settings select the active NCO frequency and phase setting.

The frequency for each phase accumulator is programmed independently through the NCO\_FREQn (and optionally NCO\_RDIV) settings. The phase offset for each accumulator is programmed independently through the NCO\_PHASEn register settings.

#### 7.3.6.2.2 NCO\_0, NCO\_1, and NCO\_2 (NCO\_x)

When the CFG\_MODE bit is set to 0, the state of these three inputs determines the active NCO frequency and phase accumulator settings.

#### 7.3.6.2.3 NCO\_SEL Bits (2:0)

When the CFG\_MODE bit is set to 1, the state of these register bits determines the active NCO frequency and phase accumulator settings.

### 7.3.6.2.4 NCO Frequency Setting (Eight Total)

#### 7.3.6.2.4.1 Basic NCO Frequency-Setting Mode

In basic NCO frequency-setting mode, the NCO frequency setting is set by the 32-bit register value, NCO\_FREQ<sub>n</sub> (n = preset 0 through 7, see the [NCO Frequency \(Preset x\) Register](#) section).

$$(n = 0 - 7) f_{(NCO)} = \text{NCO\_FREQ}_n \times 2^{-32} \times f_{(DEVCLK)} \quad (3)$$

#### NOTE

Changing the register setting after the JESD204B interface is running results in non-deterministic NCO phase. If deterministic phase is required, the JESD204B link must be re-initialized after changing the register setting. See the [Multiple ADC Synchronization](#) section.

#### 7.3.6.2.4.2 Rational NCO Frequency Setting Mode

In basic NCO frequency mode, the frequency step size is very small and many frequencies can be synthesized, but sometimes an application requires very specific frequencies that fall between two frequency steps. For example with  $f_S$  equal to 2457.6 MHz and a desired  $f_{(NCO)}$  equal to 5.02 MHz the value for NCO\_FREQ is 8773085.867. Truncating the fractional portion results in an  $f_{(NCO)}$  equal to 5.0199995 MHz, which is not the desired frequency.

To produce the desired frequency, the NCO\_RDIV parameter is used to force the phase accumulator to arrive at specific frequencies without error. First, select a frequency step size ( $f_{(STEP)}$ ) that is appropriate for the NCO frequency steps required. The typical value of  $f_{(STEP)}$  is 10 kHz. Next, program the NCO\_RDIV value according to [Equation 4](#).

$$\text{NCO\_RDIV} = \frac{\left( \frac{f_{(DEVCLK)}}{f_{(STEP)}} \right)}{128} \quad (4)$$

The result of [Equation 4](#) must be an integer value. If the value is not an integer, adjust either of the parameters until the result is an integer value.

For example, select a value of 1920 for NCO\_RDIV.

#### NOTE

NCO\_RDIV values larger than 8192 can degrade the NCO SFDR performance and are not recommended.

Now use [Equation 5](#) to calculate the NCO\_FREQ register value.

$$\text{NCO\_FREQ} = \text{round} \times \left( \frac{2^{25} \times N}{\text{NCO\_RDIV}} \right) \quad (5)$$

Alternatively, the following equations can be used:

$$N = \frac{f_{(NCO)}}{f_{(STEP)}} \quad (6)$$

$$\text{NCO\_FREQ} = \text{round} \times \left( \frac{2^{25} \times N}{\text{NCO\_RDIV}} \right) \quad (7)$$

**Table 5. Common NCO\_RDIV Values (For 10-kHz Frequency Steps)**

| $f_{(DEVCLK)}$ (MHz) | NCO_RDIV |
|----------------------|----------|
| 2457.6               | 1920     |
| 1966.08              | 1536     |
| 1474.56              | 1152     |
| 1228.8               | 960      |

#### 7.3.6.2.5 NCO Phase-Offset Setting (Eight Total)

The NCO phase-offset setting is set by the 16-bit register value NCO\_PHASEn (n = preset 0 through 7, see the [NCO Phase \(Preset x\) Register](#) section). The value is left-justified into a 32-bit field and then added to the phase accumulator.

Use [Equation 8](#) to calculate the phase offset in radians.

$$\text{NCO\_PHASEn} \times 2^{-16} \times 2 \times \pi \quad (8)$$

#### NOTE

Changing the register setting after the JESD204B interface is running results in non-deterministic NCO phase. If deterministic phase is required, the JESD204B link must be re-initialized after changing the register setting. See [Multiple ADC Synchronization](#).

#### 7.3.6.2.6 Programmable DDC Delay

The DDC Filter elements incorporate a programmable sample delay. The delay can be programmed from 0 to (decimation setting – 0.5) ADC sample periods. The delay step-size is 0.5 ADC sample periods. The delay settings are programmed through the DDC\_DLYn parameter.

**Table 6. Programmable DDC Delay Range**

| D (Decimation Setting) | Min Delay ( $t_{(DEVCLK)}$ ) | Max Delay ( $t_{(DEVCLK)}$ ) |
|------------------------|------------------------------|------------------------------|
| 4                      | 0                            | 3.5                          |
| 8                      | 0                            | 7.5                          |
| 10                     | 0                            | 9.5                          |
| 16                     | 0                            | 15.5                         |
| 20                     | 0                            | 19.5                         |
| 32                     | 0                            | 31.5                         |

### 7.3.6.3 Decimation Filters

The decimation filters are arranged to provide a programmable overall decimation of 4, 8, 10, 16, 20, or 32. The input and output of each filter is complex. The output data consists of 15-bit complex baseband information. [Table 7](#) lists the effective output sample rates.

**Table 7. Output Sample Rates**

| DECIMATION SETTING | COMPLEX SAMPLE OUTPUT RATE AND RESULTING BANDWIDTH<br>(OUTPUT SAMPLE = 15-BIT I + 15-BIT Q + 2-BIT OR) |                            |                                 |                                   |                            |                                 |
|--------------------|--|----------------------------|---------------------------------|-----------------------------------|----------------------------|---------------------------------|
|                    | $f_{(DEVCLK)}$   |                            |                                 | $f_{(DEVCLK)} = 4000 \text{ MHz}$ |                            |                                 |
|                    | OUTPUT RATE (MSPS)   | RAW OUTPUT BANDWIDTH (MHz) | ALIAS PROTECTED BANDWIDTH (MHz) | OUTPUT RATE (MSPS)                | RAW OUTPUT BANDWIDTH (MHz) | ALIAS PROTECTED BANDWIDTH (MHz) |
| 4                  | $f_{(DEVCLK)} / 4$   | $f_{(DEVCLK)} / 4$         | $0.8 \times f_{(DEVCLK)} / 4$   | 1000                              | 1000                       | 800                             |
| 8                  | $f_{(DEVCLK)} / 8$   | $f_{(DEVCLK)} / 8$         | $0.8 \times f_{(DEVCLK)} / 8$   | 500                               | 500                        | 400                             |
| 10                 | $f_{(DEVCLK)} / 10$  | $f_{(DEVCLK)} / 10$        | $0.8 \times f_{(DEVCLK)} / 10$  | 400                               | 400                        | 320                             |
| 16                 | $f_{(DEVCLK)} / 16$  | $f_{(DEVCLK)} / 16$        | $0.8 \times f_{(DEVCLK)} / 16$  | 250                               | 250                        | 200                             |
| 20                 | $f_{(DEVCLK)} / 20$  | $f_{(DEVCLK)} / 20$        | $0.8 \times f_{(DEVCLK)} / 20$  | 200                               | 200                        | 160                             |
| 32                 | $f_{(DEVCLK)} / 32$  | $f_{(DEVCLK)} / 32$        | $0.8 \times f_{(DEVCLK)} / 32$  | 125                               | 125                        | 100                             |

For maximum efficiency a group of high speed filter blocks are implemented with specific blocks used for each decimation setting. The first table below describes the combination of filter blocks used for each decimation setting. The next table lists the coefficient details and decimation factor of each filter block.

**Table 8. Decimation Mode Filter Usage**

| Decimation Setting | Filter Blocks Used         |
|--------------------|----------------------------|
| 4                  | CS19, CS55                 |
| 8                  | CS11, CS15, CS55           |
| 10                 | CS11, CS139                |
| 16                 | CS7, CS11, CS15, CS55      |
| 20                 | CS7, CS11, CS139           |
| 32                 | CS7, CS7, CS11, CS15, CS55 |

**Table 9. Filter Coefficient Details**

| Filter Coefficient Set (Decimation Factor of Filter) |     |             |      |              |       |              |       |               |        |           |       |
|--|-----|-------------|------|--------------|-------|--------------|-------|---------------|--------|-----------|-------|
| CS7 (2)  |     | CS11 (2)    |      | CS15 (2)     |       | CS19 (2)     |       | CS55 (2)      |        | CS139 (5) |       |
| -65  | -65 | 109         | 109  | -327         | -327  | 22           | 22    | -37           | -37    | -5        | -5    |
| 0  | 0   | 0           | 0    | 0            | 0     | 0            | 0     | 0             | 0      | -9        | -9    |
| 577  | 577 | -837        | -837 | 2231         | 2231  | -174         | -174  | 118           | 118    | -9        | -9    |
| <b>1024</b>  |     | 0           | 0    | 0            | 0     | 0            | 0     | 0             | 0      | -5        | -5    |
|  |     | 4824        | 4824 | -8881        | -8881 | 744          | 744   | -291          | -291   | 0         | 0     |
|  |     | <b>8192</b> |      | 0            | 0     | 0            | 0     | 0             | 0      | 20        | 20    |
|  |     |             |      | 39742        | 39742 | -2429        | -2429 | 612           | 612    | 33        | 33    |
|  |     |             |      | <b>65536</b> |       | 0            | 0     | 0             | 0      | 33        | 33    |
|  |     |             |      |              |       | 10029        | 10029 | -1159         | -1159  | 21        | 21    |
|  |     |             |      |              |       | <b>16384</b> |       | 0             | 0      | 0         | 0     |
|  |     |             |      |              |       |              |       | 2031          | 2031   | -54       | -54   |
|  |     |             |      |              |       |              |       | 0             | 0      | -88       | -88   |
|  |     |             |      |              |       |              |       | -3356         | -3356  | -89       | -89   |
|  |     |             |      |              |       |              |       | 0             | 0      | -56       | -56   |
|  |     |             |      |              |       |              |       | 5308          | 5308   | 0         | 0     |
|  |     |             |      |              |       |              |       | 0             | 0      | 119       | 119   |
|  |     |             |      |              |       |              |       | -8140         | -8140  | 196       | 196   |
|  |     |             |      |              |       |              |       | 0             | 0      | 199       | 199   |
|  |     |             |      |              |       |              |       | 12284         | 12284  | 125       | 125   |
|  |     |             |      |              |       |              |       | 0             | 0      | 0         | 0     |
|  |     |             |      |              |       |              |       | -18628        | -18628 | -234      | -234  |
|  |     |             |      |              |       |              |       | 0             | 0      | -385      | -385  |
|  |     |             |      |              |       |              |       | 29455         | 29455  | -393      | -393  |
|  |     |             |      |              |       |              |       | 0             | 0      | -248      | -248  |
|  |     |             |      |              |       |              |       | -53191        | -53191 | 0         | 0     |
|  |     |             |      |              |       |              |       | 0             | 0      | 422       | 422   |
|  |     |             |      |              |       |              |       | 166059        | 166059 | 696       | 696   |
|  |     |             |      |              |       |              |       | <b>262144</b> |        | 711       | 711   |
|  |     |             |      |              |       |              |       |               |        | 450       | 450   |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |
|  |     |             |      |              |       |              |       |               |        | -711      | -711  |
|  |     |             |      |              |       |              |       |               |        | -1176     | -1176 |
|  |     |             |      |              |       |              |       |               |        | -1206     | -1206 |
|  |     |             |      |              |       |              |       |               |        | -766      | -766  |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |
|  |     |             |      |              |       |              |       |               |        | 1139      | 1139  |
|  |     |             |      |              |       |              |       |               |        | 1893      | 1893  |
|  |     |             |      |              |       |              |       |               |        | 1949      | 1949  |
|  |     |             |      |              |       |              |       |               |        | 1244      | 1244  |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |
|  |     |             |      |              |       |              |       |               |        | -1760     | -1760 |
|  |     |             |      |              |       |              |       |               |        | -2940     | -2940 |
|  |     |             |      |              |       |              |       |               |        | -3044     | -3044 |
|  |     |             |      |              |       |              |       |               |        | -1955     | -1955 |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |
|  |     |             |      |              |       |              |       |               |        | 2656      | 2656  |
|  |     |             |      |              |       |              |       |               |        | 4472      | 4472  |
|  |     |             |      |              |       |              |       |               |        | 4671      | 4671  |
|  |     |             |      |              |       |              |       |               |        | 3026      | 3026  |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |
|  |     |             |      |              |       |              |       |               |        | -3993     | -3993 |
|  |     |             |      |              |       |              |       |               |        | -6802     | -6802 |
|  |     |             |      |              |       |              |       |               |        | -7196     | -7196 |
|  |     |             |      |              |       |              |       |               |        | -4730     | -4730 |
|  |     |             |      |              |       |              |       |               |        | 0         | 0     |

**Table 9. Filter Coefficient Details (continued)**

| Filter Coefficient Set (Decimation Factor of Filter) |  |          |  |          |  |          |  |          |  |               |        |
|--|--|----------|--|----------|--|----------|--|----------|--|---------------|--------|
| CS7 (2)  |  | CS11 (2) |  | CS15 (2) |  | CS19 (2) |  | CS55 (2) |  | CS139 (5)     |        |
|  |  |          |  |          |  |          |  |          |  | 6159          | 6159   |
|  |  |          |  |          |  |          |  |          |  | 10707         | 10707  |
|  |  |          |  |          |  |          |  |          |  | 11593         | 11593  |
|  |  |          |  |          |  |          |  |          |  | 7825          | 7825   |
|  |  |          |  |          |  |          |  |          |  | 0             | 0      |
|  |  |          |  |          |  |          |  |          |  | -10423        | -10423 |
|  |  |          |  |          |  |          |  |          |  | -18932        | -18932 |
|  |  |          |  |          |  |          |  |          |  | -21629        | -21629 |
|  |  |          |  |          |  |          |  |          |  | -15618        | -15618 |
|  |  |          |  |          |  |          |  |          |  | 0             | 0      |
|  |  |          |  |          |  |          |  |          |  | 24448         | 24448  |
|  |  |          |  |          |  |          |  |          |  | 52645         | 52645  |
|  |  |          |  |          |  |          |  |          |  | 78958         | 78958  |
|  |  |          |  |          |  |          |  |          |  | 97758         | 97758  |
|  |  |          |  |          |  |          |  |          |  | <b>104858</b> |        |

### 7.3.6.4 DDC Output Data

The DDC output data consist of 15-bit complex data plus the two over-range threshold-detection control bits. The following table lists the data format:

| CHANNEL | 16-BIT OUTPUT WORD               |    |    |    |    |    |   |   |   |   |   |   |   |   |   |       |
|---------|----------------------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|-------|
|         | 15                               | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0     |
| I       | DDC Output In-Phase (I) 15 bit   |    |    |    |    |    |   |   |   |   |   |   |   |   |   | OR_T0 |
| Q       | DDC Output Quadrature (Q) 15 bit |    |    |    |    |    |   |   |   |   |   |   |   |   |   | OR_T1 |

### 7.3.6.5 Decimation Settings

#### 7.3.6.5.1 Decimation Factor

The decimation setting is adjustable over the following settings:

- Bypass — no decimation
- Decimate-by-4
- Decimate-by-8
- Decimate-by-10
- Decimate-by-16
- Decimate-by-20
- Decimate-by-32

#### NOTE

Because the output format is complex I+Q, the effective output bandwidth is approximately two-times the value for a *real* output with the same decimation factor.

#### 7.3.6.5.2 DDC Gain Boost

The DDC gain boost (register 0x200, bit 4) provides additional gain through the DDC block. With a setting of 1 the final filter has 6.02-dB gain. With a setting of 0, the final filter has a 0-dB gain. This setting is recommended when the NCO is set near DC.

### 7.3.7 Data Outputs

The data outputs (DSx±) are very high-speed differential outputs and conform to the JESD204B JEDEC standard. A CML (current-mode logic)-type output driver is used for each output pair. Output pre-emphasis is adjustable to compensate for longer PCB-trace lengths.

### 7.3.7.1 The Digital Outputs

The ADC12J1600 and ADC12J2700 output data is transmitted on up to eight high-speed serial-data lanes. The output data from the ADC or DDC is formatted to the eight lanes, 8b10b encoded, and serialized. Up to four different serial output rates are possible depending on the decimation mode setting: 1x, 1.25x, 2x, and 2.5x. In 1x mode, the output serializers run at the same bit rate as the frequency of the applied DEVCLK. In 1.25x mode, the output serializers run at a bit rate that is 1.25-times that of the applied DEVCLK, and so on. For example, for a 1.6-GHz input DEVCLK, the output rates are 1.6 Gbps in 1x mode, 2 Gbps in 1.25x mode, 3.2 Gbps in 2x mode and 4 Gbps in 2.5x mode.

### 7.3.7.2 JESD204B Interface Features and Settings

#### 7.3.7.2.1 Scrambler Enable

Scrambling randomizes the 8b10b encoded data, spreading the frequency content of the data interface. This reduces the peak EMI energy at any given frequency reducing the possibility of feedback to the device inputs impacting performance. The scrambler is disabled by default and is enabled via SCR (register 0x201, bit 7).

#### 7.3.7.2.2 Frames Per Multi-Frame (K-1)

The frames per multi-frame (K) setting can be adjusted within constraints that are dependant on the selected decimation (D) and serial rate (DDR) settings. The K-minus-1 (KM1) register setting (register 0x201, bits 6:2) must be one less than the desired K setting.

#### 7.3.7.2.3 DDR

The serial rate can be either  $1f_{(CLK)}$  (DDR = 0) or  $2f_{(CLK)}$  (DDR = 1).

#### 7.3.7.2.4 JESD Enable

The JESD interface must be disabled (JESD\_EN is set to 0) while any of the other JESD parameters are changed. While JESD\_EN is set 0 the block is held in reset and the serializers are powered down. The clocks for this section are also gated off to further save power. When the parameters have been set as desired the JESD block can be enabled (JESD\_EN is set to 1).

#### 7.3.7.2.5 JESD Test Modes

Several different JESD204B test modes are available to assist in link verification and debugging. The list of modes follows.

---

#### NOTE

PRBS test signals are output directly, without 8b10b encoding.

---

- Normal operation
- PRBS7 test mode
- PRBS15 test mode
- PRBS23 test mode
- Ramp test mode
- Short or long transport-layer test mode
- D21.5 test mode
- K28.5 test mode
- Repeated ILA test mode
- Modified RPAT test mode
- Serial-outputs differential 0 test mode
- Serial-outputs differential 1 test mode

### 7.3.7.2.6 Configurable Pre-Emphasis

The high-speed serial-output drivers incorporate a configurable pre-emphasis feature. This feature allows the output drive waveform to be optimized for different PCB materials and signal transmission distances. The pre-emphasis setting is adjusted through the serializer pre-emphasis setting in register 0x040, bits 3 to 0. The default setting is 4d. Higher values will increase the pre-emphasis to compensate for more lossy PCB materials. This adjustment is best used in conjunction with an eye-diagram analysis capability in the receiver. The pre-emphasis setting should be adjusted to optimize the eye-opening for the hardware configuration and line rates needed.

### 7.3.7.2.7 Serial Output-Data Formatting

Output data is generated by the DDC then formatted according to the selected decimation and output rate settings. When less than the maximum of eight lanes are active, lanes are disabled beginning with the highest numerical lanes. For example when only two lanes are active, lanes 0 and 1 are active, while all higher lanes are inactive.

**Table 10. Parameter Definitions**

| PARAMETER | DESCRIPTION  | USER CONFIGURED OR DERIVED | STANDARD JESD204B LINK PARAMETER |
|-----------|--|----------------------------|----------------------------------|
| D         | Decimation factor, determined by DMODE register  | User                       | No                               |
| DDR       | Serial line rate: 1 = DDR rate (2x), 0 = SDR rate (1x)   | User                       | No                               |
| P54       | Enable 5/4 PLL to increase line rate by 1.25x.<br>0 = no PLL (1x), 1 = enable PLL (1.25x)                          | User                       | No                               |
| K         | Number of frames per multiframe  | User                       | Yes                              |
| N         | Bits per sample (before adding control bits and tails bits)  | Derived                    | Yes                              |
| CS        | Control bits per sample  | Derived                    | Yes                              |
| N'        | Bits per sample (after adding control bits and tail bits). Must be a multiple of 4.                                | Derived                    | Yes                              |
| L         | Number of serial lanes   | Derived                    | Yes                              |
| F         | Number of octets (bytes) per frame (per lane)  | Derived                    | Yes                              |
| M         | Number of (logical) converters   | Derived                    | Yes                              |
| S         | Number of samples per converter per frame  | Derived                    | Yes                              |
| CF        | Number of control words per frame  | Derived                    | Yes                              |
| HD        | 1=High density mode (samples may be broken across lanes), 0 = normal mode (samples may not be broken across lanes) | Derived                    | Yes                              |
| KS        | Legal adjustment step for K, to ensure that the multi-frame clock is a sub-harmonic of other internal clocks       | Derived                    | No                               |

**Table 11. Serial Link Parameters<sup>(1)</sup>**

| USER SPECIFIED PARAMETERS |     |     | DERIVED PARAMETERS |    |    |   |   |   |   |    | OTHER INFORMATION |                                     |
|---------------------------|-----|-----|--------------------|----|----|---|---|---|---|----|-------------------|-------------------------------------|
| DECIMATION FACTOR (D)     | DDR | P54 | N                  | CS | N' | L | F | M | S | KS | LEGAL K RANGE     | BIT RATE / ADC CLOCK <sup>(2)</sup> |
| 1                         | 1   | 0   | 12                 | 0  | 12 | 8 | 8 | 8 | 5 | 2  | 4-32              | 2x                                  |
| 4                         | 1   | 0   | 15                 | 1  | 16 | 5 | 4 | 2 | 5 | 4  | 8-32              | 2x                                  |
| 4                         | 1   | 1   | 15                 | 1  | 16 | 4 | 2 | 2 | 2 | 2  | 10-32             | 2.5x                                |
| 8                         | 0   | 0   | 15                 | 1  | 16 | 5 | 4 | 2 | 5 | 2  | 6-32              | 1x                                  |
| 8                         | 0   | 1   | 15                 | 1  | 16 | 4 | 2 | 2 | 2 | 1  | 9-32              | 1.25x                               |
| 8                         | 1   | 0   | 15                 | 1  | 16 | 3 | 8 | 2 | 5 | 2  | 4-32              | 2x                                  |
| 8                         | 1   | 1   | 15                 | 1  | 16 | 2 | 2 | 2 | 1 | 2  | 10-32             | 2.5x                                |
| 10                        | 0   | 0   | 15                 | 1  | 16 | 4 | 2 | 2 | 2 | 4  | 12-32             | 1x                                  |
| 10                        | 1   | 0   | 15                 | 1  | 16 | 2 | 2 | 2 | 1 | 8  | 16-32             | 2x                                  |
| 16                        | 0   | 0   | 15                 | 1  | 16 | 3 | 8 | 2 | 5 | 1  | 3-32              | 1x                                  |
| 16                        | 0   | 1   | 15                 | 1  | 16 | 2 | 2 | 2 | 1 | 1  | 9-32              | 1.25x                               |

(1) In all modes: HD = 0 and CF = 0

(2) x = times (for example, 2x = 2-times)

**Table 11. Serial Link Parameters<sup>(1)</sup> (continued)**

| USER SPECIFIED PARAMETERS |     |     | DERIVED PARAMETERS |    |    |   |    |   |   |    | OTHER INFORMATION |                                     |
|---------------------------|-----|-----|--------------------|----|----|---|----|---|---|----|-------------------|-------------------------------------|
| DECIMATION FACTOR (D)     | DDR | P54 | N                  | CS | N' | L | F  | M | S | KS | LEGAL K RANGE     | BIT RATE / ADC CLOCK <sup>(2)</sup> |
| 16                        | 1   | 0   | 15                 | 1  | 16 | 2 | 16 | 2 | 5 | 1  | 2-32              | 2x                                  |
| 16                        | 1   | 1   | 15                 | 1  | 16 | 1 | 4  | 2 | 1 | 1  | 5-32              | 2.5x                                |
| 20                        | 0   | 0   | 15                 | 1  | 16 | 2 | 2  | 2 | 1 | 4  | 12-32             | 1x                                  |
| 20                        | 1   | 0   | 15                 | 1  | 16 | 1 | 4  | 2 | 1 | 4  | 8-32              | 2x                                  |
| 32                        | 0   | 0   | 15                 | 1  | 16 | 2 | 16 | 2 | 5 | 1  | 2-32              | 1x                                  |
| 32                        | 0   | 1   | 15                 | 1  | 16 | 1 | 4  | 2 | 1 | 1  | 5-32              | 1.25x                               |
| 32                        | 1   | 0   | 15                 | 1  | 16 | 1 | 32 | 2 | 5 | 1  | 1-32              | 2x                                  |

Output data is formatted in a specific optimized fashion for each decimation and DDR setting combination. For bypass mode (decimation = 1) the 12-bit offset binary values are mapped to the 8-bit characters. For the DDC mode the 16-bit values (15-bit complex data plus 1 bit OR\_Tn) are mapped to the 8-bit characters. The following tables list the specific mapping formats. In all mappings the T or tail bits are 0 (zero).

**Table 12. Bypass Mode, No Decimation, DDR = 1, P54 = 0, LMF = 8,8,8**

| CHAR NUMBER | TIME →  |   |      |   |      |   |      |      |   |
|-------------|---------|---|------|---|------|---|------|------|---|
|             | 0       | 1 | 2    | 3 | 4    | 5 | 6    | 7    |   |
| Lane 0      | C0S0    |   | C0S1 |   | C0S2 |   | C0S3 | C0S4 | T |
| Lane 1      | C1S0    |   | C1S1 |   | C1S2 |   | C1S3 | C1S4 | T |
| Lane 2      | C2S0    |   | C2S1 |   | C2S2 |   | C2S3 | C2S4 | T |
| Lane 3      | C3S0    |   | C3S1 |   | C3S2 |   | C3S3 | C3S4 | T |
| Lane 4      | C4S0    |   | C4S1 |   | C4S2 |   | C4S3 | C4S4 | T |
| Lane 5      | C5S0    |   | C5S1 |   | C5S2 |   | C5S3 | C5S4 | T |
| Lane 6      | C6S0    |   | C6S1 |   | C6S2 |   | C6S3 | C6S4 | T |
| Lane 7      | C7S0    |   | C7S1 |   | C7S2 |   | C7S3 | C7S4 | T |
|             | Frame n |   |      |   |      |   |      |      |   |

**Table 13. Bypass Mode, No Decimation, DDR = 1, P54 = 0, Composite View of Interleaved Converters**

| CHAR NUMBER | TIME →  |   |     |   |     |   |     |     |   |
|-------------|---------|---|-----|---|-----|---|-----|-----|---|
|             | 0       | 1 | 2   | 3 | 4   | 5 | 6   | 7   |   |
| Lane 0      | S0      |   | S8  |   | S16 |   | S24 | S32 | T |
| Lane 1      | S1      |   | S9  |   | S17 |   | S25 | S33 | T |
| Lane 2      | S2      |   | S10 |   | S18 |   | S26 | S34 | T |
| Lane 3      | S3      |   | S11 |   | S19 |   | S27 | S35 | T |
| Lane 4      | S4      |   | S12 |   | S20 |   | S28 | S36 | T |
| Lane 5      | S5      |   | S13 |   | S21 |   | S29 | S37 | T |
| Lane 6      | S6      |   | S14 |   | S22 |   | S30 | S38 | T |
| Lane 7      | S7      |   | S15 |   | S23 |   | S31 | S39 | T |
|             | Frame n |   |     |   |     |   |     |     |   |

**Table 14. Decimate-by-4, DDR = 1, P54 = 0, LMF = 5,2,4**

| TIME →      |                |   |                |   |
|-------------|----------------|---|----------------|---|
| CHAR NUMBER | 0              | 1 | 2              | 3 |
| Lane 0      | I <sub>0</sub> |   | I <sub>1</sub> |   |
| Lane 1      | I <sub>2</sub> |   | I <sub>3</sub> |   |
| Lane 2      | I <sub>4</sub> |   | Q <sub>0</sub> |   |
| Lane 3      | Q <sub>1</sub> |   | Q <sub>2</sub> |   |
| Lane 4      | Q <sub>3</sub> |   | Q <sub>4</sub> |   |
| Frame n     |                |   |                |   |

**Table 15. Decimate-by-4, DDR = 1, P54 = 1, LMF = 4,2,2**

| TIME →      |                |             |                |   |                |   |
|-------------|----------------|-------------|----------------|---|----------------|---|
| CHAR NUMBER | 0              | 1           | 2              | 3 | 4              | 5 |
| Lane 0      | I <sub>0</sub> |             | I <sub>2</sub> |   | I <sub>4</sub> |   |
| Lane 1      | I <sub>1</sub> |             | I <sub>3</sub> |   | I <sub>5</sub> |   |
| Lane 2      | Q <sub>0</sub> |             | Q <sub>2</sub> |   | Q <sub>4</sub> |   |
| Lane 3      | Q <sub>1</sub> |             | Q <sub>3</sub> |   | Q <sub>5</sub> |   |
| Frame n     |                | Frame n + 1 |                |   | Frame n + 2    |   |

**Table 16. Decimate-by-8, DDR = 0, P54 = 0, LMF = 5,2,4**

| TIME →      |                |   |                |   |
|-------------|----------------|---|----------------|---|
| CHAR NUMBER | 0              | 1 | 2              | 3 |
| Lane 0      | I <sub>0</sub> |   | I <sub>1</sub> |   |
| Lane 1      | I <sub>2</sub> |   | I <sub>3</sub> |   |
| Lane 2      | I <sub>4</sub> |   | Q <sub>0</sub> |   |
| Lane 3      | Q <sub>1</sub> |   | Q <sub>2</sub> |   |
| Lane 4      | Q <sub>3</sub> |   | Q <sub>4</sub> |   |
| Frame n     |                |   |                |   |

**Table 17. Decimate-by-8, DDR = 0, P54 = 1, LMF = 4,2,2**

| TIME →      |                |             |                |   |                |   |
|-------------|----------------|-------------|----------------|---|----------------|---|
| CHAR NUMBER | 0              | 1           | 2              | 3 | 4              | 5 |
| Lane 0      | I <sub>0</sub> |             | I <sub>2</sub> |   | I <sub>4</sub> |   |
| Lane 1      | I <sub>1</sub> |             | I <sub>3</sub> |   | I <sub>5</sub> |   |
| Lane 2      | Q <sub>0</sub> |             | Q <sub>2</sub> |   | Q <sub>4</sub> |   |
| Lane 3      | Q <sub>1</sub> |             | Q <sub>3</sub> |   | Q <sub>5</sub> |   |
| Frame n     |                | Frame n + 1 |                |   | Frame n + 2    |   |

**Table 18. Decimate-by-8, DDR = 1, P54 = 0, LMF = 3,2,8**

| TIME →      |                |   |                |   |                |   |                |   |
|-------------|----------------|---|----------------|---|----------------|---|----------------|---|
| CHAR NUMBER | 0              | 1 | 2              | 3 | 4              | 5 | 6              | 7 |
| Lane 0      | I <sub>0</sub> |   | I <sub>1</sub> |   | I <sub>2</sub> |   | I <sub>3</sub> |   |
| Lane 1      | I <sub>4</sub> |   | Q <sub>0</sub> |   | Q <sub>1</sub> |   | Q <sub>2</sub> |   |
| Lane 2      | Q <sub>3</sub> |   | Q <sub>4</sub> |   | T              |   | T              |   |
| Frame n     |                |   |                |   |                |   |                |   |

**Table 19. Decimate-by-8, DDR = 1, P54=1, LMF = 2,2,2**

| TIME →      |         |   |             |   |             |   |
|-------------|---------|---|-------------|---|-------------|---|
| CHAR NUMBER | 0       | 1 | 2           | 3 | 4           | 5 |
| Lane 0      | $I_0$   |   | $I_1$       |   | $I_2$       |   |
| Lane 1      | $Q_0$   |   | $Q_1$       |   | $Q_2$       |   |
|             | Frame n |   | Frame n + 1 |   | Frame n + 2 |   |

**Table 20. Decimate-by-10, DDR = 0, P54 = 0, LMF = 4,2,2**

| TIME →      |         |   |             |   |             |   |             |   |
|-------------|---------|---|-------------|---|-------------|---|-------------|---|
| CHAR NUMBER | 0       | 1 | 2           | 3 | 4           | 5 | 6           | 7 |
| Lane 0      | $I_0$   |   | $I_2$       |   | $I_4$       |   | $I_6$       |   |
| Lane 1      | $I_1$   |   | $I_3$       |   | $I_5$       |   | $I_7$       |   |
| Lane 2      | $Q_0$   |   | $Q_2$       |   | $Q_4$       |   | $Q_6$       |   |
| Lane 3      | $Q_1$   |   | $Q_3$       |   | $Q_5$       |   | $Q_7$       |   |
|             | Frame n |   | Frame n + 1 |   | Frame n + 2 |   | Frame n + 3 |   |

**Table 21. Decimate-by-10, DDR = 1, P54 = 0, LMF = 2,2,2**

| TIME →      |         |   |             |   |             |   |             |   |
|-------------|---------|---|-------------|---|-------------|---|-------------|---|
| CHAR NUMBER | 0       | 1 | 2           | 3 | 4           | 5 | 6           | 7 |
| Lane 0      | $I_0$   |   | $I_1$       |   | $I_2$       |   | $I_3$       |   |
| Lane 1      | $Q_0$   |   | $Q_1$       |   | $Q_2$       |   | $Q_3$       |   |
|             | Frame n |   | Frame n + 1 |   | Frame n + 2 |   | Frame n + 3 |   |

**Table 22. Decimate-by-16, DDR = 0, P54 = 0, LMF = 3,2,8**

| TIME →      |         |   |       |   |       |   |       |   |
|-------------|---------|---|-------|---|-------|---|-------|---|
| CHAR NUMBER | 0       | 1 | 2     | 3 | 4     | 5 | 6     | 7 |
| Lane 0      | $I_0$   |   | $I_1$ |   | $I_2$ |   | $I_3$ |   |
| Lane 1      | $I_4$   |   | $Q_0$ |   | $Q_1$ |   | $Q_2$ |   |
| Lane 2      | $Q_3$   |   | $Q_4$ |   | T     |   | T     |   |
|             | Frame n |   |       |   |       |   |       |   |

**Table 23. Decimate-by-16, DDR = 0, P54 = 1, LMF = 2,2,2**

| TIME →      |         |   |             |   |             |   |
|-------------|---------|---|-------------|---|-------------|---|
| CHAR NUMBER | 0       | 1 | 2           | 3 | 4           | 5 |
| Lane 0      | $I_0$   |   | $I_1$       |   | $I_2$       |   |
| Lane 1      | $Q_0$   |   | $Q_1$       |   | $Q_2$       |   |
|             | Frame n |   | Frame n + 1 |   | Frame n + 2 |   |

**Table 24. Decimate-by-16, DDR = 1, P54 = 0, LMF = 2,2,16**

| TIME →      |         |   |       |   |       |   |       |   |       |   |       |    |       |    |       |    |
|-------------|---------|---|-------|---|-------|---|-------|---|-------|---|-------|----|-------|----|-------|----|
| CHAR NUMBER | 0       | 1 | 2     | 3 | 4     | 5 | 6     | 7 | 8     | 9 | 10    | 11 | 12    | 13 | 14    | 15 |
| Lane 0      | $I_0$   |   | $I_1$ |   | $I_2$ |   | $I_3$ |   | $I_4$ |   | $Q_0$ |    | $Q_1$ |    | $Q_2$ |    |
| Lane 1      | $Q_3$   |   | $Q_4$ |   | T     |   | T     |   | T     |   | T     |    | T     |    | T     |    |
|             | Frame n |   |       |   |       |   |       |   |       |   |       |    |       |    |       |    |

**Table 25. Decimate-by-16, DDR = 1, P54 = 1, LMF = 1,2,4**

| TIME →      |         |   |       |   |             |   |       |   |             |   |       |    |
|-------------|---------|---|-------|---|-------------|---|-------|---|-------------|---|-------|----|
| CHAR NUMBER | 0       | 1 | 2     | 3 | 4           | 5 | 6     | 7 | 8           | 9 | 10    | 11 |
| Lane 0      | $I_0$   |   | $Q_0$ |   | $I_1$       |   | $Q_1$ |   | $I_2$       |   | $Q_2$ |    |
|             | Frame n |   |       |   | Frame n + 1 |   |       |   | Frame n + 2 |   |       |    |

**Table 26. Decimate-by-20, DDR = 0, P54 = 0, LMF = 2,2,2**

| TIME →      |         |   |             |   |             |   |             |   |
|-------------|---------|---|-------------|---|-------------|---|-------------|---|
| CHAR NUMBER | 0       | 1 | 2           | 3 | 4           | 5 | 6           | 7 |
| Lane 0      | $I_0$   |   | $I_1$       |   | $I_2$       |   | $I_3$       |   |
| Lane 1      | $Q_0$   |   | $Q_1$       |   | $Q_2$       |   | $Q_3$       |   |
|             | Frame n |   | Frame n + 1 |   | Frame n + 2 |   | Frame n + 3 |   |

**Table 27. Decimate-by-20, DDR = 1, P54 = 0, LMF = 1,2,2**

| TIME →      |         |   |       |   |             |   |       |   |
|-------------|---------|---|-------|---|-------------|---|-------|---|
| CHAR NUMBER | 0       | 1 | 2     | 3 | 4           | 5 | 6     | 7 |
| Lane 0      | $I_0$   |   | $Q_0$ |   | $I_1$       |   | $Q_1$ |   |
|             | Frame n |   |       |   | Frame n + 1 |   |       |   |

**Table 28. Decimate-by-32, DDR = 0, P54 = 0, LMF = 2,2,16**

| TIME →      |         |       |   |       |   |       |   |       |   |       |    |       |    |       |    |    |
|-------------|---------|-------|---|-------|---|-------|---|-------|---|-------|----|-------|----|-------|----|----|
| CHAR NUMBER | 0       | 1     | 2 | 3     | 4 | 5     | 6 | 7     | 8 | 9     | 10 | 11    | 12 | 13    | 14 | 15 |
| Lane 0      | $I_0$   | $I_1$ |   | $I_2$ |   | $I_3$ |   | $I_4$ |   | $Q_0$ |    | $Q_1$ |    | $Q_2$ |    |    |
| Lane 1      | $Q_3$   | $Q_4$ |   | T     |   | T     |   | T     |   | T     |    | T     |    | T     |    |    |
|             | Frame n |       |   |       |   |       |   |       |   |       |    |       |    |       |    |    |

**Table 29. Decimate-by-32, DDR = 0, P54 = 1, LMF = 1,2,4**

| TIME →      |         |   |       |   |             |   |       |   |             |   |       |    |
|-------------|---------|---|-------|---|-------------|---|-------|---|-------------|---|-------|----|
| CHAR NUMBER | 0       | 1 | 2     | 3 | 4           | 5 | 6     | 7 | 8           | 9 | 10    | 11 |
| Lane 0      | $I_0$   |   | $Q_0$ |   | $I_1$       |   | $Q_1$ |   | $I_2$       |   | $Q_2$ |    |
|             | Frame n |   |       |   | Frame n + 1 |   |       |   | Frame n + 2 |   |       |    |

**Table 30. Decimate-by-32, DDR = 1, P54 = 0, LMF = 1,2,32**

| TIME →      |         |       |   |       |   |       |   |       |   |       |    |       |    |       |    |       |    |       |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
|-------------|---------|-------|---|-------|---|-------|---|-------|---|-------|----|-------|----|-------|----|-------|----|-------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| CHAR NUMBER | 0       | 1     | 2 | 3     | 4 | 5     | 6 | 7     | 8 | 9     | 10 | 11    | 12 | 13    | 14 | 15    | 16 | 17    | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 |
| Lane 0      | $I_0$   | $I_1$ |   | $I_2$ |   | $I_3$ |   | $I_4$ |   | $Q_0$ |    | $Q_1$ |    | $Q_2$ |    | $Q_3$ |    | $Q_4$ |    | T  |    | T  |    | T  |    | T  |    | T  |    | T  |    |    |
|             | Frame n |       |   |       |   |       |   |       |   |       |    |       |    |       |    |       |    |       |    |    |    |    |    |    |    |    |    |    |    |    |    |    |

The formatted data is 8b10b encoded and output on the serial lanes. The 8b10b encoding provides a number of specific benefits, including:

- Standard encoding format. Therefore the IP is readily available in off-the-shelf FPGAs and ASIC building blocks.
- Inherent DC balance allows AC coupling of lanes with small on-chip capacitors
- Inherent error checking

### 7.3.7.2.8 JESD204B Synchronization Features

The JESD204B standard defines methods for synchronization and deterministic latency in a multi-converter system. These devices are a JESD204B Subclass 1 device and conforms to the various aspects of link operation as described in section 5.3.3 of the JESD204B standard. The specific signals used to achieve link operation are described briefly in the following sections.

#### 7.3.7.2.9 SYSREF

The SYSREF is a periodic signal which is sampled by the device clock, and is used to align the boundary of the local multi-frame clock inside the data converter. SYSREF

is required to be a sub-harmonic of the LMFC internal timing. To meet this requirement, the timing of SYSREF is dependent on the device clock frequency and the LMFC frequency as determined by the selected DDC decimation and frames per multi-frame settings. This clock is typically in the range of 10 MHz to 300 MHz. See the [Multiple ADC Synchronization](#) section for more details on SYSREF timing requirements.

#### 7.3.7.2.10 SYNC~

SYNC~ is asserted by the receiver to initiate a synchronization event.

Single ended and differential SYNC~ inputs are provided. The SYNC\_DIFFSEL bit (register 0x202, bit 6) is used to select which input is used. Using the single ended SYNC~ input is recommended, as this frees the differential SYNC~/TMST input pair for use in the Time Stamp function. To assert SYNC~, a logic low is applied. To deassert SYNC~ a logic high is applied.

#### 7.3.7.2.11 Time Stamp

When configured through the TIME\_STAMP\_EN register setting (register 0x050, bit 5), the SYNC~ differential input (pins 22 and 23) can be used as a time-stamp input. The time-stamp feature enables the user to capture the timing of an external trigger event relative to the sampled signal. When enabled, the LSB of the 12-bit ADC digital output captures the trigger information. In effect, the 12-bit converter becomes an 11-bit converter and the LSB acts as a 1-bit converter with the same latency as the 11-bit converter. The trigger must be applied to the differential SYNC~/TMST inputs. The trigger can be asynchronous to the ADC sampling clock and is sampled at approximately the same time as the analog input.

#### 7.3.7.2.12 Code-Group Synchronization

Code-group synchronization is achieved using the following process:

- The receiver issues a synchronization request through the SYNC~ input
- The transmitter issues a stream of K28.5 symbols
- The receiver synchronizes and waits for correct reception of at least 4 consecutive K symbols
- The receiver deactivates the synchronization request
- Upon detecting that the receiver has deactivated the SYNC~ pin, the transmitter continues emitting K symbols until the next LMFC boundary (or optionally a later LMFC boundary)
- On the first frame following the selected LMFC boundary the transmitters emit an initial lane-alignment sequence

The initial-lane alignment sequence transmitted by the ADC device is defined in additional detail in JESD204B section 5.3.3.5.

#### 7.3.7.2.13 Multiple ADC Synchronization

The second function for the SYSREF input is to facilitate the precise synchronization of multiple ADCs in a system.

One key challenge is to ensure that this synchronization works is to ensure that the SYSREF inputs are repeatedly captured by the input CLK. Two key elements must occur for the SYSREF inputs to be captured. First, the SYSREF input must be created so that it is synchronous to the input DEVCLK, be an integer sub-harmonic of the multi-frame ( $K \times t_{(FRAME)}$ ) and a repeatable and fixed-phase offset. When this constraint is achieved, repeatedly capturing SYSREF is easier. To further ease this task, the SYSREF signal is routed through a user-adjustable delay which eases the timing requirements with respect to the input DEVCLK signal. The SYSREF delay RDEL is adjusted through bits 3 through 0 in register 0x032.

As long as the SYSREF signal has a fixed timing relationship to DEVCLK, the internal delay can be used to maximize the setup and hold times between the internally delayed SYSREF and the internal DEVCLK signal. These timing relationships are listed in the [Timing Requirements](#) table. To find the proper delay setting, the RDEL value is adjusted from minimum to maximum while applying SYSREF and monitoring the SysRefDet and Dirty Capture detect bits. The SysRefDet bit is set whenever a rising edge of SYSREF is detected. The Dirty Capture bit is set whenever the setup or hold time between DEVCLK and the delayed SYSREF is insufficient. The SysRefDetClr bit is used to clear the SysRefDet bit. The Clear Dirty Capture bit is used to clear that bit.

This procedure should be followed to determine the range of delay settings where a clean SYSREF capture is achieved. The delay value at the center of the clean capture range must be loaded as the final RDEL setting. [Table 31](#) lists a summary of the control bits that are used and the monitor bits that are read.

**Table 31. SYSREF Capture Control and Status**

| BIT NAME            | REGISTER ADDRESS | REGISTER BIT | FUNCTION  |
|---------------------|------------------|--------------|---|
| RDEL                | 0x032            | 3:0          | Adjust relative delay between DEVCLK and SYSREF   |
| SysRefDet           | 0x031            | 7            | Detect if a SYSREF rising edge has been captured (not self clearing)  |
| Dirty Capture       | 0x031            | 6            | Detect if SYSREF rising edge capture failed setup/hold (not self clearing)  |
| SysRefDetClr        | 0x030            | 5            | Clear SYSREF detection bit  |
| Clear Dirty Capture | 0x030            | 4            | Clear Dirty Capture detection bit   |
| SysRef_Rcvr_En      | 0x030            | 7            | Enable SYSREF receiver. See the CLKGEN_0 descriptions in the <a href="#">Clock Generator Control 0 Register</a> section for more information.   |
| SysRef_Pr_En        | 0x030            | 6            | Enable SYSREF processing. See the CLKGEN_0 descriptions in the <a href="#">Clock Generator Control 0 Register</a> section for more information. |

One final aspect of multi-device synchronization relates to phase alignment of the NCO phase accumulators when DDC modes are enabled. The NCO phase accumulators are reset during the ILA phase of link startup which means that for multiple ADCs to have NCO phase alignment, all links must be enabled in the same LMFC period. Enabling all links in the same LMFC period requires synchronizing the SYNC~ de-assertion across all data receivers in the system, so that all of the SYNC~ signals are released during the same LMFC period. Using large K values and resulting longer LMFC periods will ease this task, at the expense of potentially higher latency in the receiving device.

## 7.4 Device Functional Modes

### 7.4.1 DDC Bypass Mode

In DDC bypass mode (decimation = 1) the raw 12 bit data from the ADC is output at the full sampling rate.

### 7.4.2 DDC Modes

In the DDC modes (decimation > 1) complex (I,Q) data is output at a lower sample rate as determined by the decimation factor (4, 8, 10, 16, 20, and 32).

### 7.4.3 Calibration

Calibration adjusts the ADC core to optimize the following device parameters:

- ADC core linearity
- ADC core-to-core offset matching
- ADC core-to-core full-scale range matching
- ADC core 4-way interleave timing

All calibration processes occur internally. Calibration does not require any external signals to be present and works properly as long as the device is maintained within the values listed in the [Recommended Operating Conditions](#) table.

## Device Functional Modes (continued)

### 7.4.3.1 Foreground Calibration Mode

In foreground mode the calibration process interrupts normal ADC operation and no output data is available during this time (the output code is forced to a static value). The calibration process should be repeated if the device temperature changes by more than 20°C to ensure rated performance is maintained. Foreground calibration is initiated by setting the CAL\_SFT bit (register 0x050, bit 3) which is self clearing. The foreground calibration process finishes within  $t_{(CAL)}$  number of DEVCLK cycles. The process occurs somewhat longer when the timing calibration mode is enabled.

---

#### NOTE

Initiating a foreground calibration asynchronously resets the calibration control logic and may glitch internal device clocks. Therefore after setting the CAL\_SFT bit clearing and then setting JESD\_EN is necessary. If resetting the JESD204B link is undesirable for system reasons, background calibration mode may be preferred.

---

### 7.4.3.2 Background Calibration Mode

In background mode an additional ADC core is powered-up for a total of 5 ADC cores. At any given time, one core is off-line and not used for data conversion. This core is calibrated in the background and then placed on-line simultaneous with another core going off-line for calibration. This process operates continuously without interrupting data flow in the application and ensures that all cores are optimized in performance regardless of any changes of temperature. The background calibration cycle rate is fixed and is not adjustable by the user.

Because of the additional circuitry active in background calibration mode, a slight degradation in performance occurs in comparison to foreground calibration mode at a fixed temperature. As a result of this degradation, using foreground calibration mode is recommended if the expected change in operating temperature is <30°C. Using background calibration mode is recommended if the expected change in operating temperature is >30°C. The exact difference in performance is dependent on the DEVCLK (sampling clock) frequency, and the analog input signal frequency and amplitude. For this reason, device and system performance should be evaluated using both calibration modes before finalizing the choice of calibration mode.

To enable the background calibration feature, set the CAL\_BCK bit (register 0x057, bit 0) and the CAL\_CONT bit (register 0x057, bit 1). The value written to the register 0x057 to enable background calibration is therefore 0x013h. After writing this value to register 0x057, set the CAL\_SFT bit in register 0x050 to perform the one-time foreground calibration to begin the process.

---

#### NOTE

The ADC offset-adjust feature has no effect when background calibration mode is enabled.

---

### 7.4.4 Timing Calibration Mode

The timing calibration process optimizes the matching of sample timing for the 4 internally interleaved converters. This process minimize the presence of any timing related interleaving spurs in the captured spectrum. The timing calibration feature is disabled by default, but using this feature is highly recommended. To enable timing calibration, set the T\_AUTO bit (register 0x066, bit 0). When this bit is set, the timing calibration performs each time the CAL\_SFT bit is set.

**Device Functional Modes (continued)**
**Table 32. Calibration Cycle Timing for Different Calibration Modes and Options**

| CAL_CONT, CAL_BCK | T_AUTO | LOW_SIG_EN | INITIAL ONE-TIME<br>CALIBRATION<br>CAL_SFT 0 → 1<br>(t <sub>DEVCLK</sub> ) | BACKGROUND<br>CALIBRATION CYCLE <sup>(1)</sup><br>(ALL CORES)<br>(t <sub>DEVCLK</sub> ) |
|-------------------|--------|------------|--|---|
| 0                 | 0      | 0          | 102 E+6  | N/A   |
| 0                 | 0      | 1          | 64 E+6   | N/A   |
| 0                 | 1      | 0          | 227 E+6  | N/A   |
| 0                 | 1      | 1          | 189 E+6  | N/A   |
| 1                 | 0      | 0          | 127.5 E+6  | 816 E+6   |
| 1                 | 0      | 1          | 80 E+6   | 512 E+6   |
| 1                 | 1      | 0          | 283.75 E+6   | 816 E+6   |
| 1                 | 1      | 1          | 236.25 E+6   | 512 E+6   |

(1) N/A = not applicable

**7.4.5 Test-Pattern Modes**

A number of device test modes are available. These modes insert known patterns of information into the device data path for assistance with system debug, development, or characterization.

**7.4.5.1 ADC Test-Pattern Mode**

The 12-bit ADC core has a built-in test-pattern generator. This mode is helpful for verifying the full data link from the ADC to the data receiver when in DDC bypass mode. When the test-pattern mode is enabled, the ADC output data is replaced by a pattern that repeats every two frames. The data sequence is shown in [Table 33](#) (shown for default settings with foreground calibration mode).

**Table 33. ADC Test Pattern<sup>(1)</sup>**

| LANE<br>(CONVERTER<br>ID) | SAMPLE NUMBER (SID) |       |       |       |       |       |       |       |       |       |
|---------------------------|---------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
|                           | 0                   | 1     | 2     | 3     | 4     | 5     | 6     | 7     | 8     | 9     |
| 0                         | 0x000               | 0xFFF | 0x000 | 0xFFF | 0x000 | 0xFFF | 0x000 | 0xFFF | 0x000 | 0xFFF |
| 1                         | 0x008               | 0xFF7 | 0x008 | 0xFF7 | 0x008 | 0xFF7 | 0x008 | 0xFF7 | 0x008 | 0xFF7 |
| 2                         | 0x010               | 0xFEf | 0x010 | 0xFEf | 0x010 | 0xFEf | 0x010 | 0xFEf | 0x010 | 0xFEf |
| 3                         | 0x020               | 0xFDF | 0x020 | 0xFDF | 0x020 | 0xFDF | 0x020 | 0xFDF | 0x020 | 0xFDF |
| 4                         | 0x040               | 0xFBF | 0x040 | 0xFBF | 0x040 | 0xFBF | 0x040 | 0xFBF | 0x040 | 0xFBF |
| 5                         | 0x100               | 0xEFF | 0x100 | 0xEFF | 0x100 | 0xEFF | 0x100 | 0xEFF | 0x100 | 0xEFF |
| 6                         | 0x200               | 0xDFF | 0x200 | 0xDFF | 0x200 | 0xDFF | 0x200 | 0xDFF | 0x200 | 0xDFF |
| 7                         | 0x400               | 0xBFF | 0x400 | 0xBFF | 0x400 | 0xBFF | 0x400 | 0xBFF | 0x400 | 0xBFF |

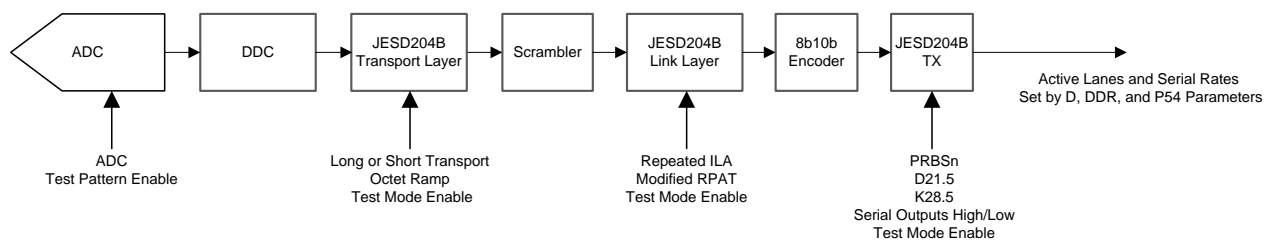
(1) When background-calibration mode is enabled, the pattern values are dynamic because the internal converter banks are output on different lanes during the calibration bank-switching process. Each converter bank has dedicated pattern values as listed in [Table 34](#).

**Table 34. ADC Bank Pattern Values**

| BANK | LOCATION | LOW VALUE | HIGH VALUE |
|------|----------|-----------|------------|
| 0    | Lane n   | 0x000     | 0xFFF      |
|      | Lane n+4 | 0x040     | 0xFBF      |
| 1    | Lane n   | 0x004     | 0xFFE      |
|      | Lane n+4 | 0x080     | 0xF7F      |
| 2    | Lane n   | 0x008     | 0xFF7      |
|      | Lane n+4 | 0x100     | 0xEFF      |
| 3    | Lane n   | 0x010     | 0xFEf      |
|      | Lane n+4 | 0x200     | 0xDFF      |
| 4    | Lane n   | 0x020     | 0xFDF      |
|      | Lane n+4 | 0x400     | 0xBFF      |

#### 7.4.5.2 Serializer Test-Mode Details

Test modes are enabled by setting the appropriate configuration of the JESD204B\_TEST setting (Register 0x202, Bits 3:0). Each test mode is described in detail in the following sections. Regardless of the test mode, the serializer outputs are powered up based on the configuration decimation and DDR settings. The test modes should only be enabled while the JESD204B link is disabled.


**Figure 66. Test-Mode Insertion Points**

### 7.4.5.3 PRBS Test Modes

The PRBS test modes bypass the 8B10B encoder. These test modes produce pseudo-random bit streams that comply with the ITU-T O.150 specification. These bit streams are used with lab test equipment that can self-synchronize to the bit pattern and therefore the initial phase of the pattern is not defined.

The sequences are defined by a recursive equation. For example, the PRBS7 sequence is defined as shown in Equation 9.

$$y[n] = y[n - 6] \oplus y[n - 7]$$

where

- Bit n is the XOR of bit [n – 6] and bit [n – 7] which are previously transmitted bits (9)

**Table 35. PBRs Mode Equations**

| PRBS TEST MODE | SEQUENCE                            | SEQUENCE LENGTH (bits) |
|----------------|-------------------------------------|------------------------|
| PRBS7          | $y[n] = y[n - 6] \oplus y[n - 7]$   | 127                    |
| PRBS15         | $y[n] = y[n - 14] \oplus y[n - 15]$ | 32767                  |
| PRBS23         | $y[n] = y[n - 18] \oplus y[n - 23]$ | 8388607                |

The initial phase of the pattern is unique for each lane.

### 7.4.5.4 Ramp Test Mode

In the ramp test mode, the JESD204B link layer operates normally, but the transport layer is disabled and the input from the formatter is ignored. After the ILA sequence, each lane transmits an identical octet stream that increments from 0x00 to 0xFF and repeats.

### 7.4.5.5 Short and Long-Transport Test Mode

The short-transport test mode is available when the device is operated in DDC bypass mode (decimation = 1). The short transport pattern has a length of one frame. Table 36 lists the formula followed by each sample of the pattern.

**Table 36. Short Transport Test Pattern Definition**

| BIT  |    |   |   |     |   |   |   |       |   |   |   |
|------|----|---|---|-----|---|---|---|-------|---|---|---|
| 11   | 10 | 9 | 8 | 7   | 6 | 5 | 4 | 3     | 2 | 1 | 0 |
| ~LID |    |   |   | LID |   |   |   | SID+1 |   |   |   |

LID is the lane ID (0 to 7) and SID is the sample number within the frame (0 to 4). The entire pattern has a length of one frame and is listed in Table 37.

**Table 37. Short Transport Test Pattern**

| LANE (CONVERTER ID) | SAMPLE NUMBER (SID) |       |       |       |       |
|---------------------|---------------------|-------|-------|-------|-------|
|                     | 0                   | 1     | 2     | 3     | 4     |
| 0                   | 0xF01               | 0xF02 | 0xF03 | 0xF04 | 0xF05 |
| 1                   | 0xE11               | 0xE12 | 0xE13 | 0xE14 | 0xE15 |
| 2                   | 0xD21               | 0xD22 | 0xD23 | 0xD24 | 0xD25 |
| 3                   | 0xC31               | 0xC32 | 0xC33 | 0xC34 | 0xC35 |
| 4                   | 0xB41               | 0xB42 | 0xB43 | 0xB44 | 0xB45 |
| 5                   | 0xA51               | 0xA52 | 0xA53 | 0xA54 | 0xA55 |
| 6                   | 0x961               | 0x962 | 0x963 | 0x964 | 0x965 |
| 7                   | 0x871               | 0x872 | 0x873 | 0x874 | 0x875 |

The long-transport test mode is available in all DDC modes (decimation > 1). Patterns are generated in accordance with the JESD204B standard and are different for each output format.

Table 38 lists one example of the long transport test pattern:

**Table 38. Long Transport Test Pattern - Decimate-by-4, DDR = 1, P54 = 1, K=10**

| CHAR NO. | TIME →  |   |           |   |           |   |           |   |           |   |           |    |           |    |           |    |           |    |           |    |            |
|----------|---------|---|-----------|---|-----------|---|-----------|---|-----------|---|-----------|----|-----------|----|-----------|----|-----------|----|-----------|----|------------|
|          | 0       | 1 | 2         | 3 | 4         | 5 | 6         | 7 | 8         | 9 | 10        | 11 | 12        | 13 | 14        | 15 | 16        | 17 | 18        | 19 | 20         |
| Lane 0   | 0x0003  |   | 0x0002    |   | 0x8000    |   | 0x8000    |   | 0x8000    |   | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x0003     |
| Lane 1   | 0x0002  |   | 0x0005    |   | 0x8000    |   | 0x8000    |   | 0x8000    |   | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x0002     |
| Lane 2   | 0x0004  |   | 0x0002    |   | 0x8001    |   | 0x8000    |   | 0x8000    |   | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x0004     |
| Lane 3   | 0x0004  |   | 0x0004    |   | 0x8000    |   | 0x8001    |   | 0x8000    |   | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x8000    |    | 0x0004     |
|          | Frame n |   | Frame n+1 |   | Frame n+2 |   | Frame n+3 |   | Frame n+4 |   | Frame n+5 |    | Frame n+6 |    | Frame n+7 |    | Frame n+8 |    | Frame n+9 |    | Frame n+10 |

If multiple devices are all programmed to the transport layer test mode (while JESD\_EN = 0), then JESD\_EN is set to 1, and then SYSREF is used to align the LMFC of the devices, the patterns will be aligned to the SYSREF event (within the skew budget of JESD204B). For more details see JESD204B, section 5.1.6.3.

#### 7.4.5.6 D21.5 Test Mode

In this test mode, the controller transmits a continuous stream of D21.5 characters (alternating 0s and 1s).

#### 7.4.5.7 K28.5 Test Mode

In this test mode, the controller transmits a continuous stream of K28.5 characters.

#### 7.4.5.8 Repeated ILA Test Mode

In this test mode, the JESD204B link layer operates normally with one exception: when the ILA sequence completes, the sequence repeats indefinitely. Whenever the receiver issues a synchronization request, the transmitter will initiate code group synchronization. Upon completion of code group synchronization, the transmitter will repeatedly transmit the ILA sequence. If there is no active code group synchronization request at the moment the transmitter enters the test mode, the transmitter will behave as if it received one.

#### 7.4.5.9 Modified RPAT Test Mode

A 12-octet repeating pattern is defined in INCITS TR-35-2004. The purpose of this pattern is to generate white spectral content for JESD204B compliance and jitter testing. Table 39 lists the pattern before and after 8b10b encoding.

**Table 39. Modified RPAT Pattern Values**

| OCTET NUMBER | Dx.y NOTATION | 8-BIT INPUT TO 8b10b ENCODER | 20b OUTPUT OF 8b10b ENCODER (2 CHARACTERS) |
|--------------|---------------|------------------------------|--|
| 0            | D30.5         | 0xBE                         | 0x86BA6                                    |
| 1            | D23.6         | 0xD7                         |  |
| 2            | D3.1          | 0x23                         | 0xC6475                                    |
| 3            | D7.2          | 0x47                         |  |
| 4            | D11.3         | 0x6B                         | 0xD0E8D                                    |
| 5            | D15.4         | 0x8F                         |  |
| 6            | D19.5         | 0xB3                         | 0xCA8B4                                    |
| 7            | D20.0         | 0x14                         |  |
| 8            | D30.2         | 0x5E                         | 0x7949E                                    |
| 9            | D27.7         | 0xFB                         |  |
| 10           | D21.1         | 0x35                         | 0xAA665                                    |
| 11           | D25.2         | 0x59                         |  |

## 7.5 Programming

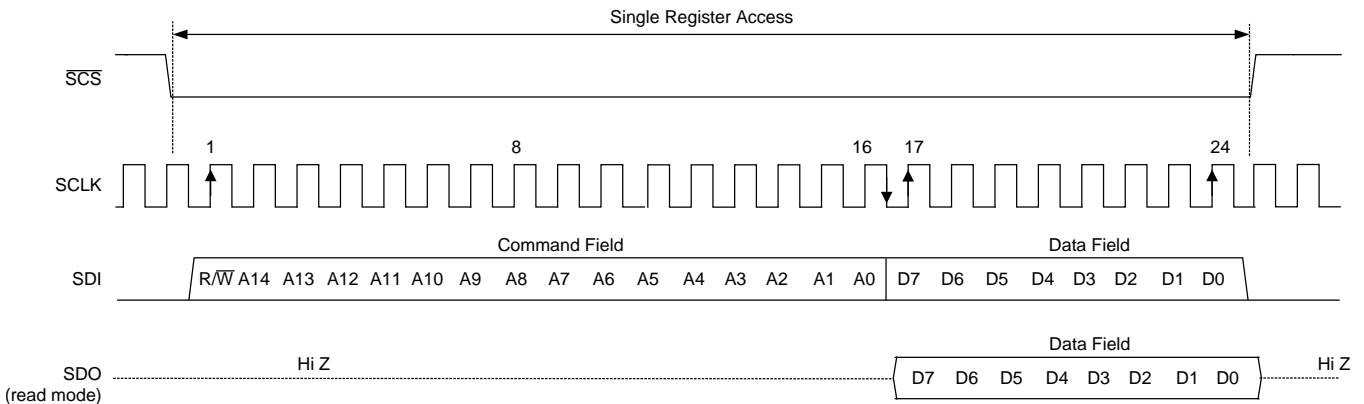
### 7.5.1 Using the Serial Interface

The serial interface is accessed using the following four pins: serial clock (SCLK), serial-data in (SDI), serial-data out (SDO), and serial-interface chip-select ( $\overline{\text{SCS}}$ ). Registers access is enabled through the  $\overline{\text{SCS}}$  pin.

- $\overline{\text{SCS}}$**  This signal must be asserted low to access a register through the serial interface. Setup and hold times with respect to the SCLK must be observed.
- SCLK** Serial data input is accepted at the rising edge of this signal. SCLK has no minimum frequency requirement.
- SDI** Each register access requires a specific 24-bit pattern at this input. This pattern consists of a read-and-write (R/W) bit, register address, and register value. The data is shifted in MSB first. Setup and hold times with respect to the SCLK must be observed (see [Figure 2](#)).
- SDO** The SDO signal provides the output data requested by a read command. This output is high impedance during write bus cycles and during the read bit and register address portion of read bus cycles.

Each register access consists of 24 bits, as shown in [Figure 2](#). The first bit is high for a read and low for a write.

The next 15 bits are the address of the register that is to be written to. During write operations, the last 8 bits are the data written to the addressed register. During read operations, the last 8 bits on SDI are ignored, and, during this time, the SDO outputs the data from the addressed register. The serial protocol details are illustrated in [Figure 67](#).

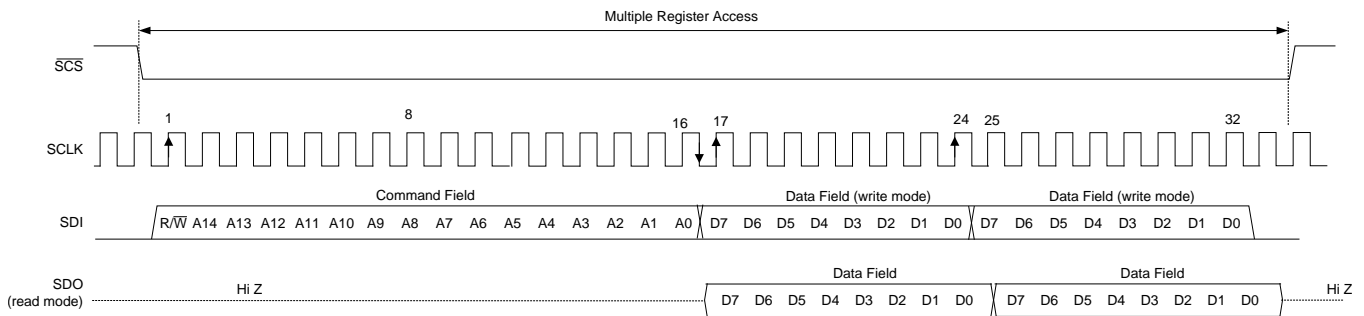


**Figure 67. Serial Interface Protocol - Single Read / Write**

## Programming (continued)

### 7.5.1.1 Streaming Mode

The serial interface supports streaming reads and writes. In this mode, the initial 24 bits of the transaction specifies the access type, register address, and data value as normal. Additional clock cycles of write or read data are immediately transferred, as long as the SCS input is maintained in the asserted (logic low) state. The register address auto increments (default) or decrements for each subsequent 8 bit transfer of the streaming transaction. The ADDR\_ASC bit (register 000h, bits 5 and 2) controls whether the address value ascends (increments) or descends (decrements). Streaming mode can be disabled by setting the ADDR\_STATIC bit (register 010h, bit 0). The streaming mode transaction details are shown in [Figure 68](#).



**Figure 68. Serial Interface Protocol - Streaming Read / Write**

See the [Register Map](#) section for detailed information regarding the registers.

#### NOTE

The serial interface must not be accessed during calibration of the ADC. Accessing the serial interface during this time impairs the performance of the device until the device is calibrated correctly. Writing or reading the serial registers also reduces dynamic performance of the ADC for the duration of the register access time.

## 7.6 Register Map

Several groups of registers provide control and configuration options for this device. Each following register description also shows the power-on reset (POR) state of each control bit.

### NOTE

All multi-byte registers are arranged in little-endian format (the least-significant byte is stored at the lowest address) unless explicitly stated otherwise.

### Memory Map

| Address  | Reset     | Type | Register                           |
|--|-----------|------|------------------------------------|
| <b>Standard SPI-3.0 (0x000 to 0x00F)</b>                                   |           |      |                                    |
| 0x000  | 0x3C      | R/W  | Configuration A Register           |
| 0x001  | 0x00      | R    | Configuration B Register           |
| 0x002  | 0x00      | R/W  | Device Configuration Register      |
| 0x003  | 0x03      | R    | Chip Type Register                 |
| 0x004-0x005  | Undefined | R    | RESERVED                           |
| 0x006  | 0x03      | R    | Chip Version Register              |
| 0x007-0x00B  | Undefined | R    | RESERVED                           |
| 0x00C-0x00D  | 0x0451    | R    | Vendor Identification Register     |
| 0x00E-0x00F  | Undefined | R    | RESERVED                           |
| <b>User SPI Configuration (0x010 to 0x01F)</b>                             |           |      |                                    |
| 0x010  | 0x00      | R/W  | User SPI Configuration Register    |
| 0x011-0x01F  | Undefined | R    | RESERVED                           |
| <b>General Analog, Bias, Band Gap, and Track and Hold (0x020 to 0x02F)</b> |           |      |                                    |
| 0x020  | 0x9D      | R/W  | RESERVED                           |
| 0x021  | 0x00      | R/W  | Power-On Reset Register            |
| 0x022  | 0x40      | R/W  | I/O Gain 0 Register                |
| 0x023  | 0x00      | R/W  | I/O Gain 1 Register                |
| 0x024  | 0x00      | R/W  | RESERVED                           |
| 0x025  | 0x40      | R/W  | I/O Offset 0 Register              |
| 0x026  | 0x00      | R/W  | I/O Offset 1 Register              |
| 0x027  | 0x06      | R/W  | RESERVED                           |
| 0x028  | 0xBA      | R/W  | RESERVED                           |
| 0x029  | 0xD4      | R/W  | RESERVED                           |
| 0x02A  | 0xEA      | R/W  | RESERVED                           |
| 0x02B-0x02F  | Undefined | R    | RESERVED                           |
| <b>Clock (0x030 to 0x03F)</b>  |           |      |                                    |
| 0x030  | 0xC0      | R/W  | Clock Generator Control 0 Register |
| 0x031  | 0x07      | R    | Clock Generator Status Register    |
| 0x032  | 0x80      | R/W  | Clock Generator Control 2 Register |
| 0x033  | 0xC3      | R/W  | Analog Miscellaneous Register      |
| 0x034  | 0x2F      | R/W  | Input Clamp Enable Register        |
| 0x035  | 0xDF      | R/W  | RESERVED                           |
| 0x036  | 0x00      | R/W  | RESERVED                           |
| 0x037  | 0x45      | R/W  | RESERVED                           |
| 0x038-0x03F  | Undefined | R/W  | RESERVED                           |
| <b>Serializer (0x040 to 0x04F)</b>   |           |      |                                    |
| 0x040  | 0x04      | R/W  | Serializer Configuration Register  |
| 0x041-0x04F  | Undefined | R    | RESERVED                           |

**Register Map (continued)**
**Memory Map (continued)**

| Address  | Reset      | Type | Register                                   |
|--|------------|------|--|
| <b>ADC Calibration (0x050 to 0x1FF)</b>                  |            |      |  |
| 0x050  | 0x06       | R/W  | Calibration Configuration 0 Register       |
| 0x051  | 0xF4       | R/W  | Calibration Configuration 1 Register       |
| 0x052  | 0x00       | R/W  | RESERVED                                   |
| 0x053  | 0x5C       | R/W  | RESERVED                                   |
| 0x054  | 0x1C       | R/W  | RESERVED                                   |
| 0x055  | 0x92       | R/W  | RESERVED                                   |
| 0x056  | 0x20       | R/W  | RESERVED                                   |
| 0x057  | 0x10       | R/W  | Calibration Background Control Register    |
| 0x058  | 0x00       | R/W  | ADC Pattern and Over-Range Enable Register |
| 0x059  | 0x00       | R/W  | RESERVED                                   |
| 0x05A  | 0x00       | R/W  | Calibration Vectors Register               |
| 0x05B  | Undefined  | R    | Calibration Status Register                |
| 0x05C  | 0x00       | R/W  | RESERVED                                   |
| 0x05D-0x05E  | Undefined  | R/W  | RESERVED                                   |
| 0x05F  | 0x00       | R/W  | RESERVED                                   |
| 0x060  | Undefined  | R    | RESERVED                                   |
| 0x061  | Undefined  | R    | RESERVED                                   |
| 0x062  | Undefined  | R    | RESERVED                                   |
| 0x063  | Undefined  | R    | RESERVED                                   |
| 0x064  | Undefined  | R    | RESERVED                                   |
| 0x065  | Undefined  | R    | RESERVED                                   |
| 0x066  | 0x02       | R/W  | Timing Calibration Register                |
| 0x067  | 0x01       | R/W  | RESERVED                                   |
| 0x068  | Undefined  | R    | RESERVED                                   |
| 0x069  | Undefined  | R    | RESERVED                                   |
| 0x06A  | 0x00       | R/W  | RESERVED                                   |
| 0x06B  | 0x20       | R/W  | RESERVED                                   |
| 0x06C-0x1FF  | Undefined  | R    | RESERVED                                   |
| <b>Digital Down Converter and JESD204B (0x200-0x27F)</b> |            |      |  |
| 0x200  | 0x10       | R/W  | Digital Down-Converter (DDC) Control       |
| 0x201  | 0x0F       | R/W  | JESD204B Control 1                         |
| 0x202  | 0x00       | R/W  | JESD204B Control 2                         |
| 0x203  | 0x00       | R/W  | JESD204B Device ID (DID)                   |
| 0x204  | 0x00       | R/W  | JESD204B Control 3                         |
| 0x205  | Undefined  | R/W  | JESD204B and System Status Register        |
| 0x206  | 0xF2       | R/W  | Overrange Threshold 0                      |
| 0x207  | 0xAB       | R/W  | Overrange Threshold 1                      |
| 0x208  | 0x00       | R/W  | Overrange Period                           |
| 0x209-0x20B  | 0x00       | R/W  | RESERVED                                   |
| 0x20C  | 0x00       | R/W  | DDC Configuration Preset Mode              |
| 0x20D  | 0x00       | R/W  | DDC Configuration Preset Select            |
| 0x20E-0x20F  | 0x0000     | R/W  | Rational NCO Reference Divisor             |
| <b>PRESET 0</b>  |            |      |  |
| 0x210-0x213  | 0xC0000000 | R/W  | NCO Frequency (Preset 0)                   |
| 0x214-0x215  | 0x0000     | R/W  | NCO Phase (Preset 0)                       |

**Register Map (continued)**
**Memory Map (continued)**

| Address         | Reset      | Type | Register                 |
|-----------------|------------|------|--------------------------|
| 0x216           | 0xFF       | R/W  | DDC Delay (Preset 0)     |
| 0x217           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 1</b> |            |      |                          |
| 0x218-0x21B     | 0xC0000000 | R/W  | NCO Frequency (Preset 1) |
| 0x21C-0x21D     | 0x0000     | R/W  | NCO Phase (Preset 1)     |
| 0x21E           | 0xFF       | R/W  | DDC Delay (Preset 1)     |
| 0x21F           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 2</b> |            |      |                          |
| 0x220-0x223     | 0xC0000000 | R/W  | NCO Frequency (Preset 2) |
| 0x224-0x225     | 0x0000     | R/W  | NCO Phase (Preset 2)     |
| 0x226           | 0xFF       | R/W  | DDC Delay (Preset 2)     |
| 0x227           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 3</b> |            |      |                          |
| 0x228-0x22B     | 0xC0000000 | R/W  | NCO Frequency (Preset 3) |
| 0x22C-0x22D     | 0x0000     | R/W  | NCO Phase (Preset 3)     |
| 0x22E           | 0xFF       | R/W  | DDC Delay (Preset 3)     |
| 0x22F           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 4</b> |            |      |                          |
| 0x230-0x233     | 0xC0000000 | R/W  | NCO Frequency (Preset 4) |
| 0x234-0x235     | 0x0000     | R/W  | NCO Phase (Preset 4)     |
| 0x236           | 0xFF       | R/W  | DDC Delay (Preset 4)     |
| 0x237           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 5</b> |            |      |                          |
| 0x238-0x23B     | 0xC0000000 | R/W  | NCO Frequency (Preset 5) |
| 0x23C-0x23D     | 0x0000     | R/W  | NCO Phase (Preset 5)     |
| 0x23E           | 0xFF       | R/W  | DDC Delay (Preset 5)     |
| 0x23F           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 6</b> |            |      |                          |
| 0x240-0x243     | 0xC0000000 | R/W  | NCO Frequency (Preset 6) |
| 0x244-0x245     | 0x0000     | R/W  | NCO Phase (Preset 6)     |
| 0x246           | 0xFF       | R/W  | DDC Delay (Preset 6)     |
| 0x247           | 0x00       | R/W  | RESERVED                 |
| <b>PRESET 7</b> |            |      |                          |
| 0x248-0x24B     | 0xC0000000 | R/W  | NCO Frequency (Preset 7) |
| 0x24C-0x24D     | 0x0000     | R/W  | NCO Phase (Preset 7)     |
| 0x24E           | 0xFF       | R/W  | DDC Delay (Preset 7)     |
| 0x24F-0x251     | 0x00       | R/W  | RESERVED                 |
| 0x252-0x27F     | Undefined  | R    | RESERVED                 |
| <b>Reserved</b> |            |      |                          |
| 0x0280-0x7FFF   | Undefined  | R    | RESERVED                 |

## 7.6.1 Register Descriptions

### 7.6.1.1 Standard SPI-3.0 (0x000 to 0x00F)

**Table 40. Standard SPI-3.0 Registers**

| Address     | Reset     | Acronym      | Register Name                  | Section            |
|-------------|-----------|--------------|--------------------------------|--------------------|
| 0x000       | 0x3C      | CFGA         | Configuration A Register       | <a href="#">Go</a> |
| 0x001       | 0x00      | CFGB         | Configuration B Register       | <a href="#">Go</a> |
| 0x002       | 0x00      | DEVCFG       | Device Configuration Register  | <a href="#">Go</a> |
| 0x003       | 0x03      | CHIP_TYPE    | Chip Type Register             | <a href="#">Go</a> |
| 0x004-0x005 | 0x0000    | RESERVED     | RESERVED                       | <a href="#">Go</a> |
| 0x006       | 0x03      | CHIP_VERSION | Chip Version Register          | <a href="#">Go</a> |
| 0x007-0x00B | Undefined | RESERVED     | RESERVED                       |                    |
| 0x00C-0x00D | 0x0451    | VENDOR_ID    | Vendor Identification Register | <a href="#">Go</a> |
| 0x00E-0x00F | Undefined | RESERVED     | RESERVED                       |                    |

#### 7.6.1.1.1 Configuration A Register (address = 0x000) [reset = 0x3C]

All writes to this register must be a palindrome (for example: bits [3:0] are a mirror image of bits [7:4]). If the data is not a palindrome, the entire write is ignored.

**Figure 69. Configuration A Register (CFGA)**

| 7     | 6        | 5        | 4        | 3        | 2        | 1        | 0     |
|-------|----------|----------|----------|----------|----------|----------|-------|
| SWRST | RESERVED | ADDR_ASC | RESERVED | RESERVED | ADDR_ASC | RESERVED | SWRST |
| R/W-0 | R/W-0    | R/W-1    | R/W-1    | R/W-1    | R/W-1    | R/W-0    | R/W-0 |

**Table 41. CFGA Field Descriptions**

| Bit | Field    | Type | Reset | Description  |
|-----|----------|------|-------|--|
| 7   | SWRST    | R/W  | 0     | Setting this bit causes all registers to be reset to their default state. This bit is self-clearing.   |
| 6   | RESERVED | R/W  | 0     |  |
| 5   | ADDR_ASC | R/W  | 1     | This bit is NOT reset by a soft reset (SWRST)<br>0 : descend – decrement address while streaming (address wraps from 0x0000 to 0x7FFF)<br>1 : ascend – increment address while streaming (address wraps from 0x7FFF to 0x0000) (default) |
| 4   | RESERVED | R/W  | 1     | Always returns 1   |
| 3   | RESERVED | R/W  | 1100  | Palindrome bits<br>bit 3 = bit 4, bit 2 = bit 5, bit 1 = bit 6, bit 0 = bit 7  |
| 2   | ADDR_ASC | R/W  |       |  |
| 1   | RESERVED | R/W  |       |  |
| 0   | SWRST    | R/W  |       |  |

#### 7.6.1.1.2 Configuration B Register (address = 0x001) [reset = 0x00]

**Figure 70. Configuration B Register (CFGB)**

| 7         | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------|---|---|---|---|---|---|---|
| RESERVED  |   |   |   |   |   |   |   |
| R - 0x00h |   |   |   |   |   |   |   |

**Table 42. CFGB Field Descriptions**

| Bit | Field    | Type | Reset     | Description |
|-----|----------|------|-----------|-------------|
| 7:0 | RESERVED | R    | 0000 0000 |             |

**7.6.1.1.3 Device Configuration Register (address = 0x002) [reset = 0x00]**
**Figure 71. Device Configuration Register (DEVCFG)**

|            |   |   |   |   |   |        |   |
|------------|---|---|---|---|---|--------|---|
| 7          | 6 | 5 | 4 | 3 | 2 | 1      | 0 |
| RESERVED   |   |   |   |   |   | MODE   |   |
| R/W-000000 |   |   |   |   |   | R/W-00 |   |

**Table 43. DEVCFG Field Descriptions**

| Bit | Field    | Type | Reset   | Description  |
|-----|----------|------|---------|--|
| 7-2 | RESERVED | R/W  | 0000 00 |  |
| 1-0 | MODE     | R/W  | 00      | SPI 3.0 specification has 1 as low power functional mode and 2 as low power fast resume. This chip does not support these modes.<br>0: Normal Operation – full power and full performance (default)<br>1: Normal Operation – full power and full performance (default)<br>2: Power Down – Everything powered down<br>3: Power Down – Everything powered down |

**7.6.1.1.4 Chip Type Register (address = 0x003) [reset = 0x03]**
**Figure 72. Chip Type Register (CHIP\_TYPE)**

|          |   |   |   |           |   |   |   |
|----------|---|---|---|-----------|---|---|---|
| 7        | 6 | 5 | 4 | 3         | 2 | 1 | 0 |
| RESERVED |   |   |   | CHIP_TYPE |   |   |   |
| R-0000   |   |   |   | R-0011    |   |   |   |

**Table 44. CHIP\_TYPE Field Descriptions**

| Bit | Field     | Type | Reset | Description   |
|-----|-----------|------|-------|---|
| 7-4 | RESERVED  | R    | 0000  |   |
| 3-0 | CHIP_TYPE | R    | 0011  | Always returns 0x3, indicating that the part is a high speed ADC. |

**7.6.1.1.5 Chip Version Register (address = 0x006) [reset = 0x03]**
**Figure 73. Chip Version Register (CHIP\_VERSION)**

|              |   |   |   |   |   |   |   |
|--------------|---|---|---|---|---|---|---|
| 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CHIP_VERSION |   |   |   |   |   |   |   |
| R-0000 0011  |   |   |   |   |   |   |   |

**Table 45. CHIP\_VERSION Field Descriptions**

| Bit | Field        | Type | Reset     | Description                |
|-----|--------------|------|-----------|----------------------------|
| 7-0 | CHIP_VERSION | R    | 0000 0011 | Chip version, returns 0x03 |

**7.6.1.1.6 Vendor Identification Register (address = 0x00C to 0x00D) [reset = 0x0451]**
**Figure 74. Vendor Identification Register (VENDOR\_ID)**

|           |    |    |    |    |    |   |   |
|-----------|----|----|----|----|----|---|---|
| 15        | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| VENDOR_ID |    |    |    |    |    |   |   |
| R-0x04h   |    |    |    |    |    |   |   |
| 7         | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| VENDOR_ID |    |    |    |    |    |   |   |
| R-0x51h   |    |    |    |    |    |   |   |

**Table 46. VENDOR\_ID Field Descriptions**

| Bit  | Field     | Type | Reset   | Description                          |
|------|-----------|------|---------|--------------------------------------|
| 15-0 | VENDOR_ID | R    | 0x0451h | Always returns 0x0451 (TI Vendor ID) |

**7.6.1.2 User SPI Configuration (0x010 to 0x01F)**
**Table 47. User SPI Configuration Registers**

| Address     | Reset     | Acronym  | Register Name                   | Section            |
|-------------|-----------|----------|---------------------------------|--------------------|
| 0x010       | 0x00      | USR0     | User SPI Configuration Register | <a href="#">Go</a> |
| 0x011-0x01F | Undefined | RESERVED | RESERVED                        |                    |

**7.6.1.2.1 User SPI Configuration Register (address = 0x010) [reset = 0x00]**
**Figure 75. User SPI Configuration Register (USR0)**

|              |   |   |   |   |   |   |             |
|--------------|---|---|---|---|---|---|-------------|
| 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0           |
| RESERVED     |   |   |   |   |   |   | ADDR_STATIC |
| R/W-0000 000 |   |   |   |   |   |   | R/W-0       |

**Table 48. USR0 Field Descriptions**

| Bit | Field       | Type | Reset    | Description  |
|-----|-------------|------|----------|--|
| 7-1 | RESERVED    | R/W  | 0000 000 |  |
| 0   | ADDR_STATIC | R/W  | 0        | 0 : Use ADDR_ASC bit to define what happens to address during streaming (default).<br>1 : Address stays static throughout streaming operation. Useful for reading/writing calibration vector information at CAL_VECTOR register. |

### 7.6.1.3 General Analog, Bias, Band Gap, and Track and Hold (0x020 to 0x02F)

**Table 49. General Analog, Bias, Band Gap, and Track and Hold Registers**

| Address     | Reset     | Acronym     | Register Name           | Section            |
|-------------|-----------|-------------|-------------------------|--------------------|
| 0x020       | 0x9D      | RESERVED    | RESERVED                |                    |
| 0x021       | 0x00      | POR         | Power-On Reset Register | <a href="#">Go</a> |
| 0x022       | 0x40      | IO_GAIN_0   | I/O Gain 0 Register     | <a href="#">Go</a> |
| 0x023       | 0x00      | IO_GAIN_1   | I/O Gain 1 Register     | <a href="#">Go</a> |
| 0x024       | 0x00      | RESERVED    | RESERVED                |                    |
| 0x025       | 0x40      | IO_OFFSET_0 | I/O Offset 0 Register   | <a href="#">Go</a> |
| 0x026       | 0x00      | IO_OFFSET_1 | I/O Offset 1 Register   | <a href="#">Go</a> |
| 0x027       | 0x06      | RESERVED    | RESERVED                |                    |
| 0x028       | 0xBA      | RESERVED    | RESERVED                |                    |
| 0x029       | 0xD4      | RESERVED    | RESERVED                |                    |
| 0x02A       | 0xAA      | RESERVED    | RESERVED                |                    |
| 0x02B-0x02F | Undefined | RESERVED    | RESERVED                |                    |

#### 7.6.1.3.1 Power-On Reset Register (address = 0x021) [reset = 0x00]

**Figure 76. Power-On Reset Register (POR)**

| 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0       |
|--------------|---|---|---|---|---|---|---------|
| RESERVED     |   |   |   |   |   |   | SPI_RES |
| R/W-0000 000 |   |   |   |   |   |   | R/W-0   |

**Table 50. POR Field Descriptions**

| Bit | Field    | Type | Reset    | Description  |
|-----|----------|------|----------|--|
| 7-1 | RESERVED | R/W  | 0000 000 |  |
| 0   | SPI_RES  | R/W  | 0        | Reset all digital. Emulates a power on reset (not self-clearing). Write a 0 and then write a 1 to emulate a reset. Transition from 0→1 initiates reset. Default: 0 |

#### 7.6.1.3.2 I/O Gain 0 Register (address = 0x022) [reset = 0x40]

**Figure 77. I/O Gain 0 Register (IO\_GAIN\_0)**

| 7        | 6           | 5           | 4           | 3           | 2           | 1          | 0          |
|----------|-------------|-------------|-------------|-------------|-------------|------------|------------|
| RESERVED | GAIN_FS[14] | GAIN_FS[13] | GAIN_FS[12] | GAIN_FS[11] | GAIN_FS[10] | GAIN_FS[9] | GAIN_FS[8] |
| R/W-0    | R/W-1       | R/W-0       | R/W-0       | R/W-0       | R/W-0       | R/W-0      | R/W-0      |

**Table 51. IO\_GAIN\_0 Field Descriptions**

| Bit | Field         | Type | Reset    | Description   |
|-----|---------------|------|----------|---|
| 7   | RESERVED      | R/W  | 0        |   |
| 6-0 | GAIN_FS[14:8] | R/W  | 100 0000 | MSB Bits for GAIN_FS[14:0]. (See the IO_GAIN_1 description in <a href="#">General Analog, Bias, Band Gap, and Track and Hold (0x020 to 0x02F)</a> ) |

**7.6.1.3.3 IO\_GAIN\_1 Register (address = 0x023) [reset = 0x00]**
**Figure 78. IO\_GAIN\_1 Register (IO\_GAIN\_1)**

| 7          | 6          | 5          | 4          | 3          | 2          | 1          | 0          |
|------------|------------|------------|------------|------------|------------|------------|------------|
| GAIN_FS[7] | GAIN_FS[6] | GAIN_FS[5] | GAIN_FS[4] | GAIN_FS[3] | GAIN_FS[2] | GAIN_FS[1] | GAIN_FS[0] |
| R/W-0      | R/W-0      | R/W-0      | R/W-0      | R/W-0      | R/W-0      | R/W-0      | R/W-0      |

**Table 52. IO\_GAIN\_1 Field Descriptions**

| Bit | Field        | Type | Reset     | Description   |
|-----|--------------|------|-----------|---|
| 7-0 | GAIN_FS[7:0] | R/W  | 0000 0000 | LSB bits for GAIN_FS[14:0]<br>GAIN_FS[14:0] Value<br>0x0000 500 mVp-p<br>0x4000 725 mVp-p (default)<br>0x7FFF 950 mVp-p |

**7.6.1.3.4 I/O Offset 0 Register (address = 0x025) [reset = 0x40]**
**Figure 79. I/O Offset 0 Register (IO\_OFFSET\_0)**

| 7        | 6                 | 5                 | 4                 | 3                 | 2                 | 1            | 0            |
|----------|-------------------|-------------------|-------------------|-------------------|-------------------|--------------|--------------|
| RESERVED | OFFSET_FS[1<br>4] | OFFSET_FS[1<br>3] | OFFSET_FS[1<br>2] | OFFSET_FS[1<br>1] | OFFSET_FS[1<br>0] | OFFSET_FS[9] | OFFSET_FS[8] |
| R/W-0    | R/W-1             | R/W-0             | R/W-0             | R/W-0             | R/W-0             | R/W-0        | R/W-0        |

**Table 53. IO\_OFFSET\_0 Field Descriptions**

| Bit | Field           | Type | Reset    | Description   |
|-----|-----------------|------|----------|---|
| 7   | RESERVED        | R/W  | 0        |   |
| 6-0 | OFFSET_FS[14:8] | R/W  | 100 0000 | MSB Bits for OFFSET_FS[14:0].<br>The ADC offset adjust feature has no effect when Background Calibration Mode is enabled. (See IO_OFFSET_1 description in the <a href="#">General Analog, Bias, Band Gap, and Track and Hold (0x020 to 0x02F)</a> section). |

**7.6.1.3.5 I/O Offset 1 Register (address = 0x026) [reset = 0x00]**
**Figure 80. I/O Offset 1 Register (IO\_OFFSET\_1)**

| 7            | 6            | 5            | 4            | 3            | 2            | 1            | 0            |
|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|
| OFFSET_FS[7] | OFFSET_FS[6] | OFFSET_FS[5] | OFFSET_FS[4] | OFFSET_FS[3] | OFFSET_FS[2] | OFFSET_FS[1] | OFFSET_FS[0] |
| R/W-0        | R/W-0        | R/W-0        | R/W-0        | R/W-0        | R/W-0        | R/W-0        | R/W-0        |

**Table 54. IO\_OFFSET\_1 Field Descriptions**

| Bit | Field          | Type | Reset     | Description  |
|-----|----------------|------|-----------|--|
| 7-0 | OFFSET_FS[7:0] | R/W  | 0000 0000 | LSB bits for OFFSET_FS[14:0]. OFFSET_FS[14:0] adjusts the offset of the entire ADC (all banks are impacted).<br>OFFSET_FS[14:0] Value<br>0x0000 –28-mV offset<br>0x4000 no offset (default)<br>0x7FFF 28-mV offset<br>The ADC offset adjust feature has no effect when Background Calibration Mode is enabled. |

### 7.6.1.4 Clock (0x030 to 0x03F)

**Table 55. Clock Registers**

| Address     | Reset     | Acronym  | Register Name                      | Section            |
|-------------|-----------|----------|------------------------------------|--------------------|
| 0x030       | 0xC0      | CLKGEN_0 | Clock Generator Control 0 Register | <a href="#">Go</a> |
| 0x031       | 0x07      | CLKGEN_1 | Clock Generator Status Register    | <a href="#">Go</a> |
| 0x032       | 0x80      | CLKGEN_2 | Clock Generator Control 2 Register | <a href="#">Go</a> |
| 0x033       | 0xC3      | ANA_MISC | Analog Miscellaneous Register      | <a href="#">Go</a> |
| 0x034       | 0x2F      | IN_CL_EN | Clamp Enable Register              | <a href="#">Go</a> |
| 0x035       | 0xDF      | RESERVED | RESERVED                           |                    |
| 0x036       | 0x00      | RESERVED | RESERVED                           |                    |
| 0x037       | 0x45      | RESERVED | RESERVED                           |                    |
| 0x038-0x03F | Undefined | RESERVED | RESERVED                           |                    |

#### 7.6.1.4.1 Clock Generator Control 0 Register (address = 0x030) [reset = 0xC0]

**Figure 81. Clock Generator Control 0 Register (CLKGEN\_0)**

| 7              | 6            | 5            | 4                   | 3        | 2                | 1                   | 0               |
|----------------|--------------|--------------|---------------------|----------|------------------|---------------------|-----------------|
| SysRef_Rcvr_En | SysRef_Pr_En | SysRefDetClr | Clear Dirty Capture | RESERVED | DC_LVPECL_CLK_en | DC_LVPECL_SYSREF_en | DC_LVPECL_TS_en |
| R/W-1          | R/W-1        | R/W-0        | R/W-0               | R/W-0    | R/W-0            | R/W-0               | R/W-0           |

**Table 56. CLKGEN\_0 Field Descriptions**

| Bit | Field               | Type | Reset | Description   |
|-----|---------------------|------|-------|---|
| 7   | SysRef_Rcvr_En      | R/W  | 1     | Default: 1<br>0 : SYSREF receiver is disabled.<br>1 : SYSREF receiver is enabled (default)  |
| 6   | SysRef_Pr_En        | R/W  | 1     | To power down the SYSREF receiver, clear this bit first, then clear SysRef_Rcvr_En. To power up the SYSREF receiver, set SysRef_Rcvr_En first, then set this bit.<br>Default: 1<br>0 : SYSREF Processor is disabled.<br>1 : SYSREF Processor is enabled (default) |
| 5   | SysRefDetClr        | R/W  | 0     | Default: 0<br>Write a 1 and then a 0 to clear the SysRefDet status bit.   |
| 4   | Clear Dirty Capture | R/W  | 0     | Default: 0<br>Write a 1 and then a 0 to clear the DC status bit.  |
| 3   | RESERVED            | R/W  | 0     | Default: 0  |
| 2   | DC_LVPECL_CLK_en    | R/W  | 0     | Default: 0<br>Set this bit if DEVCLK is a DC-coupled LVPECL signal through a 50-Ω resistor.   |
| 1   | DC_LVPECL_SYSREF_en | R/W  | 0     | Default: 0<br>Set this bit if SYSREF is a DC-coupled LVPECL signal through a 50-Ω resistor.   |
| 0   | DC_LVPECL_TS_en     | R/W  | 0     | Default: 0<br>Set this bit if TimeStamp is a DC-coupled LVPECL signal through a 50-Ω resistor.  |

**7.6.1.4.2 Clock Generator Status Register (address = 0x031) [reset = 0x07]**
**Figure 82. Clock Generator Status Register (CLKGEN\_1)**

|           |               |           |   |   |   |   |   |
|-----------|---------------|-----------|---|---|---|---|---|
| 7         | 6             | 5         | 4 | 3 | 2 | 1 | 0 |
| SysRefDet | Dirty Capture | RESERVED  |   |   |   |   |   |
| R-0       | R-0           | R-00 0111 |   |   |   |   |   |

**Table 57. CLKGEN\_1 Field Descriptions**

| Bit | Field         | Type | Reset   | Description   |
|-----|---------------|------|---------|---|
| 7   | SysRefDet     | R    | 0       | When high, indicates that a SYSREF rising edge was detected. To clear this bit, write SysRefDetClr to 1 and then back to 0.   |
| 6   | Dirty Capture | R    | 0       | When high, indicates that a SYSREF rising edge occurred very close to the device clock edge, and setup or hold is not ensured (dirty capture). To clear this bit, write CDC to 1 and then back to 0.<br><b>NOTE:</b> When sweeping the timing on SYSREF, it may jump across the clock edge without triggering this bit. The REALIGNED status bit must be used to detect this (see the JESD_STATUS register description in <a href="#">Digital Down Converter and JESD204B (0x200-0x27F)</a> ) |
| 5-0 | RESERVED      | R    | 00 0111 | Reserved register. Always returns 000111b   |

**7.6.1.4.3 Clock Generator Control 2 Register (address = 0x032) [reset = 0x80]**
**Figure 83. Clock Generator Control 2 Register (CLKGEN\_2)**

|          |   |   |   |          |   |   |   |
|----------|---|---|---|----------|---|---|---|
| 7        | 6 | 5 | 4 | 3        | 2 | 1 | 0 |
| RESERVED |   |   |   | RDEL     |   |   |   |
| R/W-1000 |   |   |   | R/W-0000 |   |   |   |

**Table 58. CLKGEN\_2 Field Descriptions**

| Bit | Field    | Type | Reset | Description   |
|-----|----------|------|-------|---|
| 7-4 | RESERVED | R/W  | 1000  | Default: 1000b  |
| 3-0 | RDEL     | R/W  | 0000  | Adjusts the delay of the SYSREF input signal with respect to DEVCLK. Each step delays SYSREF by 20 ps (nominal)<br>Default: 0<br>Range: 0 to 15 decimal |

**7.6.1.4.4 Analog Miscellaneous Register (address = 0x033) [reset = 0xC3]**
**Figure 84. Analog Miscellaneous Register (ANA\_MISC)**

| 7          | 6 | 5 | 4 | 3            | 2 | 1        | 0 |
|------------|---|---|---|--------------|---|----------|---|
| RESERVED   |   |   |   | SYNC_DIFF_PD |   | RESERVED |   |
| R/W-1100 0 |   |   |   | R/W-0        |   | R/W-11   |   |

**Table 59. ANA\_MISC Field Descriptions**

| Bit | Field        | Type | Reset  | Description   |
|-----|--------------|------|--------|---|
| 7-3 | RESERVED     | R/W  | 1100 0 |   |
| 2   | SYNC_DIFF_PD | R/W  | 0      | Set this bit to power down the differential SYNC~± inputs for the JESD204B interface. The SYNC~± inputs can also serve as the TimeStamp input receiver for the TimeStamp function. The receiver must be powered up to support the time stamp or differential SYNC~. Default: 0b |
| 1-0 | RESERVED     | R/W  | 11     | Default: 11b  |

**7.6.1.4.5 Input Clamp Enable Register (address = 0x034) [reset = 0x2F]**
**Figure 85. Input Clamp Enable Register (IN\_CL\_EN)**

| 7        | 6 | 5              | 4          | 3 | 2 | 1 | 0 |
|----------|---|----------------|------------|---|---|---|---|
| RESERVED |   | INPUT_CLAMP_EN | RESERVED   |   |   |   |   |
| R/W-00   |   | R/W-1          | R/W-0 1111 |   |   |   |   |

**Table 60. IN\_CL\_EN Field Descriptions**

| Bit | Field          | Type | Reset  | Description  |
|-----|----------------|------|--------|--|
| 7-6 | RESERVED       | R/W  | 00     | Default: 00b   |
| 5   | INPUT_CLAMP_EN | R/W  | 1      | Set this bit to enable the analog input active clamping circuit. Enabled by default. Default: 1b |
| 4-0 | RESERVED       | R/W  | 0 1111 | Default: 01111b  |

**7.6.1.5 Serializer (0x040 to 0x04F)**
**Table 61. Serializer Registers**

| Address     | Reset     | Acronym  | Register Name                     | Section            |
|-------------|-----------|----------|-----------------------------------|--------------------|
| 0x040       | 0x04      | SER_CFG  | Serializer Configuration Register | <a href="#">Go</a> |
| 0x041-0x04F | Undefined | RESERVED | RESERVED                          |                    |

**7.6.1.5.1 Serializer Configuration Register (address = 0x040) [reset = 0x04]**
**Figure 86. Serializer configuration Register (SER\_CFG)**

| 7        | 6 | 5 | 4 | 3                       | 2 | 1 | 0 |
|----------|---|---|---|-------------------------|---|---|---|
| RESERVED |   |   |   | SERIALIZER PRE-EMPHASIS |   |   |   |
| R/W-0000 |   |   |   | R/W-0100                |   |   |   |

**Table 62. SER\_CFG Field Descriptions**

| Bit | Field                   | Type | Reset | Description   |
|-----|-------------------------|------|-------|---|
| 7-4 | RESERVED                | R/W  | 0000  |   |
| 3-0 | SERIALIZER PRE-EMPHASIS | R/W  | 0100  | Control bits for the pre-emphasis strength of the serializer output driver. Pre-emphasis is required to compensate the low pass behavior of the PCB trace.<br>Default: 4d |

**7.6.1.6 ADC Calibration (0x050 to 0x1FF)**
**Table 63. ADC Calibration Registers**

| Address     | Reset     | Acronym        | Register Name                              | Section            |
|-------------|-----------|----------------|--|--------------------|
| 0x050       | 0x06      | CAL_CFG0       | Calibration Configuration 0 Register       | <a href="#">Go</a> |
| 0x051       | 0xF4      | CAL_CFG1       | Calibration Configuration 1 Register       | <a href="#">Go</a> |
| 0x052       | 0x00      | RESERVED       | RESERVED                                   |                    |
| 0x053       | 0x5C      | RESERVED       | RESERVED                                   |                    |
| 0x054       | 0x1C      | RESERVED       | RESERVED                                   |                    |
| 0x055       | 0x92      | RESERVED       | RESERVED                                   |                    |
| 0x056       | 0x20      | RESERVED       | RESERVED                                   |                    |
| 0x057       | 0x10      | CAL_BACK       | Calibration Background Control Register    | <a href="#">Go</a> |
| 0x058       | 0x00      | ADC_PAT_OVR_EN | ADC Pattern and Over-Range Enable Register | <a href="#">Go</a> |
| 0x059       | 0x00      | RESERVED       | RESERVED                                   |                    |
| 0x05A       | 0x00      | CAL_VECTOR     | Calibration Vectors Register               | <a href="#">Go</a> |
| 0x05B       | Undefined | CAL_STAT       | Calibration Status Register                | <a href="#">Go</a> |
| 0x05C       | 0x00      | RESERVED       | RESERVED                                   |                    |
| 0x05D-0x05E | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x05F       | 0x00      | RESERVED       | RESERVED                                   |                    |
| 0x060       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x061       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x062       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x063       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x064       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x065       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x066       | 0x02      | T_CAL          | Timing Calibration Register                | <a href="#">Go</a> |
| 0x067       | 0x01      | RESERVED       | RESERVED                                   |                    |
| 0x068       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x069       | Undefined | RESERVED       | RESERVED                                   |                    |
| 0x06A       | 0x00      | RESERVED       | RESERVED                                   |                    |
| 0x06B       | 0x20      | RESERVED       | RESERVED                                   |                    |
| 0x06C-0x1FF | Undefined | RESERVED       | RESERVED                                   |                    |

**7.6.1.6.1 Calibration Configuration 0 Register (address = 0x050) [reset = 0x06]**
**Figure 87. Calibration Configuration 0 Register (CAL\_CFG0)**

| 7        | 6 | 5             | 4                         | 3 | 2       | 1 | 0        |
|----------|---|---------------|---------------------------|---|---------|---|----------|
| RESERVED |   | TIME_STAMP_EN | CALIBRATION_READ_WRITE_EN |   | CAL_SFT |   | RESERVED |
| R/W-00   |   | R/W-0         | R/W-0                     |   | R/W-0   |   | R/W-110  |

**Table 64. CAL\_CFG0 Field Descriptions**

| Bit | Field                     | Type | Reset | Description  |
|-----|---------------------------|------|-------|--|
| 7-  | RESERVED                  | R/W  | 00    |  |
| 5   | TIME_STAMP_EN             | R/W  | 0     | Enables the capture of the external time stamp signal to allow tracking of input signal.<br>Default: 0   |
| 4   | CALIBRATION_READ_WRITE_EN | R/W  | 0     | Enables the scan register to read or write calibration vectors at register 0x05A.<br>Default: 0  |
| 3   | CAL_SFT <sup>(1)</sup>    | R/W  | 0     | Software calibration bit. Set bit to initiate foreground calibration. This bit is self-clearing. This bit resets the calibration state machine. Most calibration SPI registers are not synchronized to the calibration clock. Changing them may corrupt the calibration state machine. Always set CAL_SFT AFTER making any changes to the calibration registers. |
| 2-0 | RESERVED                  | R/W  | 110   | Default: 110   |

(1) IMPORTANT NOTE: Setting CAL\_SFT can glitch internal state machines. The JESD\_EN bit must be cleared and then set after setting CAL\_SFT.

**7.6.1.6.2 Calibration Configuration 1 Register (address = 0x051) [reset = 0xF4]**
**Figure 88. Calibration Configuration 1 Register (CAL\_CFG1)**

| 7        | 6 | 5          | 4 | 3 | 2 | 1 | 0        |
|----------|---|------------|---|---|---|---|----------|
| RESERVED |   | LOW_SIG_EN |   |   |   |   | RESERVED |
| R/W-1    |   | R/W-111    |   |   |   |   | R/W-0100 |

**Table 65. CAL\_CFG1 Field Descriptions**

| Bit | Field      | Type | Reset | Description  |
|-----|------------|------|-------|--|
| 7   | RESERVED   | R/W  | 1     |  |
| 6-4 | LOW_SIG_EN | R/W  | 111   | Controls signal range optimization for calibration processes.<br>111: Calibration is optimized for lower amplitude input signals (< -10dBFS).<br><b>000: Calibration is optimized for large (-1dBFS) input signals.</b><br>Default: 111 but recommend 000 for large input signals. |
| 3-0 | RESERVED   | R/W  | 0100  |  |

**7.6.1.6.3 Calibration Background Control Register (address = 0x057) [reset = 0x10]**
**Figure 89. Calibration Background Control Register (CAL\_BACK)**

| 7           | 6 | 5 | 4 | 3 | 2 | 1        | 0       |
|-------------|---|---|---|---|---|----------|---------|
| RESERVED    |   |   |   |   |   | CAL_CONT | CAL_BCK |
| R/W-0001 00 |   |   |   |   |   | R/W-0    | R/W-0   |

**Table 66. CAL\_BACK Field Descriptions**

| Bit | Field    | Type | Reset   | Description  |
|-----|----------|------|---------|--|
| 7-2 | RESERVED | R/W  | 0001 00 | Set to 0001 00b  |
| 1   | CAL_CONT | R/W  | 0       | CAL_CONT is the only calibration register bit that can be modified while background calibration is ongoing. This bit must be set to 0 before modifying any of the other bits.<br>0 : Pause or stop background calibration sequence.<br>1 : Start background calibration sequence.                                |
| 0   | CAL_BCK  | R/W  | 0       | Background calibration mode enabled. When pausing background calibration leave this bit set, only change CAL_CONT to 0.<br>If CAL_BCK is set to 0 after background calibration has been operation the calibration processes may stop in an incomplete condition. Set CAL_SFT to perform a foreground calibration |

**7.6.1.6.4 ADC Pattern and Over-Range Enable Register (address = 0x058) [reset = 0x00]**
**Figure 90. ADC Pattern and Over-Range Enable Register (ADC\_PAT\_OVR\_EN)**

| 7          | 6 | 5 | 4 | 3 | 2          | 1     | 0        |
|------------|---|---|---|---|------------|-------|----------|
| RESERVED   |   |   |   |   | ADC_PAT_EN | OR_EN | RESERVED |
| R/W-0000 0 |   |   |   |   | R/W-0      | R/W-0 | R/W-0    |

**Table 67. ADC\_PAT\_OVR\_EN Field Descriptions**

| Bit | Field      | Type | Reset  | Description              |
|-----|------------|------|--------|--------------------------|
| 7-3 | RESERVED   | R/W  | 0000 0 | Set to 00000b            |
| 2   | ADC_PAT_EN | R/W  | 0      | Enable ADC test pattern  |
| 1   | OR_EN      | R/W  | 0      | Enable over-range output |
| 0   | RESERVED   | R/W  | 0      | Set to 0                 |

**7.6.1.6.5 Calibration Vectors Register (address = 0x05A) [reset = 0x00]**
**Figure 91. Calibration Vectors Register (CAL\_VECTOR)**

| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|
| CAL_DATA      |   |   |   |   |   |   |   |
| R/W-0000 0000 |   |   |   |   |   |   |   |

**Table 68. CAL\_VECTOR Field Descriptions**

| Bit | Field    | Type | Reset     | Description   |
|-----|----------|------|-----------|---|
| 7-0 | CAL_DATA | R/W  | 0000 0000 | Repeated reads of this register outputs all the calibration register values for analysis if the CALIBRATION_READ_WRITE_EN bit is set.<br>Repeated writes of this register inputs all the calibration register values for configuration if the CAL_RD_EN bit is set. |

**7.6.1.6.6 Calibration Status Register (address = 0x05B) [reset = undefined]**
**Figure 92. Calibration Status Register (CAL\_STAT)**

| 7         | 6 | 5 | 4 | 3 | 2 | 1            | 0              |
|-----------|---|---|---|---|---|--------------|----------------|
| RESERVED  |   |   |   |   |   | CAL_CONT_OFF | FIRST_CAL_DONE |
| R-0000 10 |   |   |   |   |   | R-X          | R-X            |

**Table 69. CAL\_STAT Field Descriptions**

| Bit | Field          | Type | Reset        | Description  |
|-----|----------------|------|--------------|--|
| 7-2 | RESERVED       | R    | 0000<br>10XX |  |
| 1   | CAL_CONT_OFF   | R    | X            | After clearing CAL_CONT, calibration does not stop immediately. Use this register to confirm it has stopped before changing calibration settings.<br>0: Indicates calibration is running (foreground or background)<br>1: Indicates that calibration is finished or stopped because CAL_CONT = 0 |
| 0   | FIRST_CAL_DONE | R    | X            | Indicates first calibration sequence has been done and ADC is operational.   |

**7.6.1.6.7 Timing Calibration Register (address = 0x066) [reset = 0x02]**
**Figure 93. Timing Calibration Register (T\_CAL)**

| 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0      |
|--------------|---|---|---|---|---|---|--------|
| RESERVED     |   |   |   |   |   |   | T_AUTO |
| R/W-0000 001 |   |   |   |   |   |   | R/W-0  |

**Table 70. CAL\_STAT Field Descriptions**

| Bit | Field    | Type | Reset    | Description   |
|-----|----------|------|----------|---|
| 7-1 | RESERVED | R/W  | 0000 001 | Set to 0000001b   |
| 0   | T_AUTO   | R/W  | 0        | Set to enable automatic timing optimization. Timing calibration will occur once CAL_SFT is set. |

**7.6.1.7 Digital Down Converter and JESD204B (0x200-0x27F)**
**Table 71. Digital Down Converter and JESD204B Registers**

| Address     | Reset      | Acronym     | Register Name                        | Section            |
|-------------|------------|-------------|--------------------------------------|--------------------|
| 0x200       | 0x10       | DDC_CTRL1   | Digital Down-Converter (DDC) Control | <a href="#">Go</a> |
| 0x201       | 0x0F       | JESD_CTRL1  | JESD204B Control 1                   | <a href="#">Go</a> |
| 0x202       | 0x00       | JESD_CTRL2  | JESD204B Control 2                   | <a href="#">Go</a> |
| 0x203       | 0x00       | JESD_DID    | JESD204B Device ID (DID)             | <a href="#">Go</a> |
| 0x204       | 0x00       | JESD_CTRL3  | JESD204B Control 3                   | <a href="#">Go</a> |
| 0x205       | Undefined  | JESD_STATUS | JESD204B and System Status Register  | <a href="#">Go</a> |
| 0x206       | 0xF2       | OVR_T0      | Overrange Threshold 0                | <a href="#">Go</a> |
| 0x207       | 0xAB       | OVR_T1      | Overrange Threshold 1                | <a href="#">Go</a> |
| 0x208       | 0x00       | OVR_N       | Overrange Period                     | <a href="#">Go</a> |
| 0x209-0x20B | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x20C       | 0x00       | NCO_MODE    | DDC Configuration Preset Mode        | <a href="#">Go</a> |
| 0x20D       | 0x00       | NCO_SEL     | DDC Configuration Preset Select      | <a href="#">Go</a> |
| 0x20E-0x20F | 0x0000     | NCO_RDIV    | Rational NCO Reference Divisor       | <a href="#">Go</a> |
| 0x210-0x213 | 0xC0000000 | NCO_FREQ0   | NCO Frequency (Preset 0)             | <a href="#">Go</a> |
| 0x214-0x215 | 0x0000     | NCO_PHASE0  | NCO Phase (Preset 0)                 | <a href="#">Go</a> |
| 0x216       | 0xFF       | DDC_DLY0    | DDC Delay (Preset 0)                 | <a href="#">Go</a> |
| 0x217       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x218-0x21B | 0xC0000000 | NCO_FREQ1   | NCO Frequency (Preset 1)             | <a href="#">Go</a> |
| 0x21C-0x21D | 0x0000     | NCO_PHASE1  | NCO Phase (Preset 1)                 | <a href="#">Go</a> |
| 0x21E       | 0xFF       | DDC_DLY1    | DDC Delay (Preset 1)                 | <a href="#">Go</a> |
| 0x21F       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x220-0x223 | 0xC0000000 | NCO_FREQ2   | NCO Frequency (Preset 2)             | <a href="#">Go</a> |
| 0x224-0x225 | 0x0000     | NCO_PHASE2  | NCO Phase (Preset 2)                 | <a href="#">Go</a> |
| 0x226       | 0xFF       | DDC_DLY2    | DDC Delay (Preset 2)                 | <a href="#">Go</a> |
| 0x227       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x228-0x22B | 0xC0000000 | NCO_FREQ3   | NCO Frequency (Preset 3)             | <a href="#">Go</a> |
| 0x22C-0x22D | 0x0000     | NCO_PHASE3  | NCO Phase (Preset 3)                 | <a href="#">Go</a> |
| 0x22E       | 0xFF       | DDC_DLY3    | DDC Delay (Preset 3)                 | <a href="#">Go</a> |
| 0x22F       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x230-0x233 | 0xC0000000 | NCO_FREQ4   | NCO Frequency (Preset 4)             | <a href="#">Go</a> |
| 0x234-0x235 | 0x0000     | NCO_PHASE4  | NCO Phase (Preset 4)                 | <a href="#">Go</a> |
| 0x236       | 0xFF       | DDC_DLY4    | DDC Delay (Preset 4)                 | <a href="#">Go</a> |
| 0x237       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x238-0x23B | 0xC0000000 | NCO_FREQ5   | NCO Frequency (Preset 5)             | <a href="#">Go</a> |
| 0x23C-0x23D | 0x0000     | NCO_PHASE5  | NCO Phase (Preset 5)                 | <a href="#">Go</a> |
| 0x23E       | 0xFF       | DDC_DLY5    | DDC Delay (Preset 5)                 | <a href="#">Go</a> |
| 0x23F       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x240-0x243 | 0xC0000000 | NCO_FREQ6   | NCO Frequency (Preset 6)             | <a href="#">Go</a> |
| 0x244-0x245 | 0x0000     | NCO_PHASE6  | NCO Phase (Preset 6)                 | <a href="#">Go</a> |
| 0x246       | 0xFF       | DDC_DLY6    | DDC Delay (Preset 6)                 | <a href="#">Go</a> |
| 0x247       | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x248-0x24B | 0xC0000000 | NCO_FREQ7   | NCO Frequency (Preset 7)             | <a href="#">Go</a> |
| 0x24C-0x24D | 0x0000     | NCO_PHASE7  | NCO Phase (Preset 7)                 | <a href="#">Go</a> |
| 0x24E       | 0xFF       | DDC_DLY7    | DDC Delay (Preset 7)                 | <a href="#">Go</a> |
| 0x24F-0x251 | 0x00       | RESERVED    | RESERVED                             |                    |
| 0x252-0x27F | Undefined  | RESERVED    | RESERVED                             |                    |

**7.6.1.7.1 Digital Down-Converter (DDC) Control Register (address = 0x200) [reset = 0x10]**
**Figure 94. Digital Down-Converter (DDC) Control Register (DDC\_CTRL1)**

| 7        | 6 | 5       | 4              | 3        | 2 | 1 | 0 |
|----------|---|---------|----------------|----------|---|---|---|
| RESERVED |   | SFORMAT | DDC GAIN BOOST | DMODE    |   |   |   |
| R/W-00   |   | R/W-0   | R/W-1          | R/W-0000 |   |   |   |

**Table 72. DDC\_CTRL1 Field Descriptions**

| Bit | Field                | Type | Reset | Description   |
|-----|----------------------|------|-------|---|
| 7-6 | RESERVED             | R/W  | 00    |   |
| 5   | SFORMAT              | R/W  | 0     | Output sample format for bypass mode:<br>0 : Offset binary (default)<br>1 : Signed 2s complement <sup>(1)</sup>   |
| 4   | DDC GAIN BOOST       | R/W  | 1     | 0 : Final filter has 0-dB gain (recommended when NCO is set near DC).<br>1 : Final filter has 6.02-dB gain (default)  |
| 3-0 | DMODE <sup>(2)</sup> | R/W  | 0000  | 0 : Bypass mode (12-bit output, decimate-by-1, DDC off) (default)<br>1 : Reserved<br>2 : decimate-by-4<br>3 : decimate-by-8<br>4 : decimate-by-10<br>5 : decimate-by-16<br>6 : decimate-by-20<br>7 : decimate-by-32<br>8..15 : RESERVED |

(1) Decimated modes always output in signed 2s complement.

(2) The DMODE setting must only be changed when JESD\_EN is 0.

**7.6.1.7.2 JESD204B Control 1 Register (address = 0x201) [reset = 0x0F]**
**Figure 95. JESD204B Control 1 Register (JESD\_CTRL1)**

| 7     | 6          | 5 | 4 | 3 | 2     | 1       | 0 |
|-------|------------|---|---|---|-------|---------|---|
| SCR   | K_Minus_1  |   |   |   | DDR   | JESD_EN |   |
| R/W-0 | R/W-000 11 |   |   |   | R/W-1 | R/W-1   |   |

**Table 73. JESD\_CTRL1 Field Descriptions**

| Bit | Field                  | Type | Reset  | Description   |
|-----|------------------------|------|--------|---|
| 7   | SCR                    | R/W  | 0      | 0 : Scrambler disabled (default)<br>1 : Scrambler enabled   |
| 6-2 | K_Minus_1              | R/W  | 000 11 | K is the number of frames per multiframe, and K – 1 is programmed here.<br>Default: K = 4, K_Minus_1 = 3.<br>Depending on the decimation (D) and serial rate (DDR), there are constraints on the legal values of K. |
| 1   | DDR                    | R/W  | 1      | 0 : SDR serial rate ( $f_{(BIT)} = f_S$ )<br>1 : DDR serial rate ( $f_{(BIT)} = 2f_S$ ) (default)   |
| 0   | JESD_EN <sup>(1)</sup> | R/W  | 1      | 0 : Block disabled<br>1 : Normal operation (default)  |

(1) Before altering any parameters in the JESD\_CTRL1 register, you must set JESD\_EN to 0. When JESD\_EN is 0, the block is held in reset and the serializers are powered down. The clocks are gated off to save power.

**7.6.1.7.3 JESD204B Control 2 Register (address = 0x202) [reset = 0x00]**
**Figure 96. JESD204B Control 2 Register (JESD\_CTRL2)**

|       |              |          |   |               |   |   |   |
|-------|--------------|----------|---|---------------|---|---|---|
| 7     | 6            | 5        | 4 | 3             | 2 | 1 | 0 |
| P54   | SYNC_DIFFSEL | RESERVED |   | JESD204B_TEST |   |   |   |
| R/W-0 | R/W-0        | R/W-00   |   | R/W-0000      |   |   |   |

**Table 74. JESD\_CTRL2 Field Descriptions**

| Bit | Field                        | Type | Reset | Description  |
|-----|------------------------------|------|-------|--|
| 7   | P54                          | R/W  | 0     | 0 : Disable 5/4 PLL. Serial bit rate is 1x or 2x based on DDR parameter.<br>1 : Enable 5/4 PLL. Serial bit rate is 1.25x or 2.5x based on DDR parameter.   |
| 6   | SYNC_DIFFSEL                 | R/W  | 0     | 0 : Use SYNC_SE_N input for SYNC_N function<br>1 : Use SYNC_DIFF_N input for SYNC_N function   |
| 5-4 | RESERVED                     | R/W  | 00    | Set to 00b   |
| 3-0 | JESD204B_TEST <sup>(1)</sup> | R/W  | 0000  | See<br>0 : Test mode disabled. Normal operation (default)<br>1 : PRBS7 test mode<br>2 : PRBS15 test mode<br>3 : PRBS23 test mode<br>4 : Ramp test mode<br>5 : Short and long transport layer test mode<br>6 : D21.5 test mode<br>7 : K28.5 test mode<br>8 : Repeated ILA test mode<br>9 : Modified RPAT test mode<br>10 : Serial outputs held low<br>11 : Serial outputs held high<br>12 through 15 : RESERVED |

(1) The JESD\_CTRL2 register must only be changed when JESD\_EN is 0.

**7.6.1.7.4 JESD204B Device ID (DID) Register (address = 0x203) [reset = 0x00]**
**Figure 97. JESD204B Device ID (DID) Register (JESD\_DID)**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| JESD_DID      |   |   |   |   |   |   |   |
| R/W-0000 0000 |   |   |   |   |   |   |   |

**Table 75. JESD\_DID Field Descriptions**

| Bit | Field                   | Type | Reset     | Description   |
|-----|-------------------------|------|-----------|---|
| 7-0 | JESD_DID <sup>(1)</sup> | R/W  | 0000 0000 | Specifies the DID value that is transmitted during the second multiframe of the JESD204B ILA. |

(1) The DID setting must only be changed when JESD\_EN is 0.

**7.6.1.7.5 JESD204B Control 3 Register (address = 0x204) [reset = 0x00]**
**Figure 98. JESD204B Control 3 Register (JESD\_CTRL3)**

| 7           | 6 | 5 | 4 | 3 | 2 | 1      | 0 |
|-------------|---|---|---|---|---|--------|---|
| RESERVED    |   |   |   |   |   | FCHAR  |   |
| R/W-0000 00 |   |   |   |   |   | R/W-00 |   |

**Table 76. JESD\_CTRL3 Field Descriptions**

| Bit | Field                | Type | Reset   | Description  |
|-----|----------------------|------|---------|--|
| 7-2 | RESERVED             | R/W  | 0000 00 |  |
| 1-0 | FCHAR <sup>(1)</sup> | R/W  | 00      | Specify which comma character is used to denote end-of-frame. This character is transmitted opportunistically according to JESD204B Section 5.3.3.4.<br>When using a JESD204B receiver, always use FCHAR=0. When using a general purpose 8-b or 10-b receiver, the K28.7 character can cause issues. When K28.7 is combined with certain data characters, a false, misaligned comma character can result, and some receivers realign to the false comma. To avoid this, program FCHAR to 1 or 2.<br>0 : Use K28.7 (default) (JESD204B compliant)<br>1 : Use K28.1 (not JESD204B compliant)<br>2 : Use K28.5 (not JESD204B compliant)<br>3 : Reserved |

(1) The JESD\_CTRL3 register must only be changed when JESD\_EN is 0.

**7.6.1.7.6 JESD204B and System Status Register (address = 0x205) [reset = Undefined]**

See the [JESD204B Synchronization Features](#) section for more details.

**Figure 99. JESD204B and System Status Register (JESD\_STATUS)**

| 7        | 6       | 5           | 4         | 3       | 2          | 1        | 0 |
|----------|---------|-------------|-----------|---------|------------|----------|---|
| RESERVED | LINK_UP | SYNC_STATUS | REALIGNED | ALIGNED | PLL_LOCKED | RESERVED |   |
| R/W-0    | R/W-0   | R/W-X       | R/W-X     | R/W-0   | R/W-0      | R/W-00   |   |

**Table 77. JESD\_STATUS Field Descriptions**

| Bit | Field       | Type | Reset | Description   |
|-----|-------------|------|-------|---|
| 7   | RESERVED    | R/W  | 0     | Always returns 0  |
| 6   | LINK_UP     | R/W  | 0     | When set, indicates that the JESD204B link is in the DATA_ENC state.  |
| 5   | SYNC_STATUS | R/W  | X     | Returns the state of the JESD204B SYNC~ signal (SYNC_SE_N or SYNC_DIFF_N).<br>0 : SYNC~ asserted<br>1 : SYNC~ deasserted  |
| 4   | REALIGNED   | R/W  | X     | When high, indicates that the div8 clock, frame clock, or multiframe clock phase was realigned by SYSREF. Writing a 1 to this bit clears it.  |
| 3   | ALIGNED     | R/W  | 0     | When high, indicates that the multiframe clock phase has been established by SYSREF. The first SYSREF event after enabling the JESD204B encoder will set this bit. Writing a 1 to this bit clears it. |
| 2   | PLL_LOCKED  | R/W  | 0     | When high, indicates that the PLL is locked.  |
| 1-0 | RESERVED    | R/W  | 0     | Always returns 0  |

**7.6.1.7.7 Overrange Threshold 0 Register (address = 0x206) [reset = 0xF2]**
**Figure 100. Overrange Threshold 0 Register (OVR\_T0)**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OVR_T0        |   |   |   |   |   |   |   |
| R/W-1111 0010 |   |   |   |   |   |   |   |

**Table 78. OVR\_T0 Field Descriptions**

| Bit | Field  | Type | Reset     | Description   |
|-----|--------|------|-----------|---|
| 7-0 | OVR_T0 | R/W  | 1111 0010 | Overrange threshold 0. This parameter defines the absolute sample level that causes control bit 0 to be set. Control bit 0 is attached to the DDC I output samples. The detection level in dBFS (peak) is $20_{\log_{10}}(\text{OVR\_T0} / 256)$<br>Default: 0xF2 = 242 → -0.5 dBFS |

**7.6.1.7.8 Overrange Threshold 1 Register (address = 0x207) [reset = 0xAB]**
**Figure 101. Overrange Threshold 1 Register (OVR\_T1)**

|               |   |   |   |   |   |   |   |
|---------------|---|---|---|---|---|---|---|
| 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| OVR_T1        |   |   |   |   |   |   |   |
| R/W-1010 1011 |   |   |   |   |   |   |   |

**Table 79. OVR\_T1 Field Descriptions**

| Bit | Field  | Type | Reset     | Description   |
|-----|--------|------|-----------|---|
| 7-0 | OVR_T1 | R/W  | 1010 1011 | Overrange threshold 1. This parameter defines the absolute sample level that causes control bit 1 to be set. Control bit 1 is attached to the DDC Q output samples. The detection level in dBFS (peak) is $20_{\log_{10}}(\text{OVR\_T1} / 256)$<br>Default: 0xAB = 171 → -3.5 dBFS |

**7.6.1.7.9 Overrange Period Register (address = 0x208) [reset = 0x00]**
**Figure 102. Overrange Period Register (OVR\_N)**

|            |   |   |   |   |         |   |   |
|------------|---|---|---|---|---------|---|---|
| 7          | 6 | 5 | 4 | 3 | 2       | 1 | 0 |
| RESERVED   |   |   |   |   | OVR_N   |   |   |
| R/W-0000 0 |   |   |   |   | R/W-000 |   |   |

**Table 80. OVR\_N Field Descriptions**

| Bit | Field                | Type | Reset  | Description   |
|-----|----------------------|------|--------|---|
| 7-3 | RESERVED             | R/W  | 0000 0 |   |
| 2-0 | OVR_N <sup>(1)</sup> | R/W  | 000    | This bit adjusts the monitoring period for the OVR[1:0] output bits. The period is scaled by $2^{\text{OVR\_N}}$ . Incrementing this field doubles the monitoring period. |

(1) Changing the OVR\_N setting while JESD\_EN=1 may cause the phase of the monitoring period to change.

**7.6.1.7.10 DDC Configuration Preset Mode Register (address = 0x20C) [reset = 0x00]**
**Figure 103. DDC Configuration Preset Mode Register (NCO\_MODE)**

|              |   |   |   |   |   |   |          |
|--------------|---|---|---|---|---|---|----------|
| 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
| RESERVED     |   |   |   |   |   |   | CFG_MODE |
| R/W-0000 000 |   |   |   |   |   |   | R/W-0    |

**Table 81. NCO\_MODE Field Descriptions**

| Bit | Field    | Type | Reset    | Description  |
|-----|----------|------|----------|--|
| 7-1 | RESERVED | R/W  | 0000 000 |  |
| 0   | CFG_MODE | R/W  | 0        | The NCO frequency and phase are set by the NCO_FREQ <sub>x</sub> and NCO_PHASE <sub>x</sub> registers, where x is the configuration preset (0 through 7). The DDC delay setting is defined by the DDC_DLY <sub>x</sub> register.<br>0 : Use NCO_[2:0] input pins to select the active DDC and NCO configuration preset.<br>1 : Use the NCO_SEL register to select the active DDC and NCO configuration preset. |

**7.6.1.7.11 DDC Configuration Preset Select Register (address = 0x20D) [reset = 0x00]**
**Figure 104. DDC Configuration Preset Select Register (NCO\_SEL)**

|            |   |   |   |   |   |         |   |
|------------|---|---|---|---|---|---------|---|
| 7          | 6 | 5 | 4 | 3 | 2 | 1       | 0 |
| RESERVED   |   |   |   |   |   | NCO_SEL |   |
| R/W-0000 0 |   |   |   |   |   | R/W-000 |   |

**Table 82. NCO\_SEL Field Descriptions**

| Bit | Field    | Type | Reset  | Description   |
|-----|----------|------|--------|---|
| 7-3 | RESERVED | R/W  | 0000 0 |   |
| 2-0 | NCO_SEL  | R/W  | 000    | When NCO_MODE = 1, this register is used to select the active configuration preset. |

**7.6.1.7.12 Rational NCO Reference Divisor Register (address = 0x20E to 0x20F) [reset = 0x0000]**
**Figure 105. Rational NCO Reference Divisor Register (NCO\_RDIV)**

|           |    |    |    |    |    |   |   |
|-----------|----|----|----|----|----|---|---|
| 15        | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| NCO_RDIV  |    |    |    |    |    |   |   |
| R/W-0x00h |    |    |    |    |    |   |   |
| 7         | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| NCO_RDIV  |    |    |    |    |    |   |   |
| R/W-0x00h |    |    |    |    |    |   |   |

**Table 83. NCO\_RDIV Field Descriptions**

| Bit  | Field    | Type | Reset   | Description  |
|------|----------|------|---------|--|
| 15-0 | NCO_RDIV | R/W  | 0x0000h | <p>Sometimes the 32-bit NCO frequency word does not provide the desired frequency step size and can only approximate the desired frequency. This results in a frequency error. Use this register to eliminate the frequency error. Use this equation to compute the proper value to program:</p> $\text{NCO\_RDIV} = f_S / f_{(\text{STEP})} / 128$ <p>where</p> <ul style="list-style-type: none"> <li><math>f_S</math> is the ADC sample rate</li> <li><math>f_{(\text{STEP})}</math> is the desired NCO frequency step size</li> </ul> <p style="text-align: right;">(10)</p> <p>For example, if <math>f_S = 3072</math> MHz, and <math>f_{(\text{STEP})} = 10</math> KHz then:</p> $\text{NCO\_RDIV} = 3072 \text{ MHz} / 10 \text{ KHz} / 128 = 2400$ <p style="text-align: right;">(11)</p> <p>Any combination of <math>f_S</math> and <math>f_{(\text{STEP})}</math> that results in a fractional value for NCO_RDIV is not supported. Values of NCO_RDIV larger than 8192 can degrade the NCO's SFDR performance and are not recommended. This register is used for all configuration presets.</p> |

**7.6.1.7.13 NCO Frequency (Preset x) Register (address = see Table 71) [reset = see Table 71]**
**Figure 106. NCO Frequency (Preset x) Register (NCO\_FREQ\_x)**

|            |    |    |    |    |    |    |    |
|------------|----|----|----|----|----|----|----|
| 31         | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| NCO_FREQ_x |    |    |    |    |    |    |    |
| R/W-0xC0h  |    |    |    |    |    |    |    |
| 23         | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| NCO_FREQ_x |    |    |    |    |    |    |    |
| R/W-0x00h  |    |    |    |    |    |    |    |
| 15         | 14 | 13 | 12 | 11 | 10 | 9  | 8  |
| NCO_FREQ_x |    |    |    |    |    |    |    |
| R/W-0x00h  |    |    |    |    |    |    |    |
| 7          | 6  | 5  | 4  | 3  | 2  | 1  | 0  |
| NCO_FREQ_x |    |    |    |    |    |    |    |
| R/W-0x00h  |    |    |    |    |    |    |    |

**Table 84. NCO\_FREQ\_x Field Descriptions**

| Bit  | Field      | Type | Reset           | Description   |
|------|------------|------|-----------------|---|
| 31-0 | NCO_FREQ_x | R/W  | 0xC00000<br>00h | <p>Changing this register after the JESD204B interface is running results in non-deterministic NCO phase. If deterministic phase is required, the JESD204B interface must be re-initialized after changing this register.</p> <p>The NCO frequency (<math>f_{(NCO)}</math>) is:</p> $f_{(NCO)} = NCO\_FREQ\_x \times 2^{-32} \times f_S$ <p>where</p> <ul style="list-style-type: none"> <li><math>f_S</math> is the sampling frequency of the ADC</li> <li>NCO_FREQ_x is the integer value of this register</li> </ul> <p>(12)</p> <p>This register can be interpreted as signed or unsigned. Use this equation to determine the value to program:</p> $NCO\_FREQ\_x = 2^{32} \times f_{(NCO)} / f_S$ <p>(13)</p> <p>If the equation does not result in an integer value, you must choose an alternate frequency step (<math>f_{(STEP)}</math>) and program the NCO_RDIV register. Then use one of the following equations to compute NCO_FREQ_x:</p> $NCO\_FREQ\_x = \text{round}(2^{32} \times f_{(NCO)} / f_S)$ <p>(14)</p> $NCO\_FREQ\_x = \text{round}(2^{25} \times f_{(NCO)} / f_{(STEP)} / NCO\_RDIV)$ <p>(15)</p> |

**7.6.1.7.14 NCO Phase (Preset x) Register (address = see Table 71) [reset = see Table 71]**
**Figure 107. NCO Phase (Preset) Register (NCO\_PHASE\_x)**

|             |    |    |    |    |    |   |   |
|-------------|----|----|----|----|----|---|---|
| 15          | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| NCO_PHASE_x |    |    |    |    |    |   |   |
| R/W-0x00h   |    |    |    |    |    |   |   |
| 7           | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| NCO_PHASE_x |    |    |    |    |    |   |   |
| R/W-0x00h   |    |    |    |    |    |   |   |

**Table 85. NCO\_PHASE\_x Field Descriptions**

| Bit  | Field       | Type | Reset   | Description  |
|------|-------------|------|---------|--|
| 15-0 | NCO_PHASE_x | R/W  | 0x0000h | This value is MSB-justified into a 32-bit field and then added to the phase accumulator. The phase (in radians) is<br>$\text{NCO\_PHASE\_x} \times 2^{-16} \times 2\pi \quad (16)$ This register can be interpreted as signed or unsigned. |

**7.6.1.7.15 DDC Delay (Preset x) Register (address = see Table 71) [reset = see Table 71]**
**Figure 108. DDC Delay (Preset) Register (DDC\_DLY\_x)**

|           |   |   |   |   |   |   |   |
|-----------|---|---|---|---|---|---|---|
| 7         | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| DDC_DLY_x |   |   |   |   |   |   |   |
| R/W-0xFFh |   |   |   |   |   |   |   |

**Table 86. DDC\_DLY\_x Field Descriptions**

| Bit | Field     | Type | Reset | Description   |
|-----|-----------|------|-------|---|
| 7-0 | DDC_DLY_x | R/W  | 0xFFh | DDC delay for configuration preset 0<br>This register provides fine adjustments to the DDC group delay. The step size is one half of an ADC sample period ( $t_{\text{DEVCLK}} / 2$ ). This is equivalent to Equation 17.<br>$t_{\text{O}} / (2 \times D)$ where <ul style="list-style-type: none"> <li><math>t_{\text{O}}</math> is the DDC output sample period</li> <li><math>D</math> is the decimation factor <span style="float: right;">(17)</span></li> </ul> The legal range for this register is 0 to 2D-1. Illegal values result in undefined behavior.<br>Example: When $D = 8$ , the legal register range is 0 to 15. The step size is $t_{\text{O}} / 16$ and the maximum delay is $15 \times t_{\text{O}} / 16$ .<br>Programming this register to 0xFF (the default value) powers down and bypasses the fractional delay filter which reduces the DDC latency by 34 ADC sample periods (as compared to the 0 setting). |

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

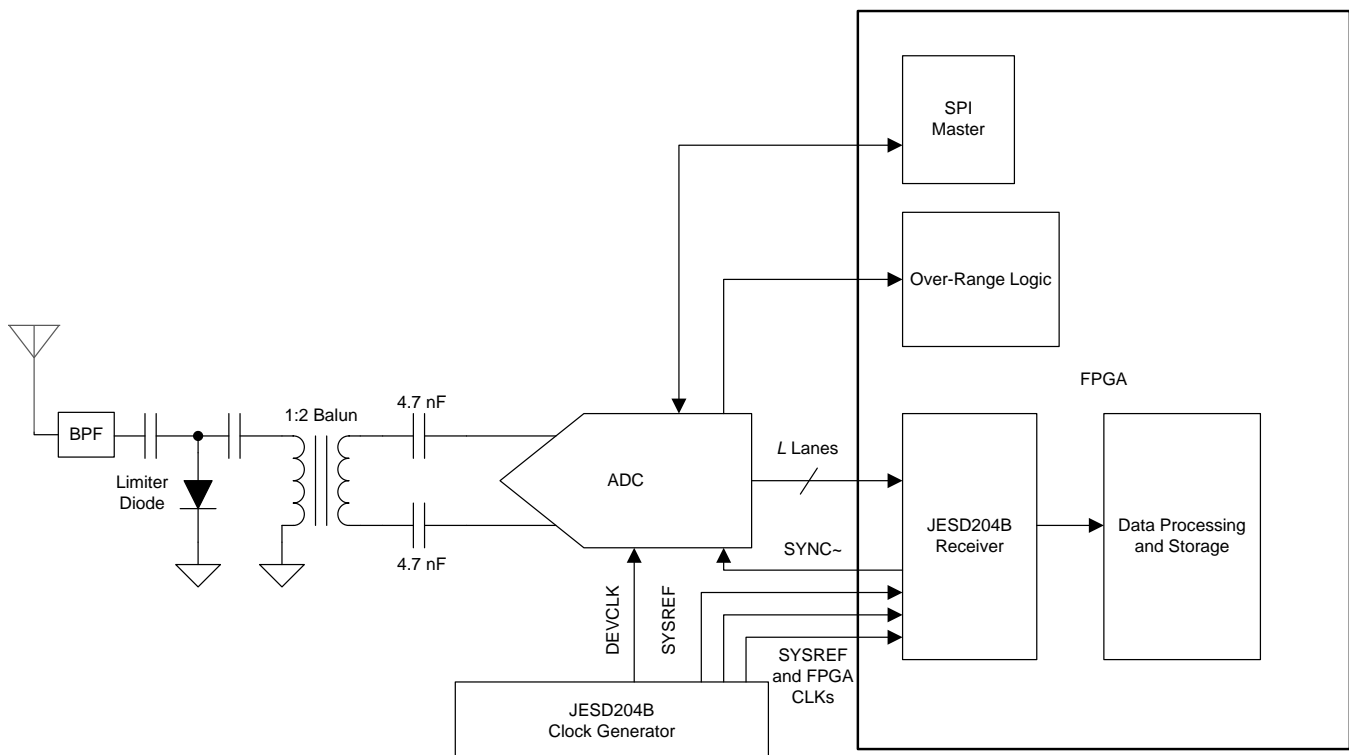
### 8.1 Application Information

The ADC12J1600 and ADC12J2700 devices are a wideband sampling and digital tuning device. The ADC input captures input signals from DC to greater than 3 GHz. The DDC performs digital-down conversion and programmable decimation filtering, and outputs complex (15 bit I and 15 bit Q) data. In DDC Bypass Mode (Decimation = 1) the raw 12 bit ADC data is also available. The resulting output data is output on the JESD204B data interface for capture by the downstream capture or processing device. Most frequency-domain applications benefit from DDC capability to select the desired frequency band and provide only the necessary bandwidth of output data, minimizing the required number of data signals. Time domain applications generally require the raw 12-bit ADC output data provided by the DDC bypass feature.

### 8.2 Typical Application

#### 8.2.1 RF Sampling Receiver

An RF Sampling Receiver is used to directly sample a signal in the RF frequency range and provide the data for the captured signal to downstream processing. The wide input bandwidth, high sampling rate, and DDC features of the ADC12J1600 and ADC12J2700 make them ideally suited for this application.



**Figure 109. Simplified Schematic**

## Typical Application (continued)

### 8.2.1.1 Design Requirements

For this design example, use the parameters listed in [Table 87](#).

**Table 87. Design Parameters**

| DESIGN PARAMETERS                        | EXAMPLE VALUES |
|--|----------------|
| Signal center frequency                  | 2500 MHz       |
| Signal bandwidth                         | 100 MHz        |
| Signal nominal amplitude                 | -7 dBm         |
| Signal maximum amplitude                 | 6 dBm          |
| Minimum SINAD (in bandwidth of interest) | 48 dBc         |
| Minimum SFDR (in bandwidth of interest)  | 60 dBc         |

### 8.2.1.2 Detailed Design Procedure

Use the following steps to design the RF receiver:

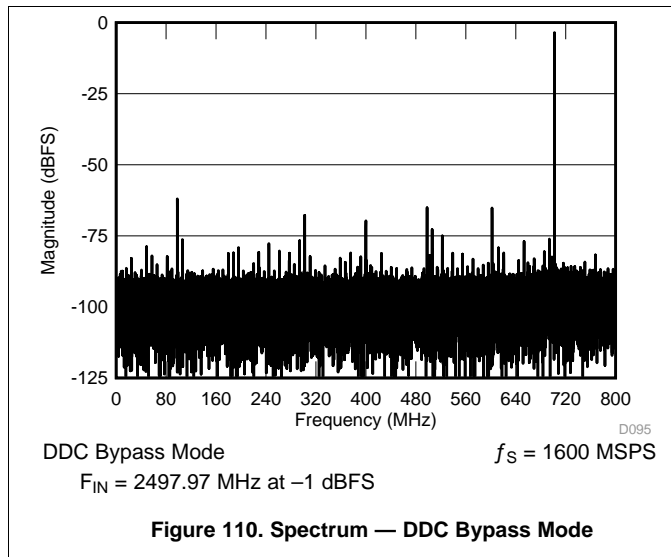
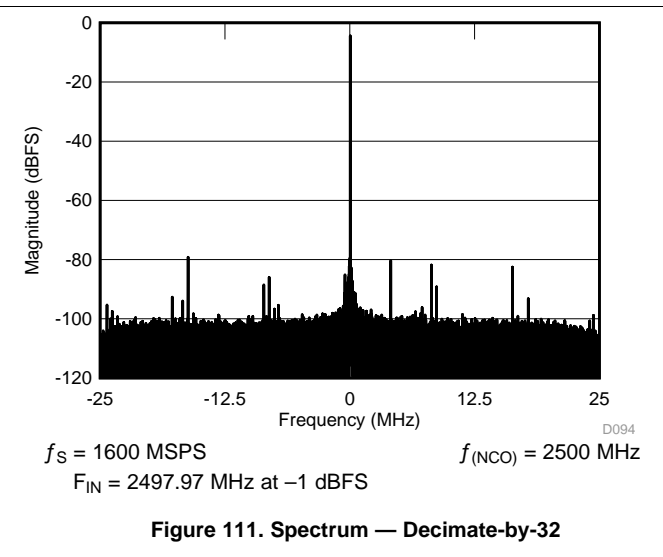
- Use the signal-center frequency and signal bandwidth to select an appropriate sampling rate (DEVCLK frequency) and decimate factor ( $x / 4$  to  $x / 32$ ).
- Select the sampling rate so that the band of interest is completely within a Nyquist zone.
- Select the sampling rate so that the band of interest is away from any harmonics or interleaving tones.
- Use a frequency planning tool, such as the ADC harmonic calculator (see the [Development Support](#) section).
- Select the decimation factor that provides the highest factor possible with an adequate alias-protected output bandwidth to capture the frequency bandwidth of interest.
- Select other system components to provide the needed signal frequency range and DEVCLK rate.
- See [Table 1](#) for recommended balun components.
- Select bandpass filters and limiter components based on the requirement to attenuate unwanted signals outside the band of interest (blockers) and to prevent large signals from damaging the ADC inputs. See the [Absolute Maximum Ratings](#) table.

The LMK048xx JESD204B clocking devices can provide the DEVCLK clock and other system clocks for  $f_{(DEVCLK)} < 3101$  MHz.

For DEVCLK frequencies up to 4 GHz the consider using the LMX2581 and TRF3765 devices as the DEVCLK source. Use the LMK048xx device to provide the JESD204B clocks. For additional device information, see the [Related Documentation](#) section.

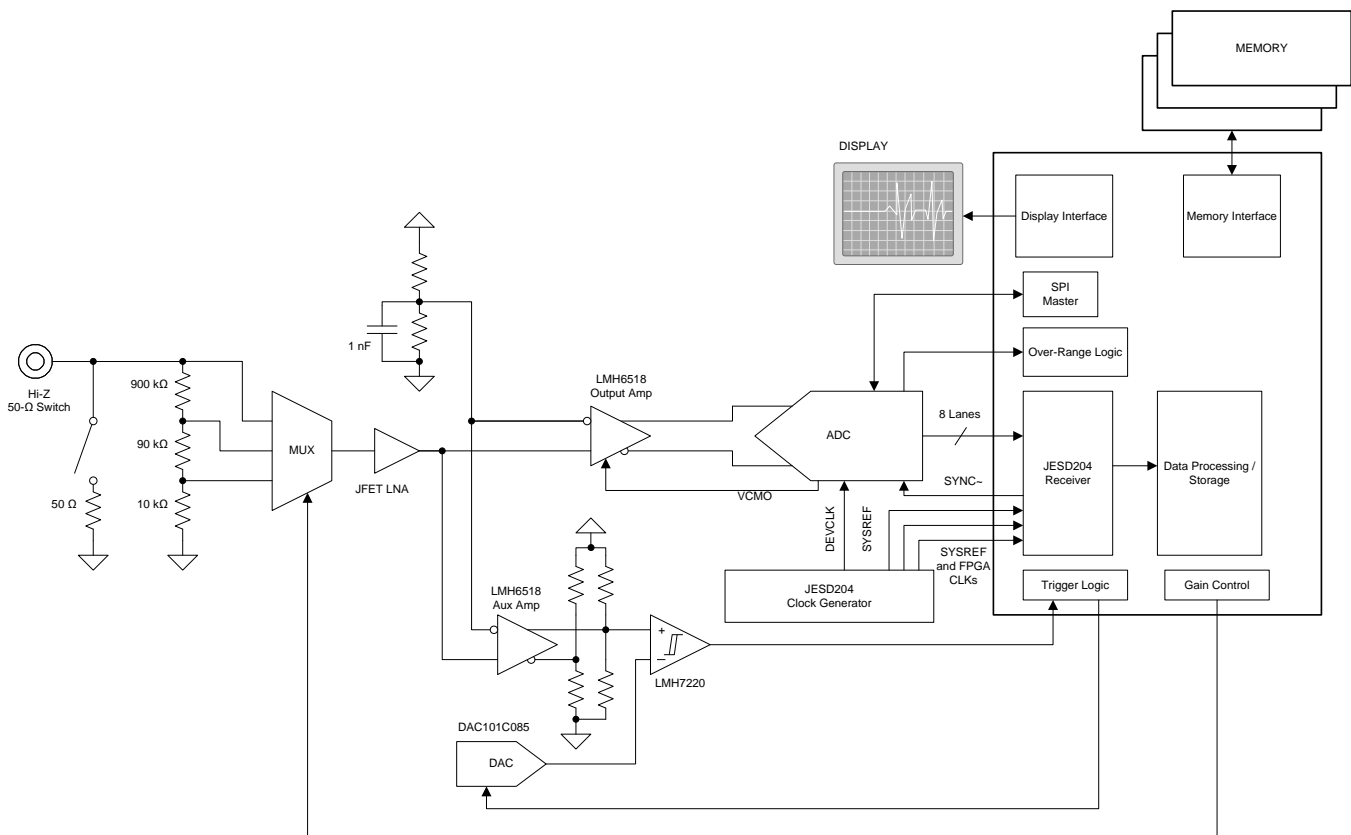
### 8.2.1.3 Application Curves

The following curves show an RF signal at 2497.97 MHz captured at a sample rate of 1600 MSPS. [Figure 110](#) shows the spectrum for the full Nyquist band. [Figure 111](#) shows the spectrum for the output data in decimate-by-32 mode with  $f_{(NCO)}$  equal to 700 MHz. [Figure 111](#) shows the ability to provide only the spectrum of interest in the decimated output data. [Figure 111](#) also shows how proper selection of the sampling rate can ensure interleaving tones are outside the band of interest and outside the decimated frequency range. Lastly, [Figure 111](#) shows the reduction in the noise floor provided by the processing gain of decimation.


**Figure 110. Spectrum — DDC Bypass Mode**

**Figure 111. Spectrum — Decimate-by-32**

### 8.2.2 Oscilloscope

The ADC12J1600 and ADC12J2700 devices are equally well-suited for high-speed time-domain applications such as oscilloscopes. The following typical application is for a generic high-speed oscilloscope. Adjustable gain is provided by the front-end resistor ladder and selection mux, and the gain adjustments of the LMH6518 device. Additional gain fine-tuning can be achieved using the full-scale range adjustment features of the ADC.


**Figure 112. Simplified Schematic for an Oscilloscope**

### 8.2.2.1 Design Requirements

For this design example, use the parameters listed in [Table 88](#).

**Table 88. Design Parameters**

| DESIGN PARAMETERS         | EXAMPLE VALUES   |
|---------------------------|------------------|
| Maximum sample rate       | 1600 MSPS        |
| Maximum input frequency   | 1500 MHz         |
| 1-dB flat-frequency range | 0 to 1000 MHz    |
| Signal maximum amplitude  | 6 dBm            |
| Signal minimum amplitude  | 48 dBc           |
| Maximum capture depth     | 1 million points |

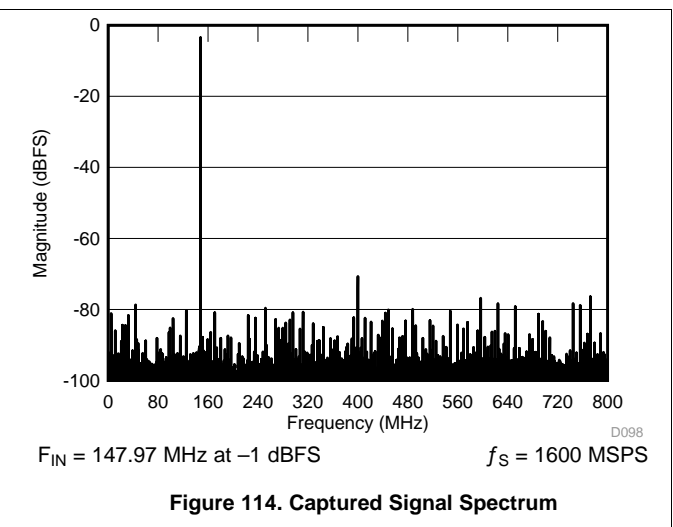
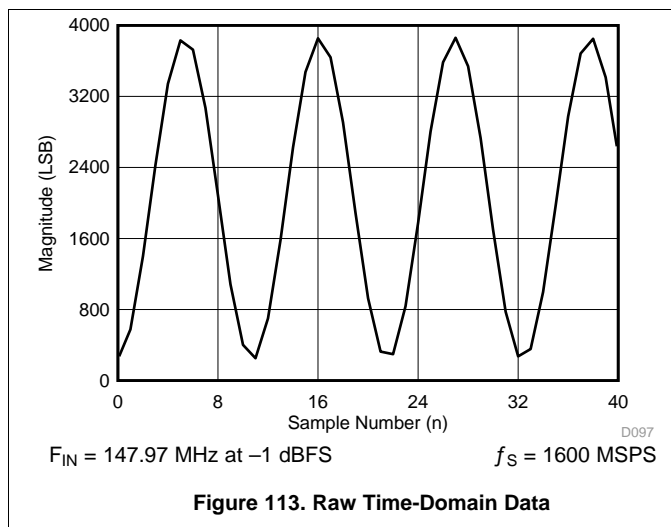
### 8.2.2.2 Detailed Design Procedure

Use the following primary steps to design a 12-bit oscilloscope:

- Select the desired sampling rate based on the maximum sampling-rate requirement.
- Select the input path components (LNA, amplifier, and other components) based on the maximum input frequency and 1-dB flat-frequency range requirements.
- Set the attenuation range steps based on the required minimum and maximum values for the signal amplitude.
- Select the memory size based on the resolution of the ADC output (12 bits) and the required maximum number of sample points.

### 8.2.2.3 Application Curves

The following curves show the time-domain sample data for a 150-MHz input signal at  $-1$  dBFS, sampled at 1600 MSPS using the ADC12J1600 device. [Figure 113](#) shows the raw time-domain data. [Figure 114](#) shows the spectrum of the captured signal which shows the additional capability of a 12-bit ADC oscilloscope to provide basic spectrum-analysis functions with reasonable performance.



## 8.3 Initialization Set-Up

### 8.3.1 JESD204B Startup Sequence

The JESD204B interface requires a specific startup and alignment sequence. The general order of that sequence is listed in the following steps.

1. Power up or reset the ADC12J1600 and ADC12J2700 devices.
2. Program JESD\_EN = 0 to shut down the link and enable configuration changes.
3. Program DECIMATE, SCRAM\_EN, KM1 and DDR to the desired settings.
4. Configure the device calibration settings as desired, and initiate a calibration (set CAL\_SFT = 1).
5. Program JESD\_EN = 1 to enable the link.
6. Apply at least one SYSREF rising edge to establish the LMFC phase.
7. Assert SYNC~ from the data receiver to initiate link communications.
8. After the JESD204B receiver has established code group synchronization, SYNC~ is de-asserted and the ILA process begins.
9. Immediately following the end of the ILA sequence normal data output begins.

---

#### NOTE

If deterministic latency is not required this step can be omitted.

---

## 8.4 Dos and Don'ts

### 8.4.1 Common Application Pitfalls

**Driving the inputs (analog or digital) beyond the power supply rails.** For device reliability, an input must not go more than 150 mV below the ground pins or 150 mV above the supply pins. Exceeding these limits even on a transient basis can cause faulty, or erratic, operation and can impair device reliability. High-speed digital circuits exhibiting undershoot that goes more than a volt below ground is common. To control overshoot, the impedance of high-speed lines must be controlled and these lines must be terminated in the characteristic impedance.

Care must be taken not to overdrive the inputs of the ADC12J1600 and ADC12J2700 devices. Such practice can lead to conversion inaccuracies and even to device damage.

**Incorrect analog input common-mode voltage in the DC-coupled mode.** As described in the [The Analog Inputs](#) and [DC Coupled Input Usage](#) sections, the input common-mode voltage ( $V_{\text{CMI}}$ ) must remain the specified range as referenced to the VCMI pin, which has a variability with temperature that must also be tracked. Distortion performance is degraded if the input common mode voltage is outside the specified  $V_{\text{CMI}}$  range.

**Using an inadequate amplifier to drive the analog input.** Use care when choosing a high frequency amplifier to drive the ADC12J1600 and ADC12J2700 devices because many high-speed amplifiers have higher distortion than the ADC12J1600 and ADC12J2700 devices which results in overall system performance degradation.

**Driving the clock input with an excessively high level signal.** The ADC input clock level must not exceed the level described in the [Recommended Operating Conditions](#) table because the input offset can change if these levels are exceeded.

**Inadequate input clock levels.** As described in the [Using the Serial Interface](#) section, insufficient input clock levels can result in poor performance. Excessive input-clock levels can result in the introduction of an input offset.

**Using a clock source with excessive jitter, using an excessively long input clock signal trace, or having other signals coupled to the input clock signal trace.** These pitfalls cause the sampling interval to vary which causes excessive output noise and a reduction in SNR performance.

**Failure to provide adequate heat removal.** As described in the [Thermal Management](#) section, providing adequate heat removal is important to ensure device reliability. Adequate heat removal is primarily provided by properly connecting the thermal pad to the circuit board ground planes. Multiple vias should be arranged in a grid pattern in the area of the thermal pad. These vias will connect the topside pad to the internal ground planes and to a copper pour area on the opposite side of the printed circuit board.

## 9 Power Supply Recommendations

Data-converter-based systems draw sufficient transient current to corrupt their own power supplies if not adequately bypassed. A 10- $\mu$ F capacitor must be placed within one inch (2.5 cm) of the device power pins for each supply voltage. A 0.1- $\mu$ F capacitor must be placed as close as possible to each supply pin, preferably within 0.5 cm. Leadless chip capacitors are preferred due to their low-lead inductance.

As is the case with all high-speed converters, the ADC12J1600 and ADC12J2700 devices must be assumed to have little power-supply noise-rejection. Any power supply used for digital circuitry in a system where a large amount of digital power is consumed must not be used to supply power to the ADC12J1600 and ADC12J2700 devices. If not a dedicated supply, the ADC supplies must be the same supply used for other analog circuitry.

### 9.1 Supply Voltage

The ADC12J1600 and ADC12J2700 devices are specified to operate with nominal supply voltages of 1.9 V (VA19) and 1.2 V (VA12, VD12). For detailed information regarding the operating voltage minimums and maximums see the [Recommended Operating Conditions](#) table.

During power-up the voltage on all 1.9-V supplies must always be equal to or greater than the voltage on the 1.2-V supplies. Similarly, during power-down, the voltage on the 1.2-V supplies must always be lower than or equal to that of the 1.9-V supplies. In general, supplying all 1.9-V buses from a single regulator, and all 1.2-V buses from a single regulator is the easiest method to ensure that the 1.9-V supplies are greater than the 1.2-V supplies. If the 1.2-V buses are generated from separate regulators, they must rise and fall together (within 200 mV).

The voltage on a pin, including a transient basis, must not have a voltage that is in excess of the supply voltage or below ground by more than 150 mV. A pin voltage that is higher than the supply or that is below ground can be a problem during startup and shutdown of power. Ensure that the supplies to circuits driving any of the input pins, analog or digital, do not rise faster than the voltage at the ADC12J1600 and ADC12J2700 power pins.

The values in the [Absolute Maximum Ratings](#) table must be strictly observed including during power up and power down. A power supply that produces a voltage spike at power turnon, turnoff, or both can destroy the ADC12J1600 and ADC12J2700 devices. Many linear regulators produce output spiking at power on unless there is a minimum load provided. Active devices draw very little current until the supply voltages reach a few hundred millivolts. The result can be a turn-on spike that destroys the ADC12J1600 and ADC12J2700 devices, unless a minimum load is provided for the supply. A 100- $\Omega$  resistor at the regulator output provides a minimum output current during power up to ensure that no turn-on spiking occurs. Whether a linear or switching regulator is used, TI recommends using a soft-start circuit to prevent overshoot of the supply.

## 10 Layout

### 10.1 Layout Guidelines

Proper grounding and proper routing of all signals is essential to ensure accurate conversion. Each ground layer should be a single unified ground plane, rather than splitting the ground planes into analog and digital areas.

Because digital switching transients are composed largely of high frequency components, the skin effect dictates that the total ground-plane copper weight has little effect upon the logic-generated noise. Total surface area is more important than the total ground-plane volume. Coupling between the typically-noisy digital circuitry and the sensitive analog circuitry can lead to poor performance that can be impossible to isolate and remedy. The solution is to keep the analog circuitry well separated from the digital circuitry.

High-power digital components must not be located on or near any linear component or power-supply trace or plane that services analog or mixed-signal components because the resulting common return current path could cause fluctuation in the analog input *ground* return of the ADC which causes excessive noise in the conversion result.

In general, assume that analog and digital lines must cross each other at 90° to avoid digital noise into the analog path. In high frequency systems, however, avoid crossing analog and digital lines altogether. The input clock lines must be isolated from **all** other lines, both analog and digital. The generally-accepted 90° crossing must be avoided because even a same amount of coupling causes problems at high frequencies. Best performance at high frequencies is obtained with a straight signal path.

## Layout Guidelines (continued)

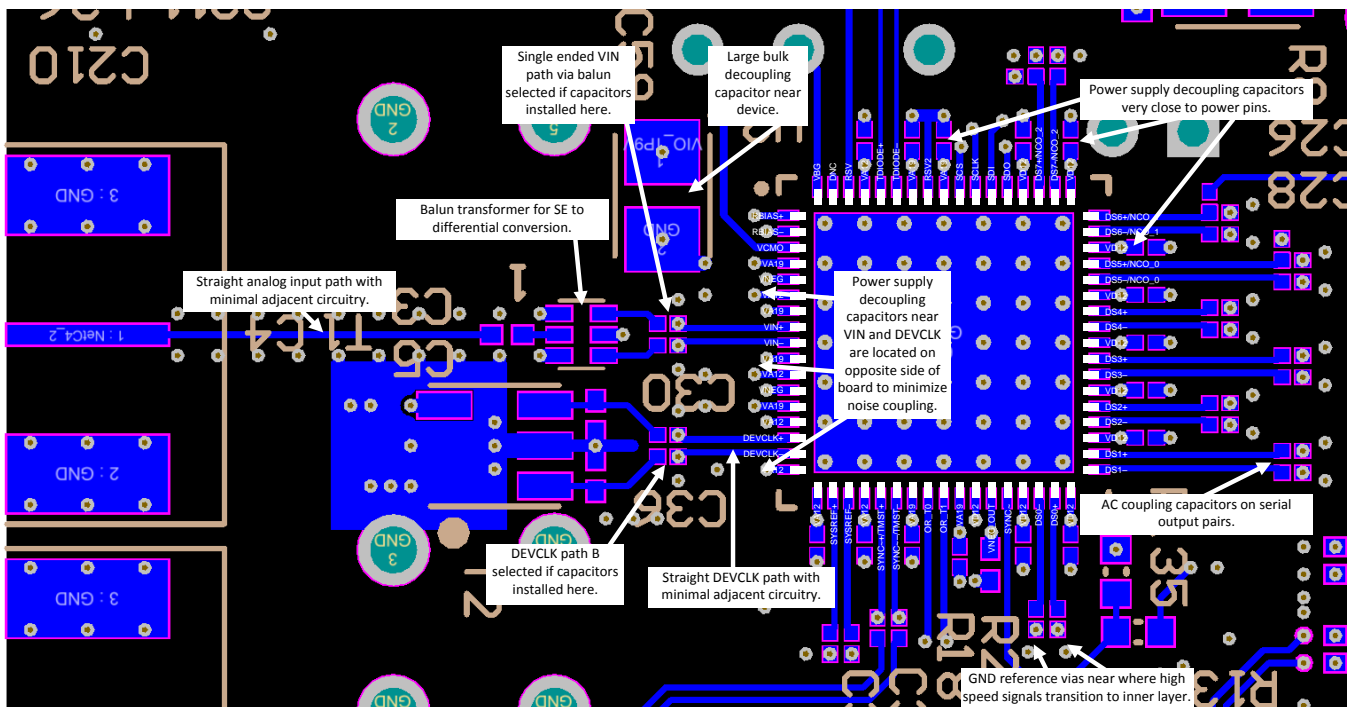
Coupling onto or between the clock and input signal paths must be avoided using any isolation techniques available including distance isolation, orientation planning to prevent field coupling of components like inductors and transformers, and providing well coupled reference planes. Via stitching around the clock signal path and the input analog signal path provides a quiet ground reference for the critical signal paths and reduces noise coupling onto these paths. Sensitive signal traces must not cross other signal traces or power routing on adjacent PCB layers, rather a ground plane must separate the traces. If necessary, the traces should cross at 90° angles to minimize crosstalk.

Isolation of the analog input is important because of the low-level drive required of the ADC12J1600 and ADC12J2700 devices. Quality analog input signal and clock signal path layout is required for full dynamic performance. Symmetry of the differential signal paths and discrete components in the path is mandatory and symmetrical shunt-oriented components should have a common grounding via. The high frequency requirements of the input and clock signal paths necessitate using differential routing with controlled impedances and minimizing signal path stubs (including vias) when possible.

Layout of the high-speed serial-data lines is of particular importance. These traces must be routed as tightly coupled 100-Ω differential pairs, with minimal vias. When vias must be used, care must be taken to implement control-impedance vias (that is, 50-Ω) with adjacent ground vias for image current control.

## 10.2 Layout Example

The following examples show layout-example plots (top and bottom layers only). [Figure 117](#) shows a typical stackup for a 10 layer board.



**Figure 115. ADC12J1600 and ADC12J2700 Layout Example 1 — Top Side**



## 10.3 Thermal Management

The ADC12J1600 and ADC12J2700 devices are capable of impressive speeds and performance at low power levels for speed. However, the power consumption is still high enough to require attention to thermal management. The VQFN package has a primary-heat transfer path through the center pad on the bottom of the package. The thermal resistance of this path is provided as  $R_{\theta JCbot}$ .

For reliability reasons, the die temperature must be kept to a maximum of 135°C which is the ambient temperature ( $T_A$ ) plus the ADC power consumption multiplied by the net junction-to-ambient thermal resistance ( $R_{\theta JA}$ ). Maintaining this temperature is not a problem if the ambient temperature is kept to a maximum of 85°C as specified in the [Recommended Operating Conditions](#) table and the center ground pad on the bottom of the package is thermally connected to a large-enough copper area of the PC board.

The package of the ADC12J1600 and ADC12J2700 devices have a center pad that provides the primary heat-removal path as well as excellent electrical grounding to the PCB. Recommended land pattern and solder paste examples are provided in the [Mechanical, Packaging, and Orderable Information](#) section. The center-pad vias shown must be connected to internal ground planes to remove the maximum amount of heat from the package, as well as to ensure best product parametric performance.

If needed to further reduce junction temperature, TI recommends to build a simple heat sink into the PCB which occurs by including a copper area of about 1 to 2 cm<sup>2</sup> on the opposite side of the PCB. This copper area can be plated or solder-coated to prevent corrosion, but should not have a conformal coating which would provide thermal insulation. Thermal vias will be used to connect these top and bottom copper areas and internal ground planes. These thermal vias act as *heat pipes* to carry the thermal energy from the device side of the board to the opposite side of the board where the heat can be more effectively dissipated.

## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Third-Party Products Disclaimer

TI'S PUBLICATION OF INFORMATION REGARDING THIRD-PARTY PRODUCTS OR SERVICES DOES NOT CONSTITUTE AN ENDORSEMENT REGARDING THE SUITABILITY OF SUCH PRODUCTS OR SERVICES OR A WARRANTY, REPRESENTATION OR ENDORSEMENT OF SUCH PRODUCTS OR SERVICES, EITHER ALONE OR IN COMBINATION WITH ANY TI PRODUCT OR SERVICE.

#### 11.1.2 Development Support

For the ADC Harmonic Calculator, go to <http://www.ti.com/tool/adc-harmonic-calc>.

#### 11.1.3 Device Nomenclature

**Aperture (sampling) Delay** is the amount of delay, measured from the sampling edge of the clock input, after which the signal present at the input pin is sampled inside the device.

**Aperture Jitter ( $t_{AJ}$ )** is the variation in aperture delay from sample to sample. Aperture jitter appears as input noise.

**Clock Duty Cycle** is the ratio of the time that the clock waveform is at a logic high to the total time of one clock period.

**Full Power Bandwidth (FPBW)** is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below the low frequency value for a full scale input.

**Interleaving Spurs** are frequency domain (FFT) artifacts resulting from non-idealities in the multi-bank interleaved architecture of the ADC.

Offset errors between banks result in fixed spurs at  $f_S / 4$  and  $f_S / 2$ . Gain and timing errors result in input-signal-dependent spurs at  $f_S / 4 \pm F_{IN}$  and  $f_S / 2 \pm F_{IN}$ .

**Intermodulation Distortion (IMD)** is the creation of additional spectral components as a result of two sinusoidal frequencies being applied to the ADC input at the same time. IMD is defined as the ratio of the power in the second-order and third-order intermodulation products to the power in one of the original frequencies. IMD is usually expressed in dBFS.

## Device Support (continued)

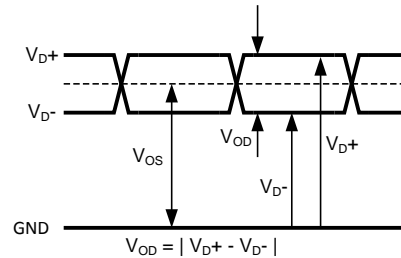
**Least Significant Bit (LSB)** is the bit that has the smallest value or weight of all bits. This value is calculated with [Equation 18](#).

$$V_{FS(dif)} / 2^n$$

where

- $V_{FS(dif)}$  is the differential full-scale amplitude of  $V_i$  as set by the FSR input (pin 14)
- $n$  is the ADC resolution in bits, which is 12 for the ADC12J1600 and ADC12J2700 devices (18)

**CML Differential Output Voltage ( $V_{OD}$ )** is the absolute value of the difference between the positive and negative outputs. Each output is measured with respect to Ground.



### CML Output Signal Levels

**CML Output Offset Voltage ( $V_{O(ofs)}$ )** is the midpoint between the D+ and D– pins output voltage. [Equation 19](#) is an example of  $V_{OS}$ .

$$[(V_{D+}) + (V_{D-})] / 2 \quad (19)$$

**Most Significant Bit (MSB)** is the bit that has the largest value or weight. The value of the MSB is one half of full scale.

**Overrange Recovery Time** is the time required after the differential input voltages goes from  $\pm 1.2$  V to 0 V for the converter to recover and make a conversion with its rated accuracy.

**Other Spurs** is the sum of all higher harmonics (fourth and above), interleaving spurs, and any other fixed or input-dependent spurs.

**Data Delay (Latency)** is the number of input clock cycles between initiation of conversion and when related data is present at the serializer output.

**Spurious-free Dynamic Range (SFDR)** is the difference, expressed in dB, between the RMS values of the input signal at the output and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input, excluding DC.

**Total Harmonic Distortion (THD)** is the ratio expressed in dB, of the RMS total of the first nine harmonic levels at the output to the level of the fundamental at the output. THD is calculated with [Equation 20](#).

$$THD = 20 \times \log \sqrt{\frac{A_{f2}^2 + \dots + A_{f10}^2}{A_{f1}^2}}$$

where

- $A_{(f1)}$  is the RMS power of the fundamental (output) frequency
- $A_{(f2)}$  through  $A_{(f10)}$  are the RMS power of the first nine harmonic frequencies in the output spectrum (20)

**Second Harmonic Distortion (2nd Harm)** is the difference, expressed in dB, between the RMS power in the input frequency detected at the output and the power in the second harmonic level at the output.

**Third Harmonic Distortion (3rd Harm)** is the difference, expressed in dB, between the RMS power in the input frequency seen at the output and the power in the third harmonic level at the output.

**Word Error Rate** is the probability of error and is defined as the probable number of errors per unit of time divided by the number of words seen in that amount of time. A Word Error Rate of  $10^{-18}$  corresponds to a statistical error in one conversion about every four years.

## 11.2 Documentation Support

### 11.2.1 Related Documentation

For related documentation see the following:

- *LMH3401 7-GHz, Ultra-Wideband, Fixed-Gain, Fully-Differential Amplifier*, [SBOS695](#)
- *LMK0482x Ultra Low-Noise JESD204B Compliant Clock Jitter Cleaner with Dual Loop PLLs*, [SNAS605](#)
- *LMX2581 Wideband Frequency Synthesizer with Integrated VCO*, [SNAS601](#)
- *TRF3765 Integer-N/Fractional-N PLL with Integrated VCO*, [SLWS230](#)

### 11.3 Related Links

Below are direct links to information available to accelerate design activity. Categories include technical information, community resources, design information, and quick access to sample or purchase once you have made a decision.

| Parts      | Product Folder             | Sample & Buy               | Technical Documents        | Tools & Software           | Support & Community        |
|------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| ADC12J1600 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| ADC12J2700 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 11.4 Community Resource

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.5 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 11.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 11.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADC12J1600NKE    | ACTIVE        | VQFN         | NKE             | 68   | 168         | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J1600              | <a href="#">Samples</a> |
| ADC12J1600NKE10  | ACTIVE        | VQFN         | NKE             | 68   | 10          | Green (RoHS & no Sb/Br) | Call TI                 | Level-3-260C-168 HR  | -40 to 85    | ADC12J1600              | <a href="#">Samples</a> |
| ADC12J1600NKER   | ACTIVE        | VQFN         | NKE             | 68   | 2000        | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J1600              | <a href="#">Samples</a> |
| ADC12J1600NKET   | ACTIVE        | VQFN         | NKE             | 68   | 250         | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J1600              | <a href="#">Samples</a> |
| ADC12J2700NKE    | ACTIVE        | VQFN         | NKE             | 68   | 168         | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J2700              | <a href="#">Samples</a> |
| ADC12J2700NKE10  | ACTIVE        | VQFN         | NKE             | 68   | 10          | Green (RoHS & no Sb/Br) | Call TI                 | Level-3-260C-168 HR  | -40 to 85    | ADC12J2700              | <a href="#">Samples</a> |
| ADC12J2700NKER   | ACTIVE        | VQFN         | NKE             | 68   | 2000        | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J2700              | <a href="#">Samples</a> |
| ADC12J2700NKET   | ACTIVE        | VQFN         | NKE             | 68   | 250         | Green (RoHS & no Sb/Br) | CU SN   Call TI         | Level-3-260C-168 HR  | -40 to 85    | ADC12J2700              | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

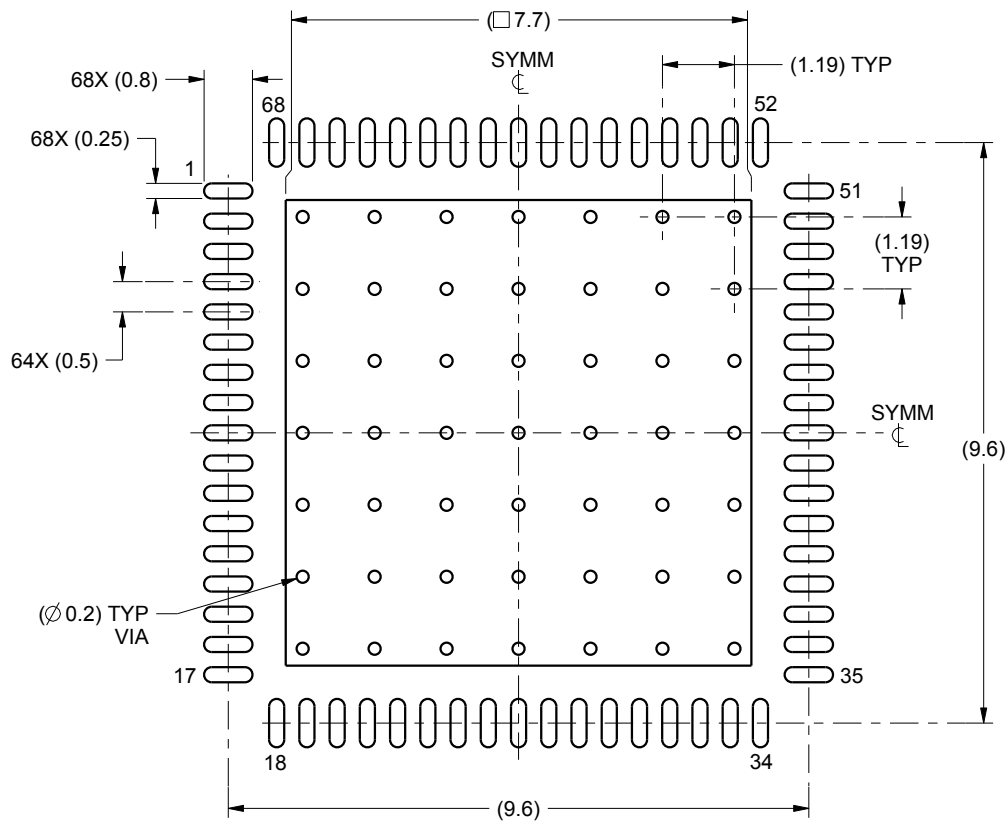


# EXAMPLE BOARD LAYOUT

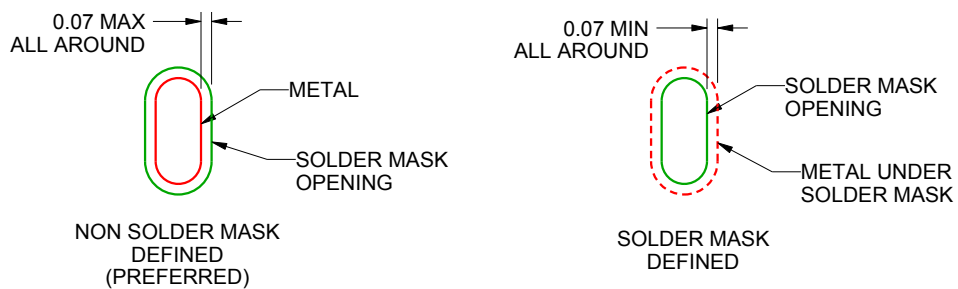
**NKE0068A**

**VQFN - 0.9 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4214820/A 12/2014

NOTES: (continued)

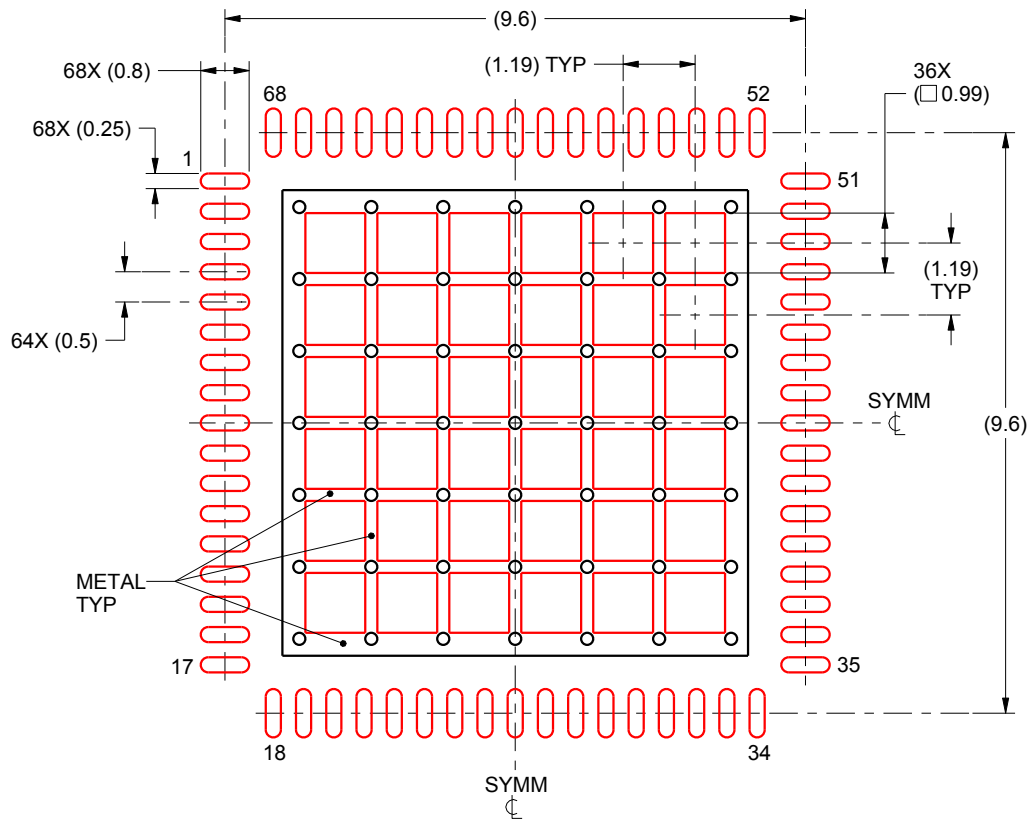
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

NKE0068A

VQFN - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
60% PRINTED SOLDER COVERAGE BY AREA  
SCALE:8X

4214820/A 12/2014

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

|                              |  |
|------------------------------|--|
| Audio                        | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                               |
| Amplifiers                   | <a href="http://amplifier.ti.com">amplifier.ti.com</a>                               |
| Data Converters              | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products                | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                          | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
| Clocks and Timers            | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
| Interface                    | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                        | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt                   | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers             | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Applications Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity        | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

|                               |  |
|-------------------------------|--|
| Automotive and Transportation | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>                         |
| Communications and Telecom    | <a href="http://www.ti.com/communications">www.ti.com/communications</a>                 |
| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
| Security                      | <a href="http://www.ti.com/security">www.ti.com/security</a>                             |
| Space, Avionics and Defense   | <a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a> |
| Video and Imaging             | <a href="http://www.ti.com/video">www.ti.com/video</a>                                   |

### TI E2E Community

[e2e.ti.com](http://e2e.ti.com)

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View ADC12J1600NKE10 on WIN SOURCE](#)

 [Texas Instruments](#) Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management